

Surfaces in the Real World - Adsorption

Lesson 2

MSE 304

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Plan of the Course: Fundamentals, Characterization, and Applications

1: Intro to Surfaces & Interfaces

2: Surfaces in the Real World - Adsorption

3: Surface Fundamentals – Energy & Structure

4: Solid-Solid Interfaces

5: Characterization of Real Surfaces

6: Solid-Liquid Interfaces + Techniques

7: Interfacial Phenomena

8: Charged Solid-Liquid Interfaces

9: Surface Chemistry

10: Biological Processes at Surfaces

11: Electronic Properties of Surfaces

12: Thin Film Technologies

13: Biosensor Fundamentals

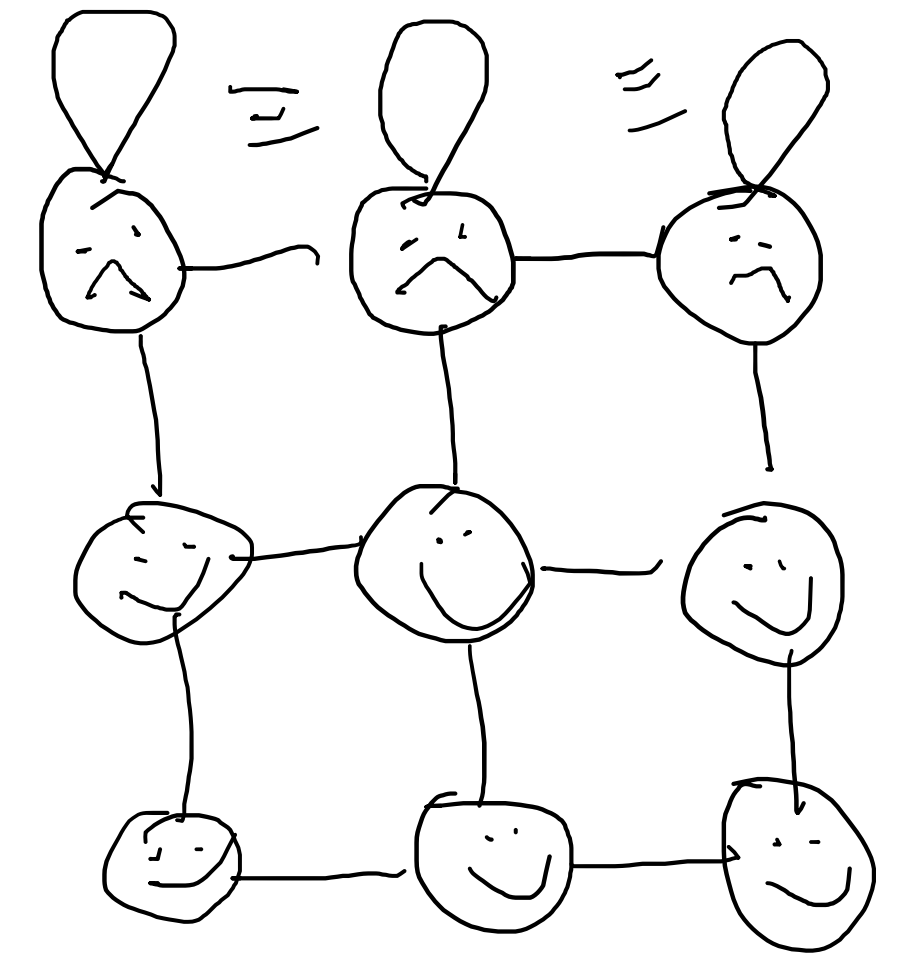
14: Biosensing applications

Things may be adapted in real time – thank you for your patience!
Midterm feedback (Week 5) – Recap session Week 7?



Recap from Lesson 1

- Surface science is not a mature field
- Why study surfaces and interfaces?
- Challenges of studying surfaces and interfaces
- Keeping surfaces clean is very challenging – UHV can help



What's really on a surface and how do we deal with it?



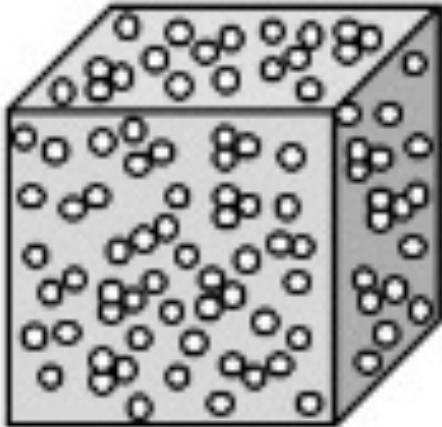
Outline of Lesson 2

- Basics of physisorption and chemisorption
- Short recap of crystal structures
- Visualizing surfaces at the atomic level – scanning tunneling microscopy (STM)
- Surface contamination sources & problems
- How to obtain clean surfaces – cleaning hierarchy



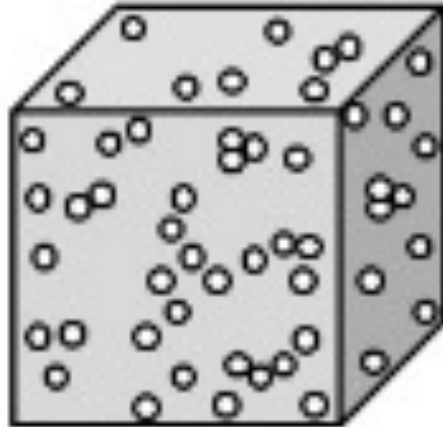
Instantaneous Contamination on Surfaces

Rough Vacuum
 1 atm – 10^{-3} Torr



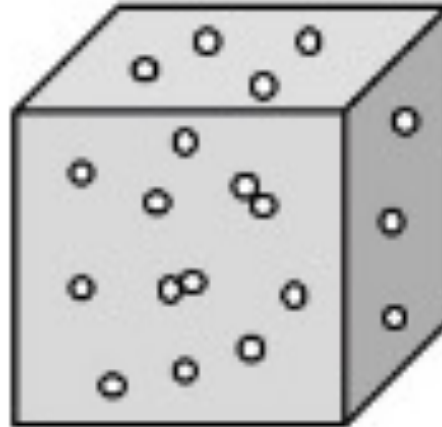
1×10^{-3} Torr
 10^{13} atoms/cm³

High Vacuum
 10^{-3} Torr - 10^{-8} Torr



1×10^{-6} Torr
 10^{10} atoms/cm³

Ultra High Vacuum
 10^{-8} Torr - 10^{-12} Torr



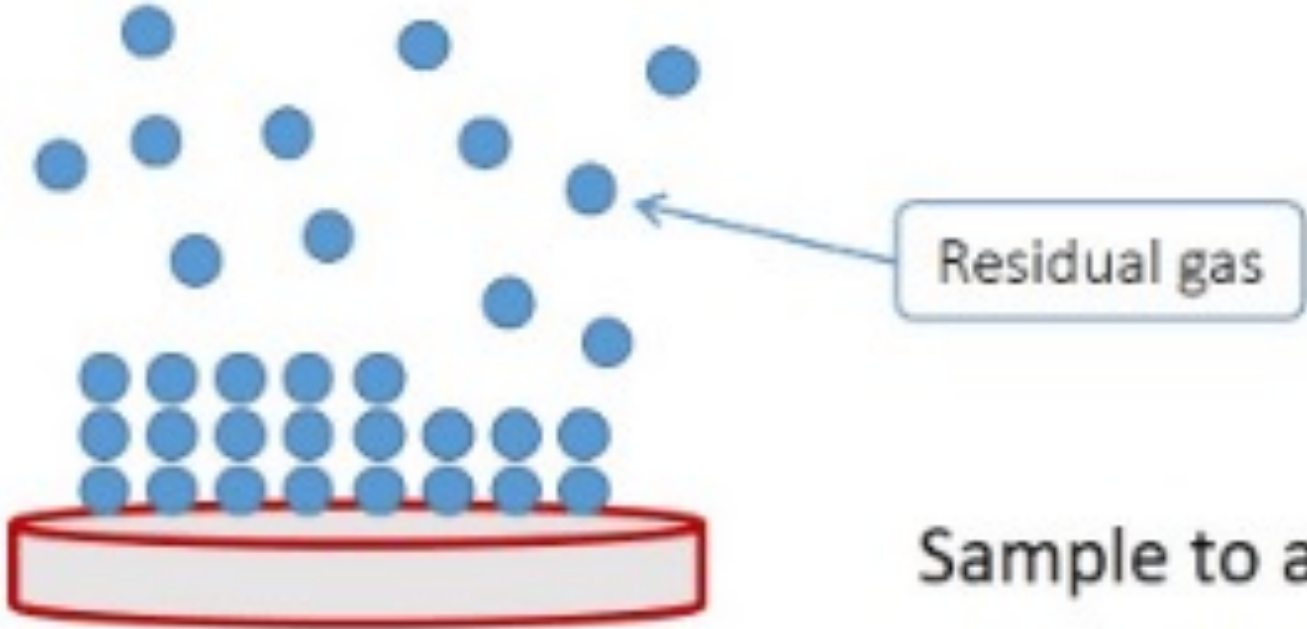
1×10^{-11} Torr
 10^5 atoms/cm³



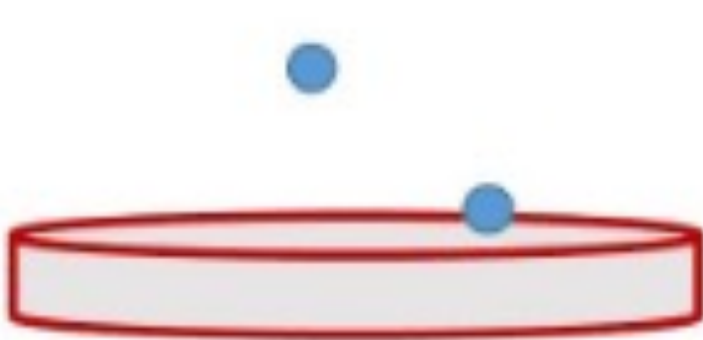
1 residual gas monolayer
 every **4 SECONDS**

1 residual gas monolayer
 every **4 DAYS**

High Vacuum



UHV



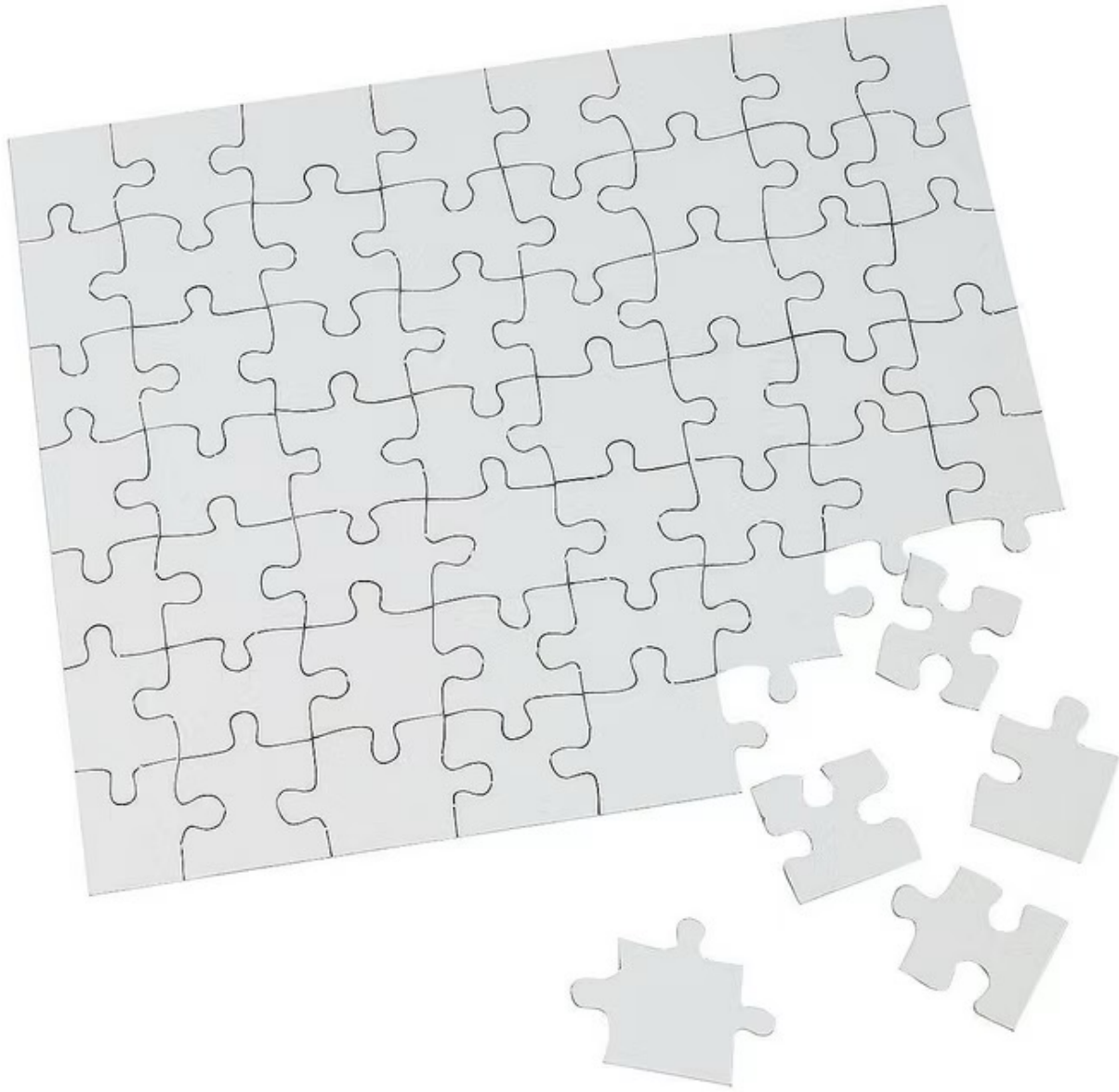
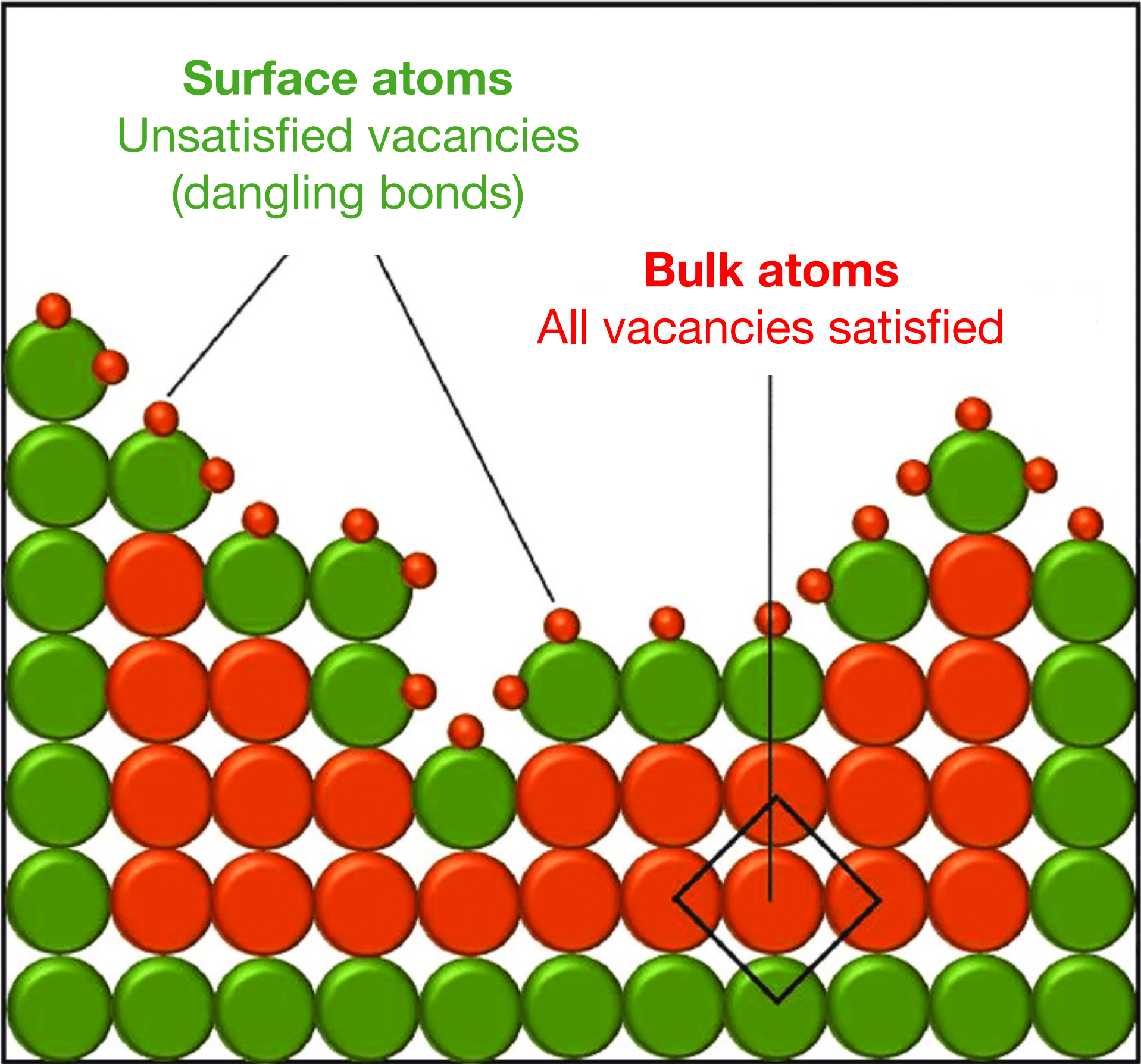
VAC COAT

CHEMNA

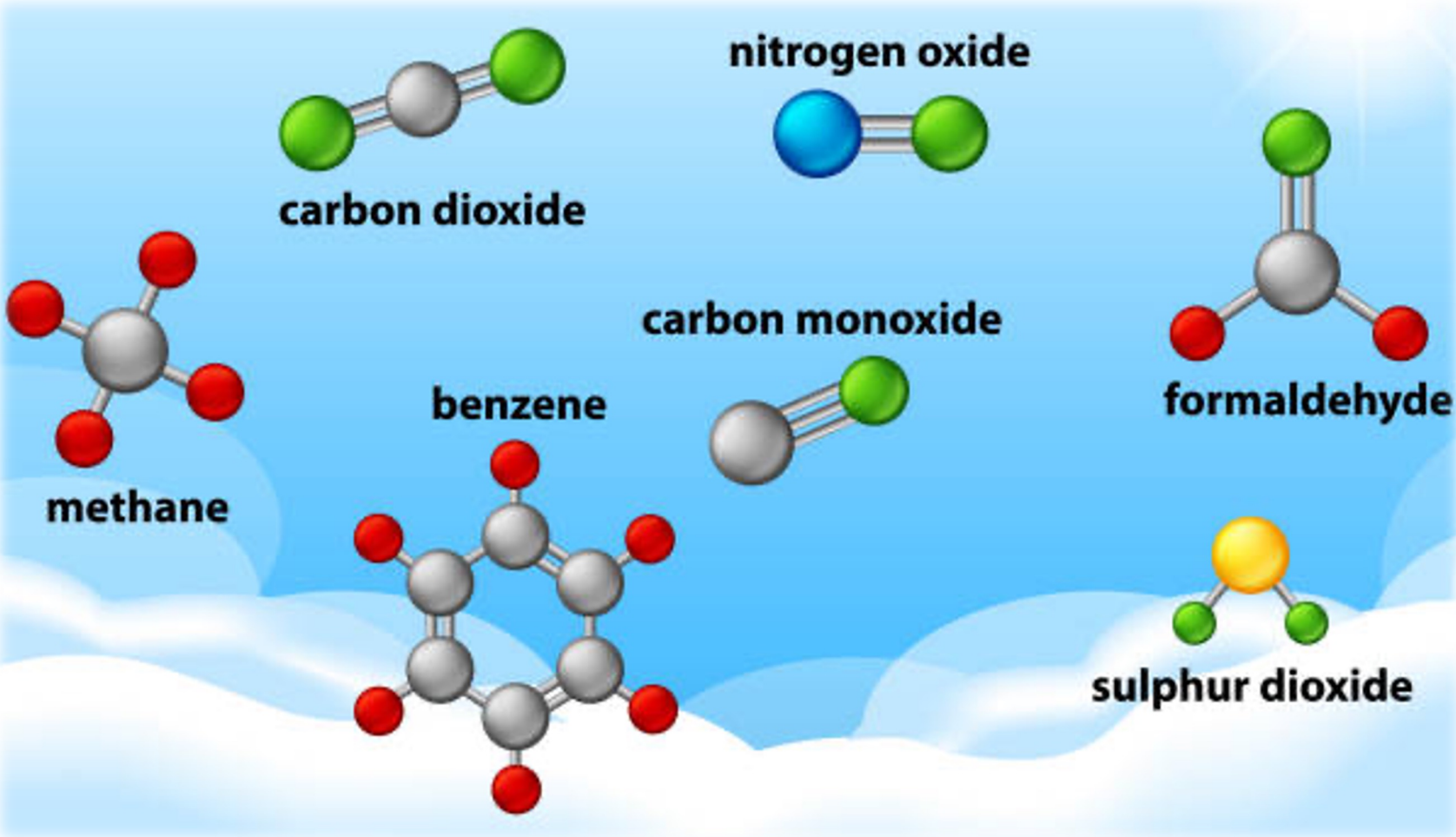
Clean Surfaces are High Energy – Coatings Lower Energy

Surface energetically unfavorable compared to bulk

Clean surface has a high surface energy and wants to reduce this



Sources of Surface Contamination



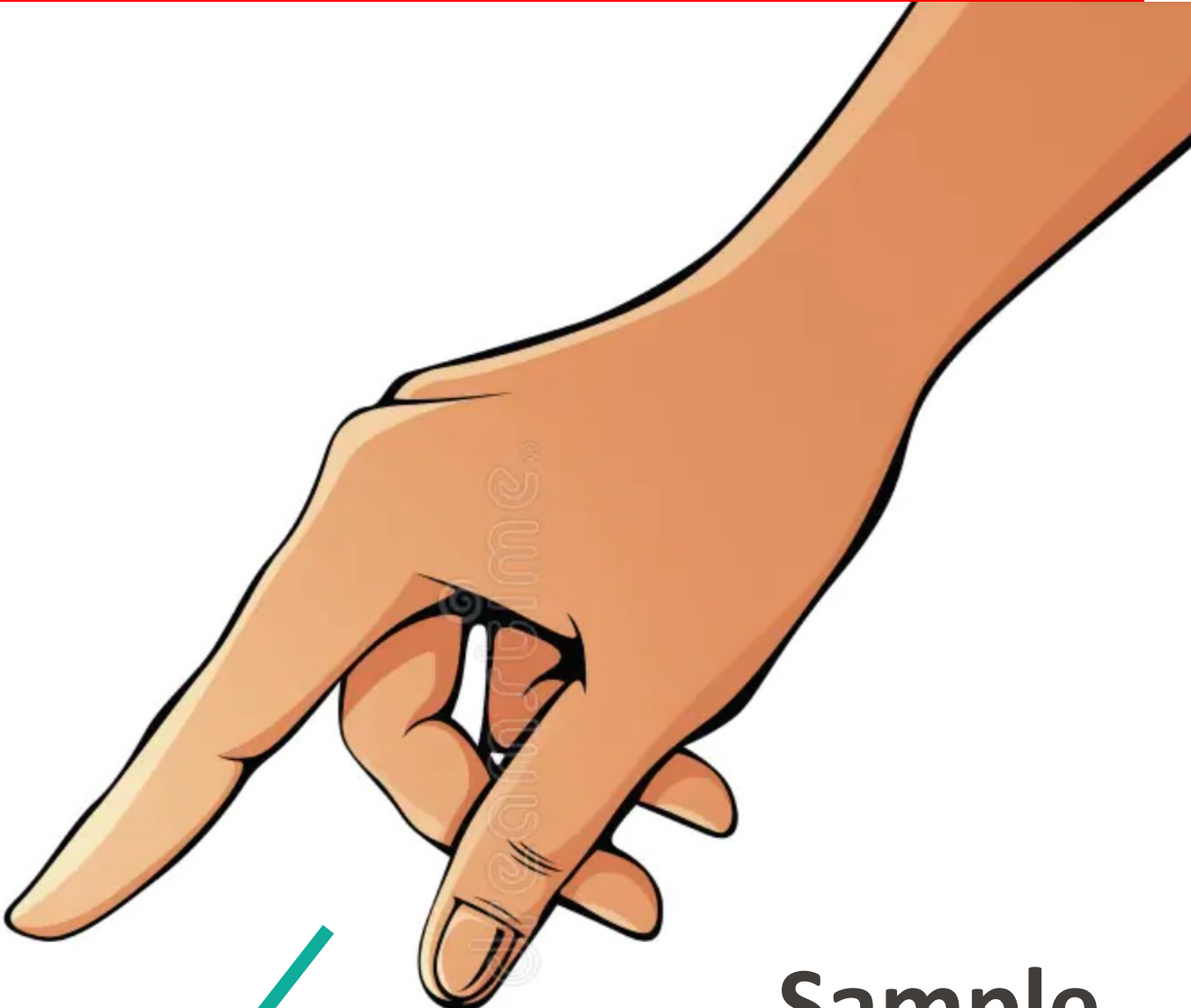
Air contaminants



Humidity



Chemical residue



Sample handling

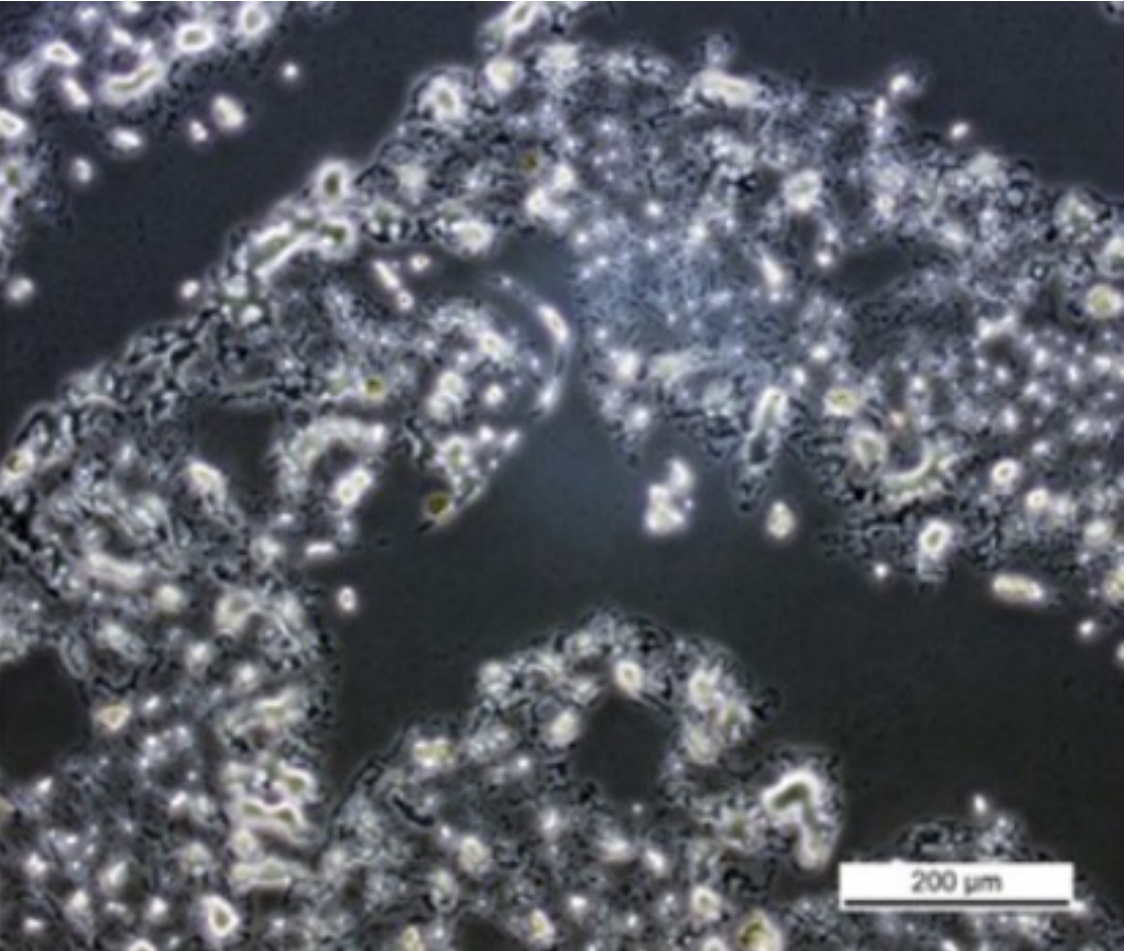


Dust

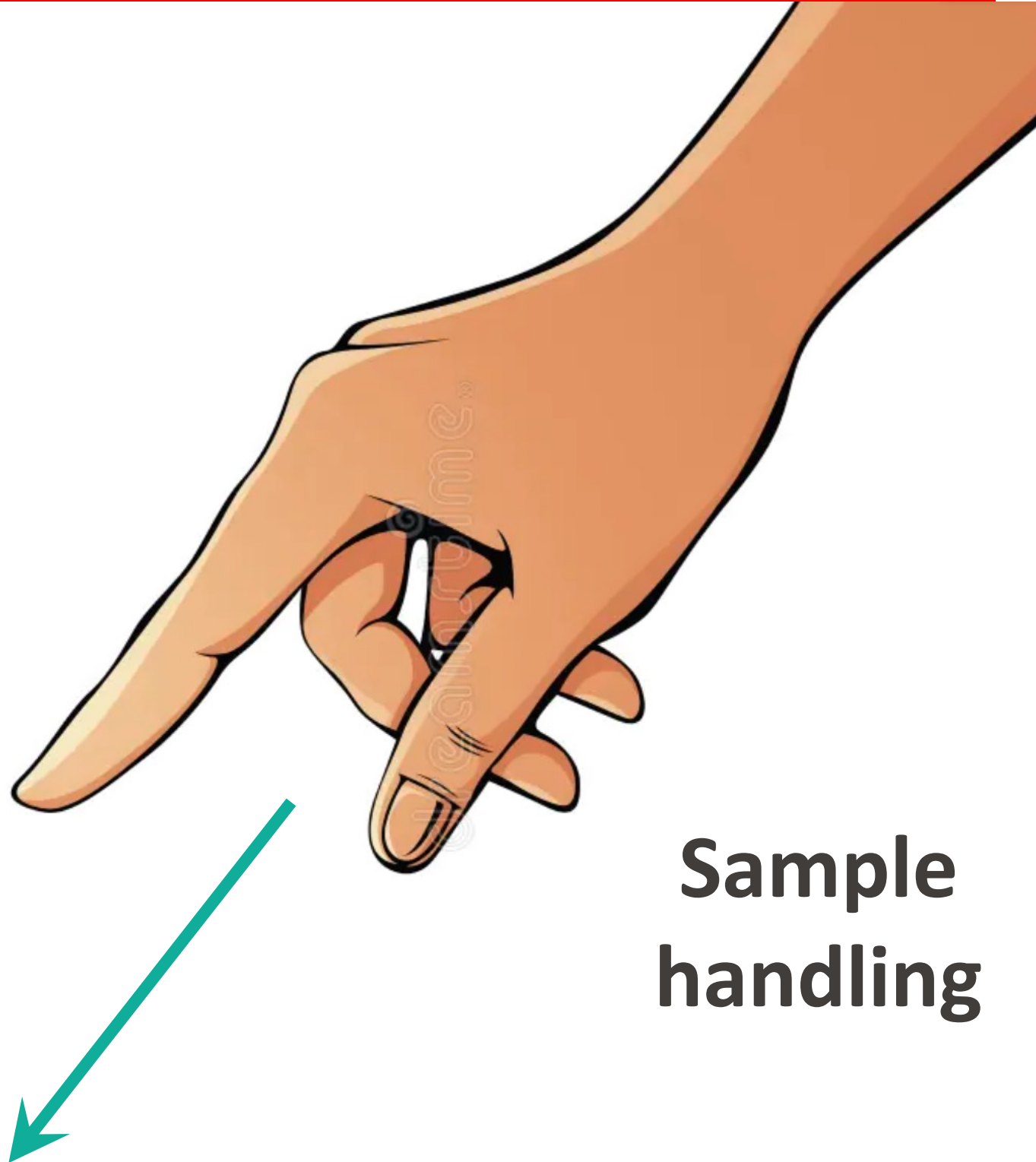
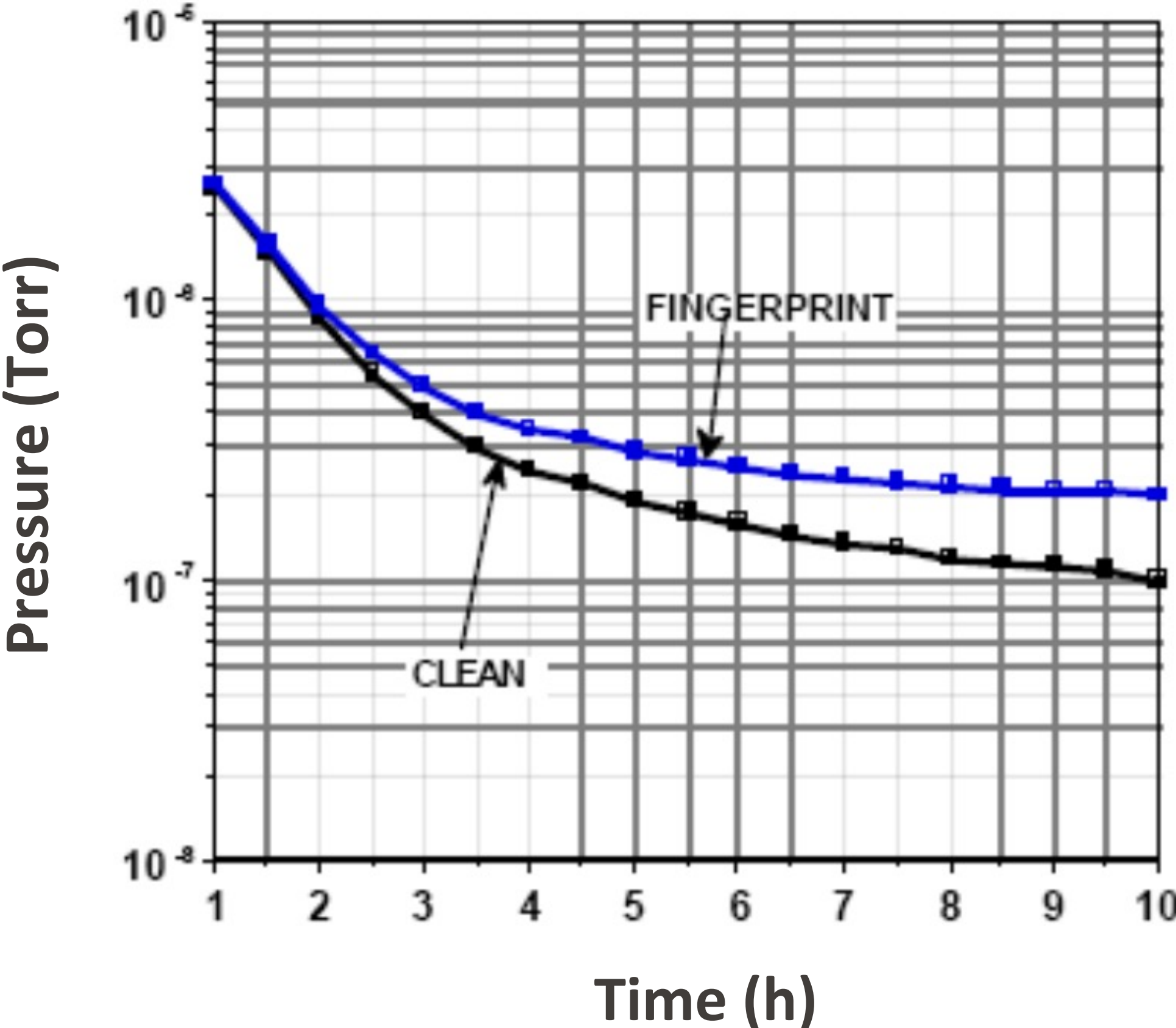


Single Fingerprint Has a Large Effect on Vacuum Pumpdown

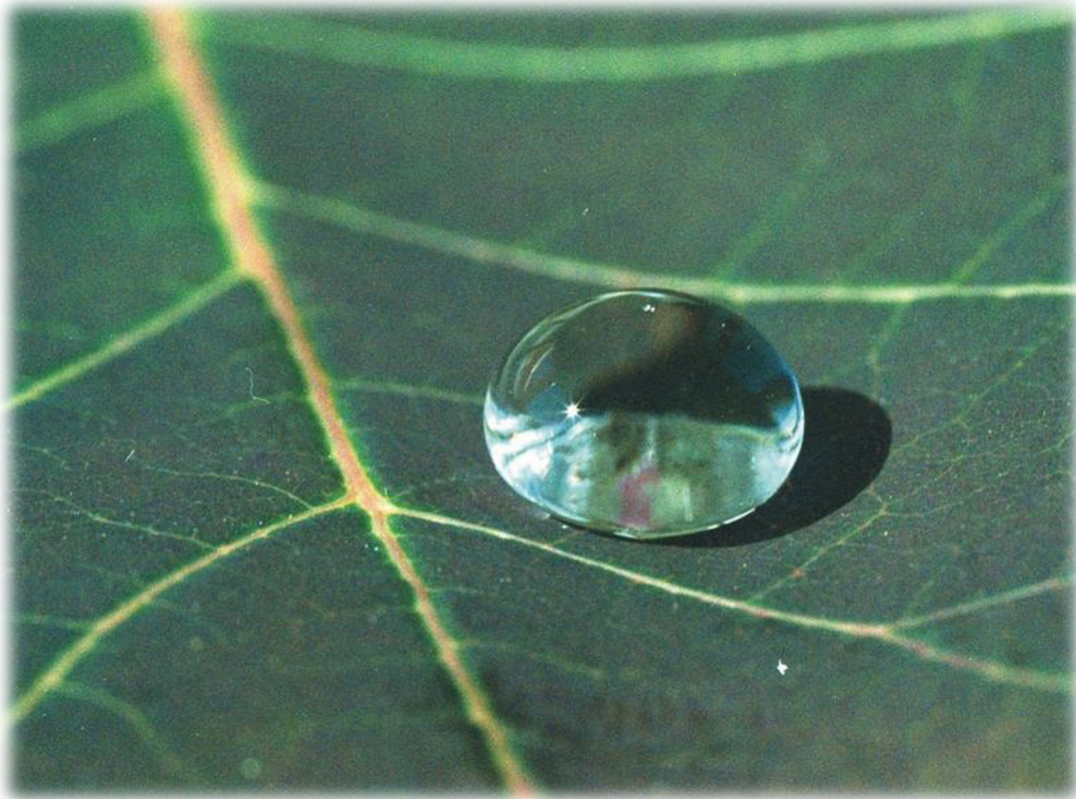
1 fingerprint = 1×10^{19} molecules!



Moret et al. | *Forensic Sci. Int.* | 2018

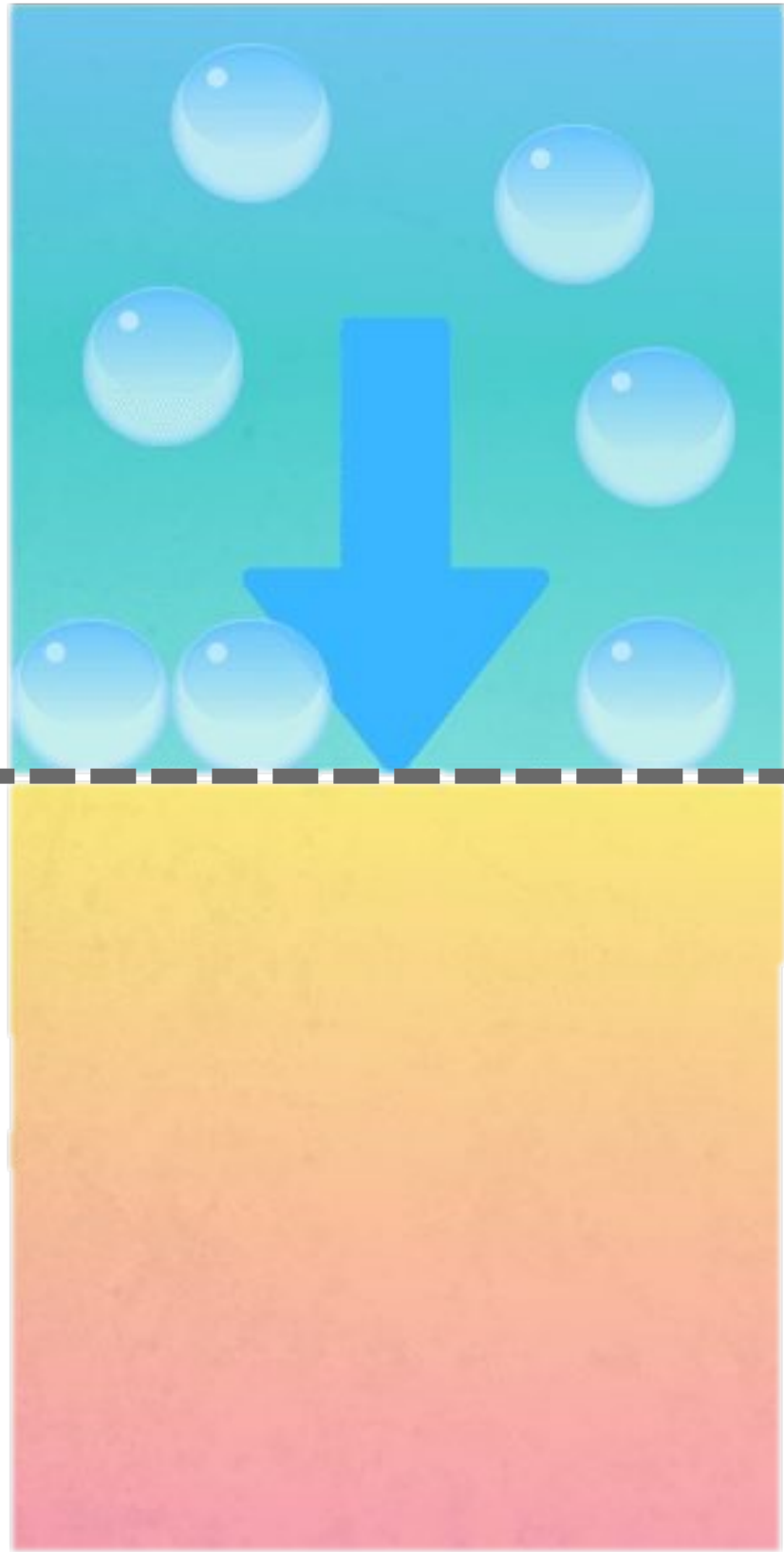


Careful: Adsorption vs. Absorption



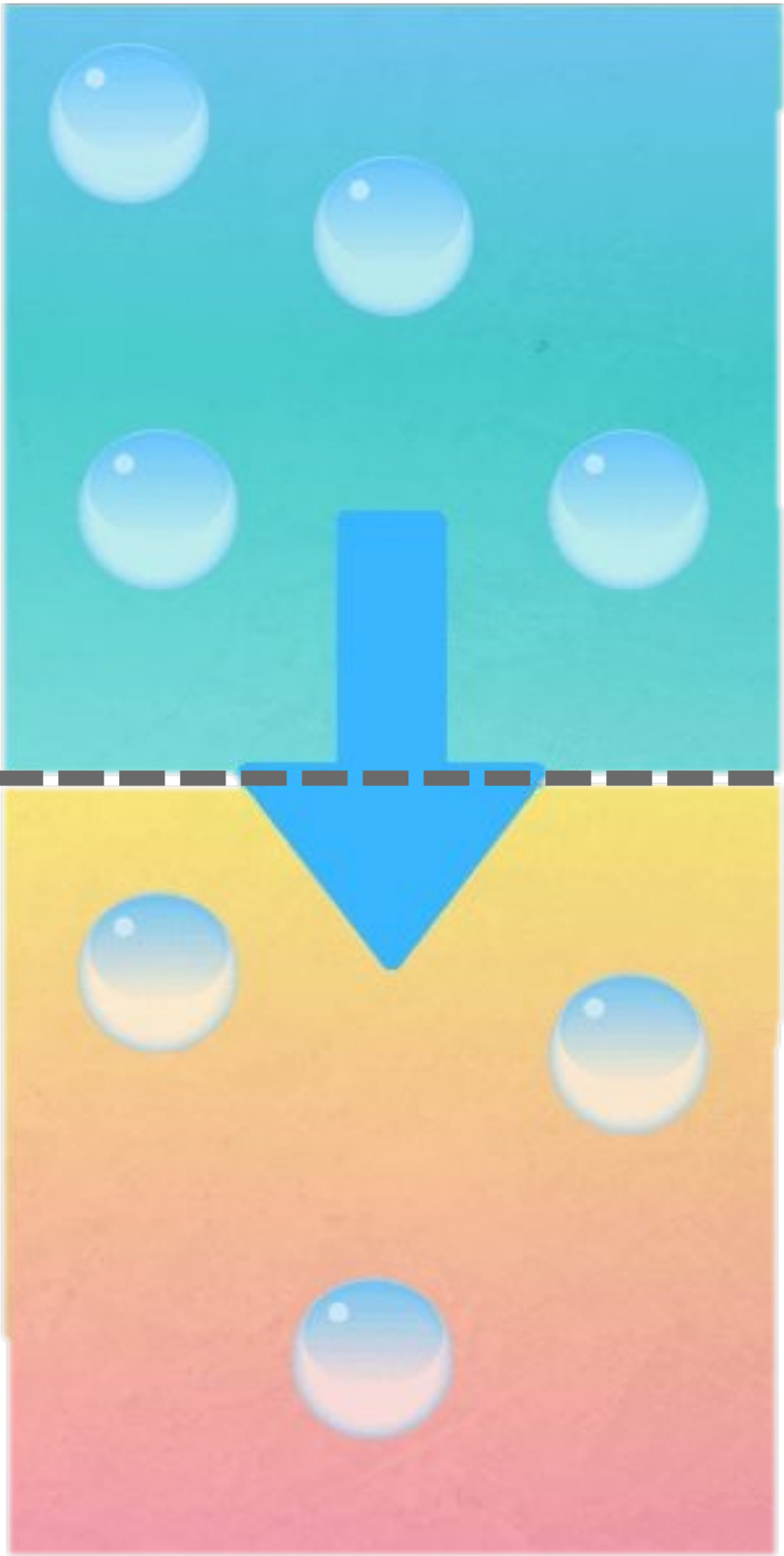
Adsorption

Sticking to the surface of the other phase



Absorption

Soaking into the bulk of the other phase



Mass transfer **into** another material

SCIENCE NOTES

CHEMNA

Careful: Adsorption vs. Absorption

Interactions

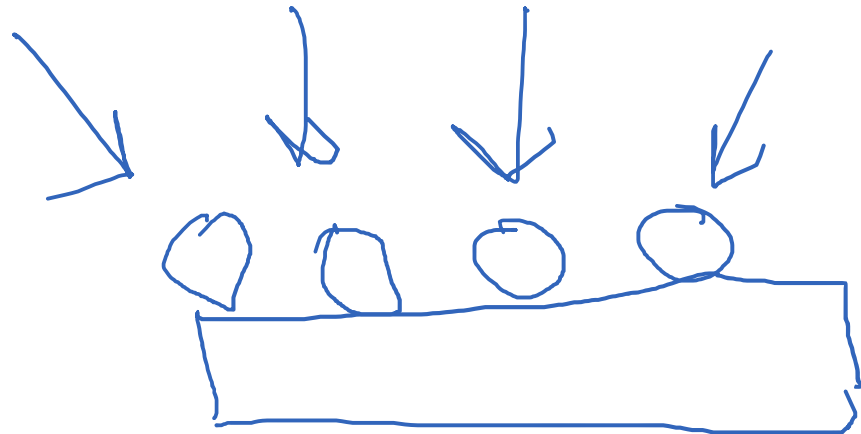
Bond



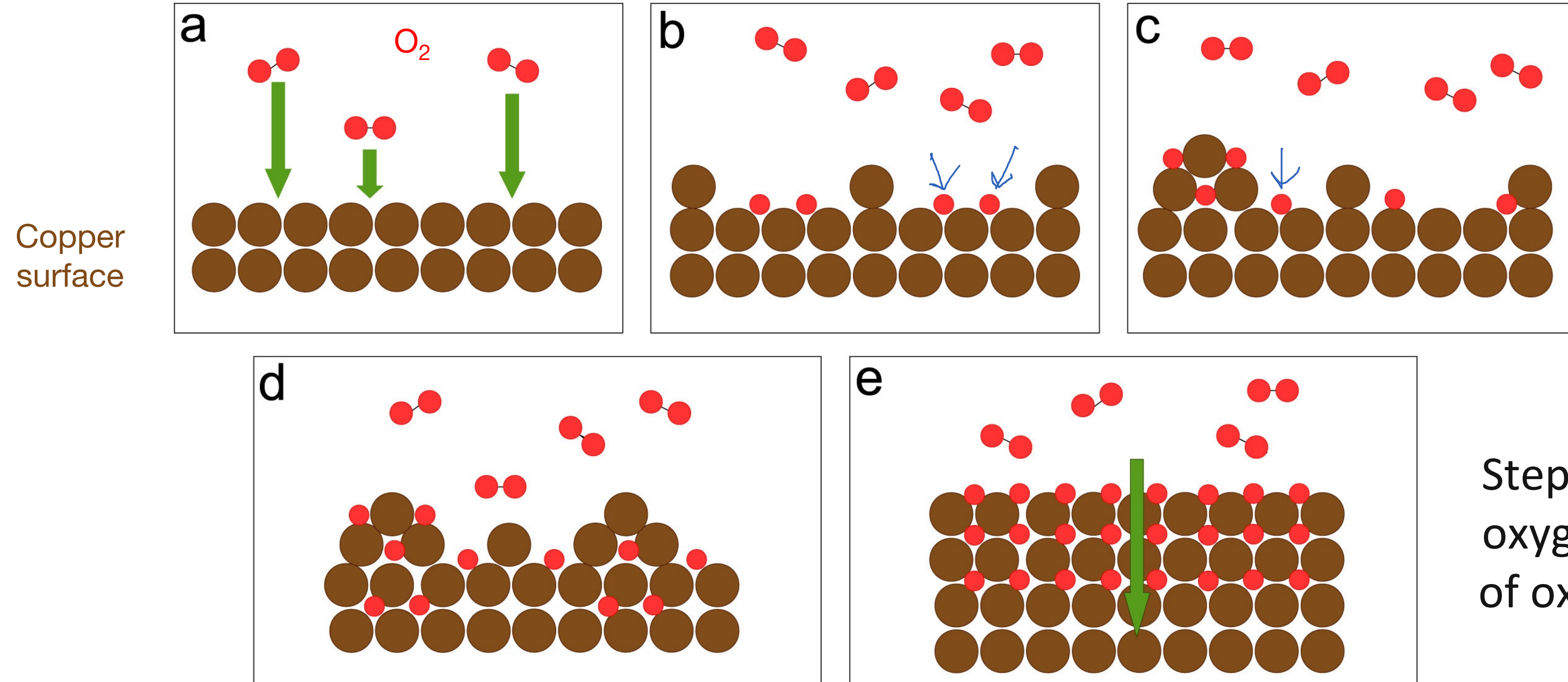
Release Energy

Adsorption	Absorption
Accumulation onto surface	Accumulation into another substance
Surface phenomenon	Bulk phenomenon
Exothermic process	Endothermic process
Favored by lower temperature	Mostly unaffected by temperature
Rate dependent on surface sites until equilibrium reached	Occurs at uniform rate
Surface concentration differs from internal concentration	Concentration eventually becomes the same throughout material

Le Chatelier's Principle



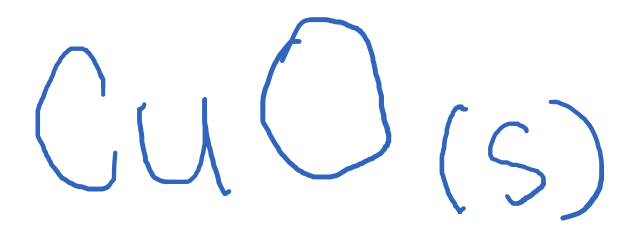
Metal Oxidation – Adsorption + Absorption



Copper surface

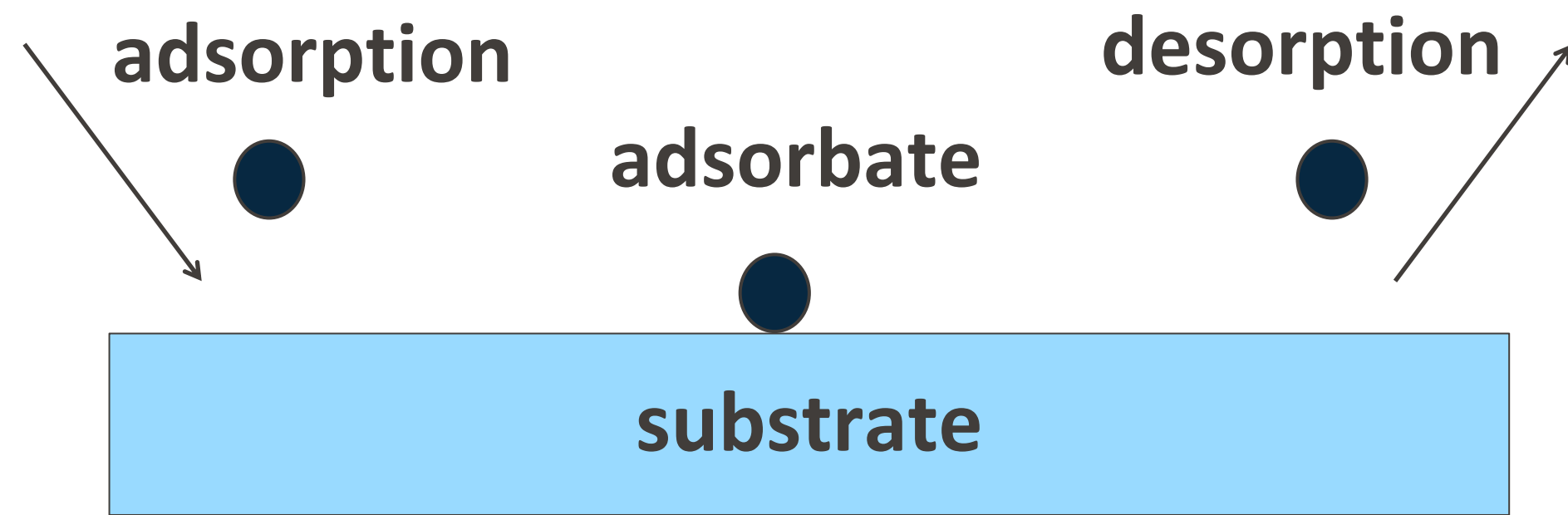
Step 1: **Adsorption** of O₂ onto copper surface

Step 2: **Absorption** of oxygen drives growth of oxide film into bulk



Gattinoni & Michaelides | *Surf. Sci. Rep.* | 2015

The Different Forms of Adsorption on Surfaces



Surface
occupancy
 θ

$$\theta = \frac{\text{Number of occupied adsorption sites}}{\text{Number of adsorption sites present}} \uparrow$$

$\theta = 0$ clean surface

$\theta = 1$ monolayer

Physisorption

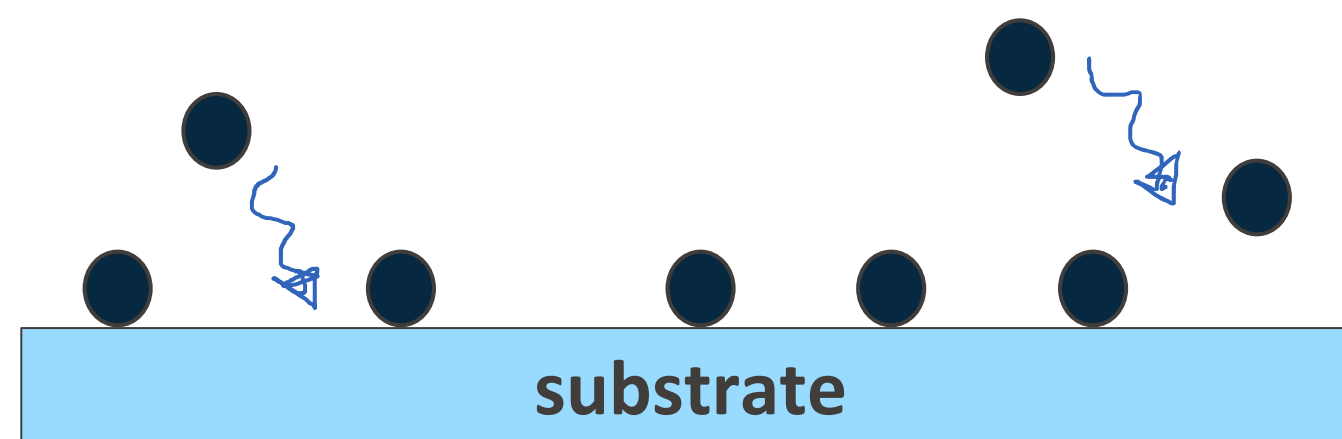
Van der Waals interactions between adsorbate and substrate

non-specific and weak

$$\Delta H_{\text{des}} \approx 20 \text{ kJ/mol}$$

multilayer growth possible

observed mostly at low temperatures



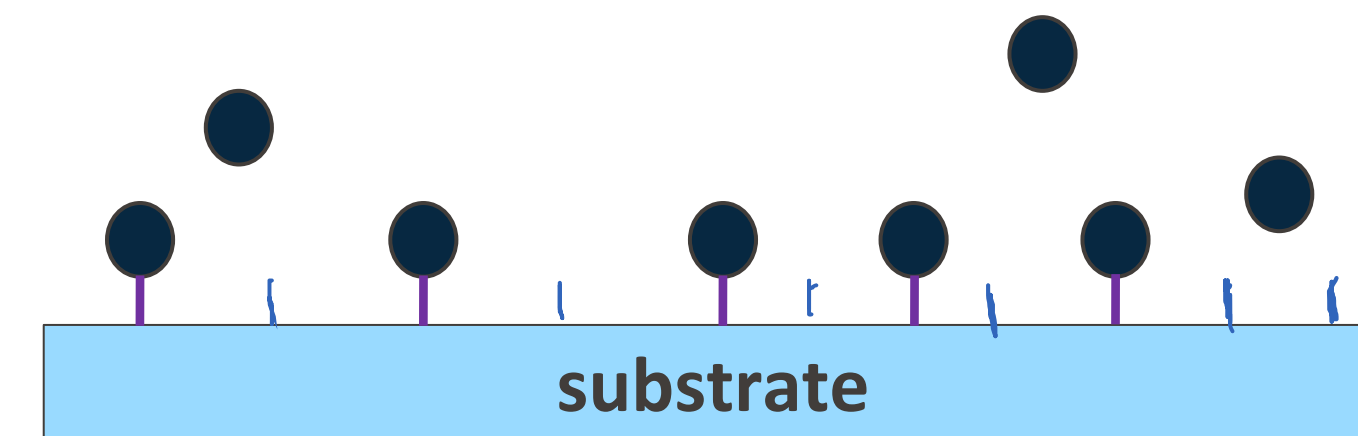
Chemisorption

Chemical bond between adsorbate and substrate

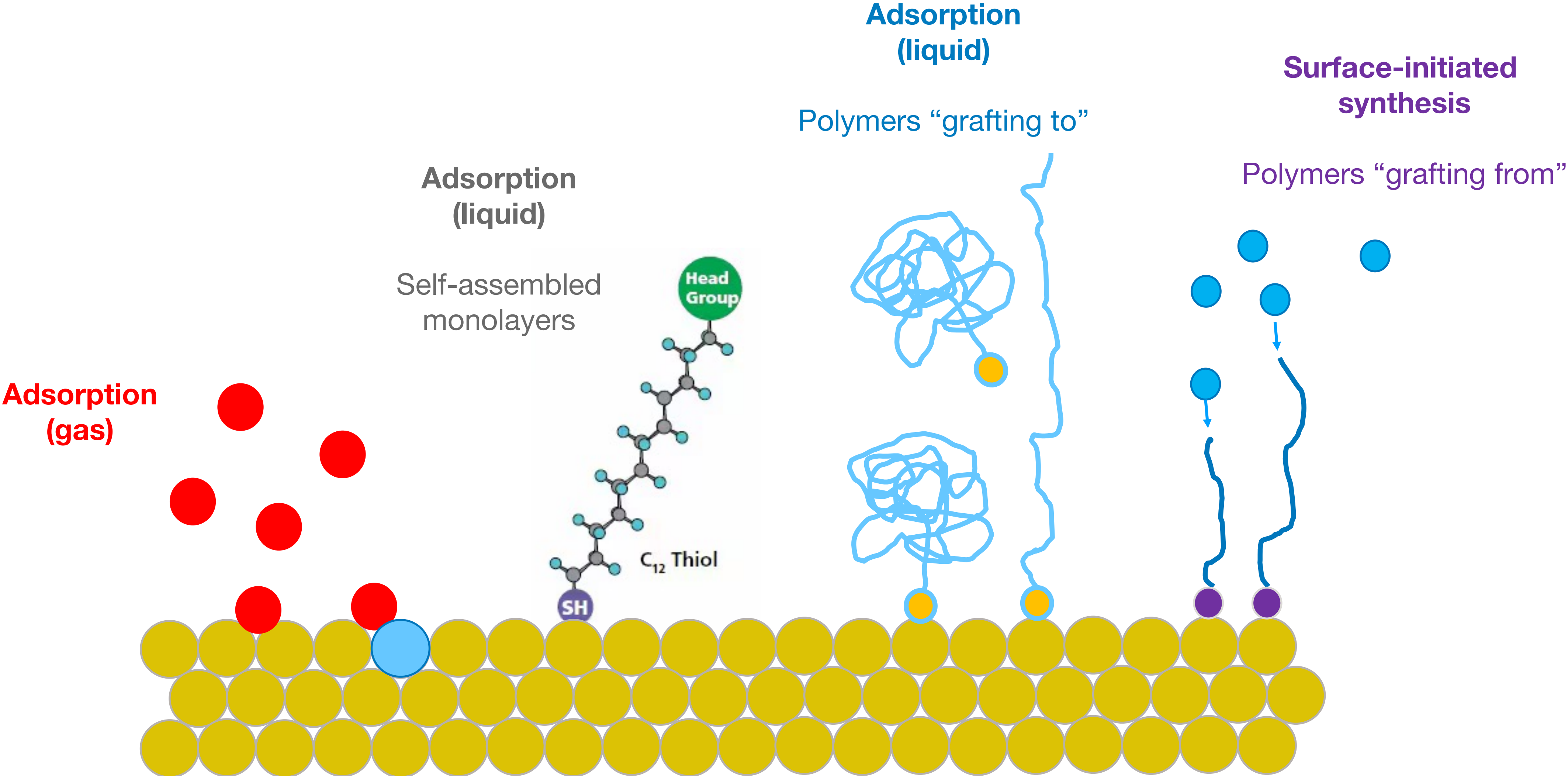
Generally kinetically stable at RT

$$\Delta H_{\text{des}} \approx 200 \text{ kJ/mol}$$

maximum coverage is 1 monolayer ($\theta = 1$)



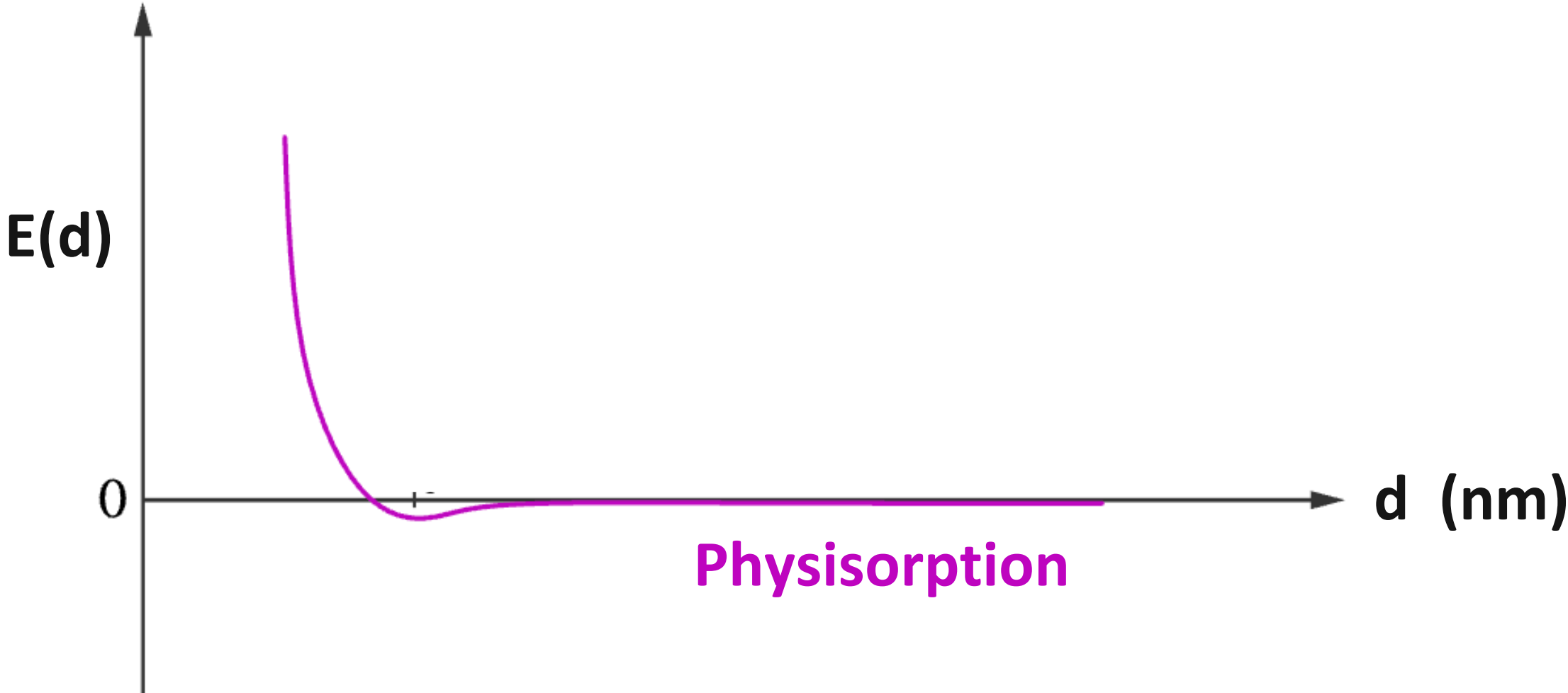
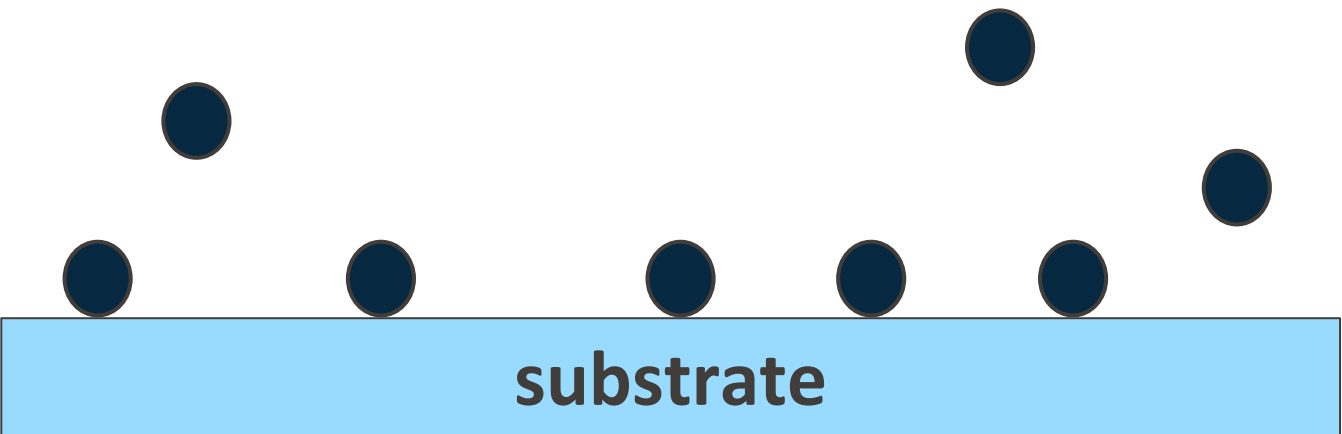
Chemisorption (Surface Chemistry) In Future Lessons



Potential Energy Change for Physisorption vs. Chemisorption

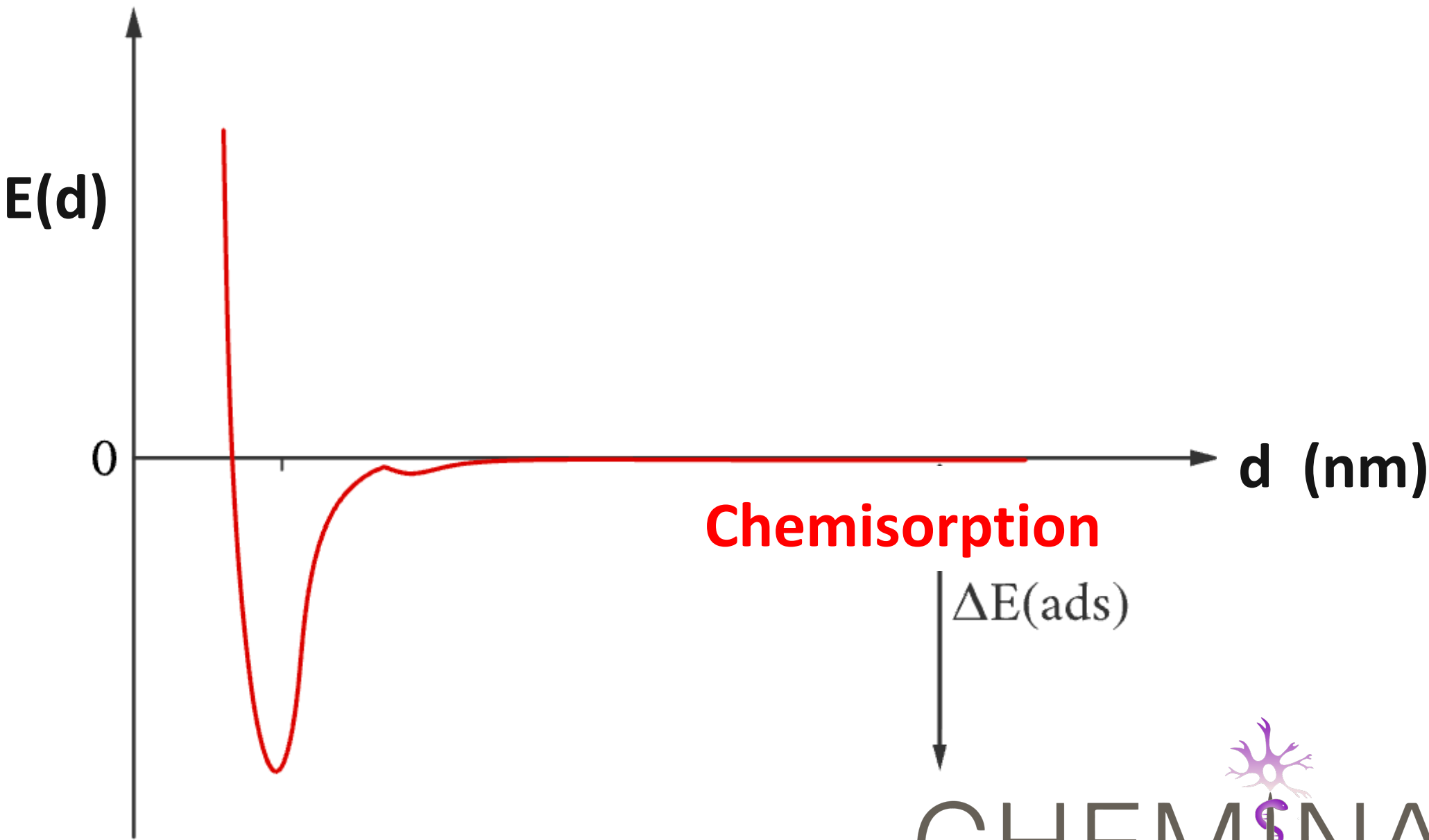
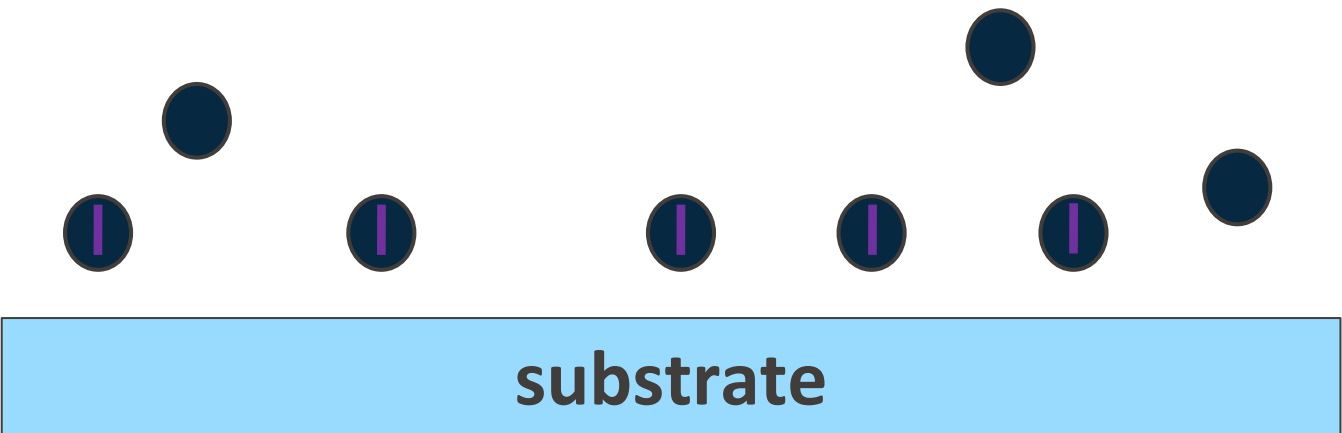
Physisorption

Van der Waals interactions between adsorbate and substrate



Chemisorption

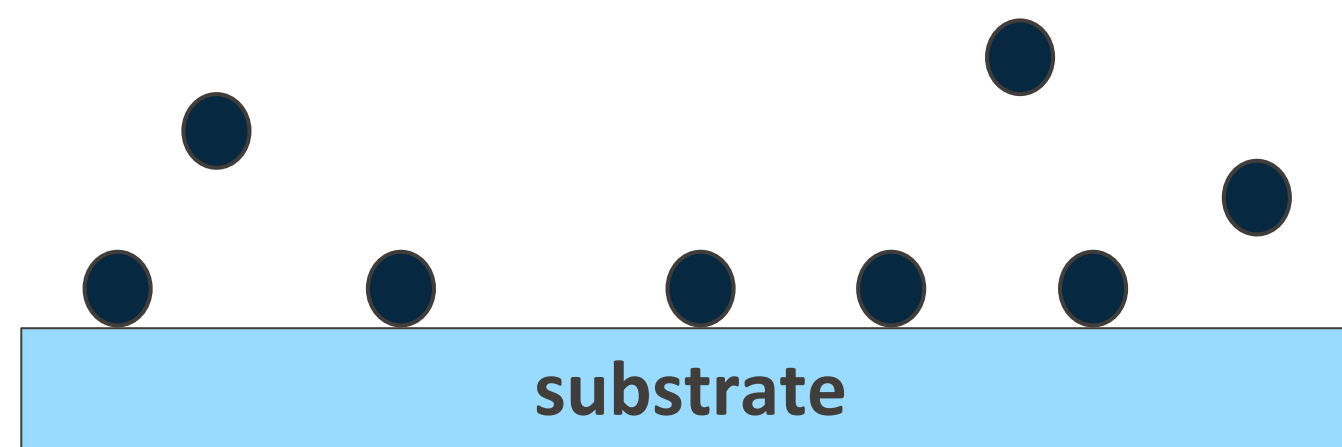
Chemical bond between adsorbate and substrate



Chemisorption Typically Slower Due to Activation Barrier

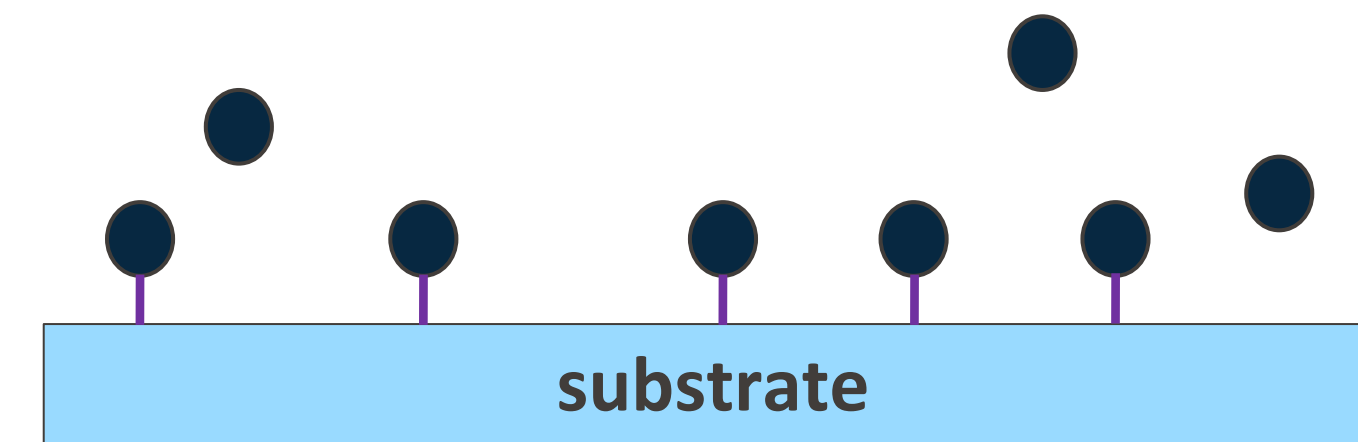
Physisorption

Van der Waals interactions between adsorbate and substrate

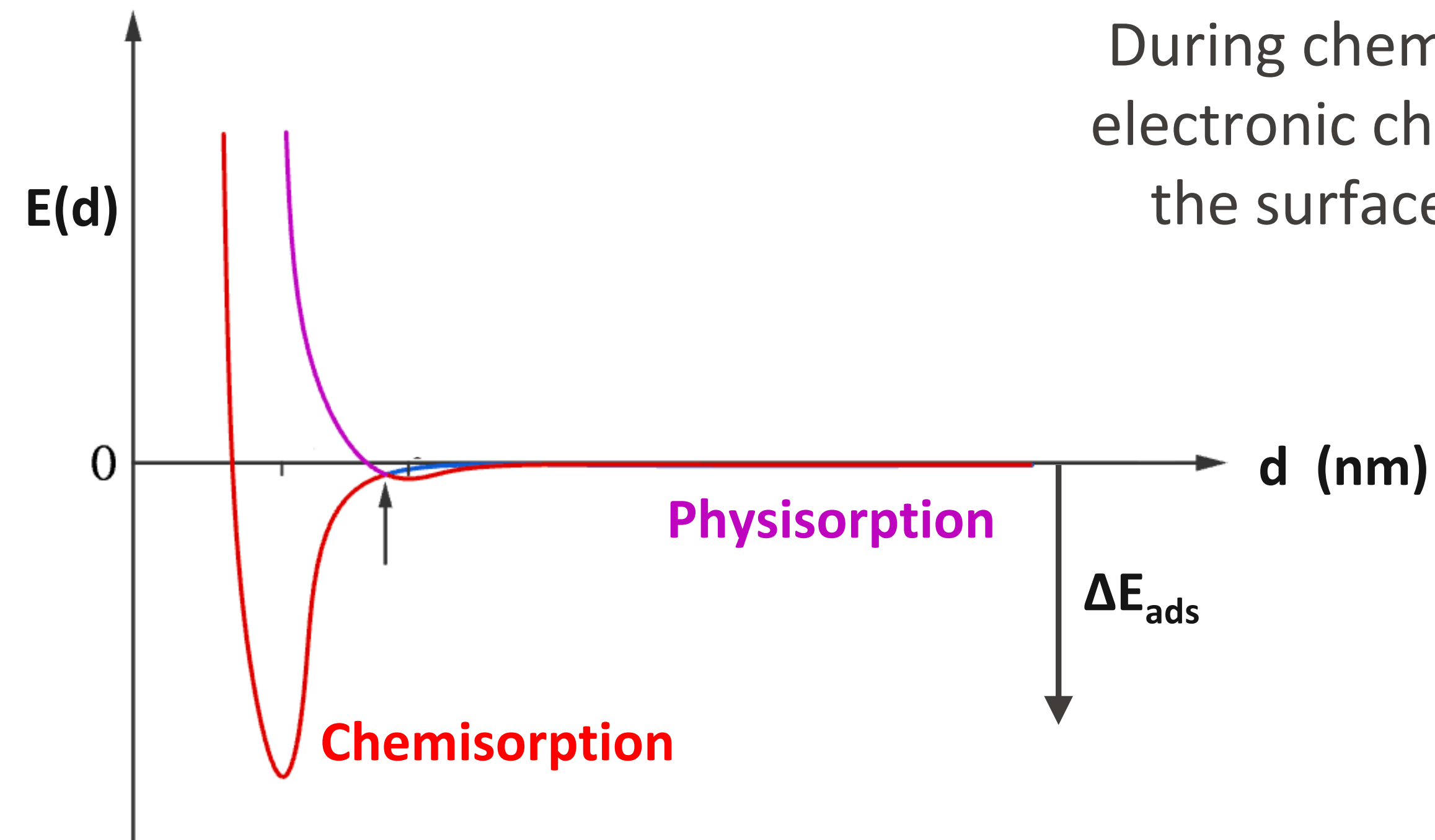
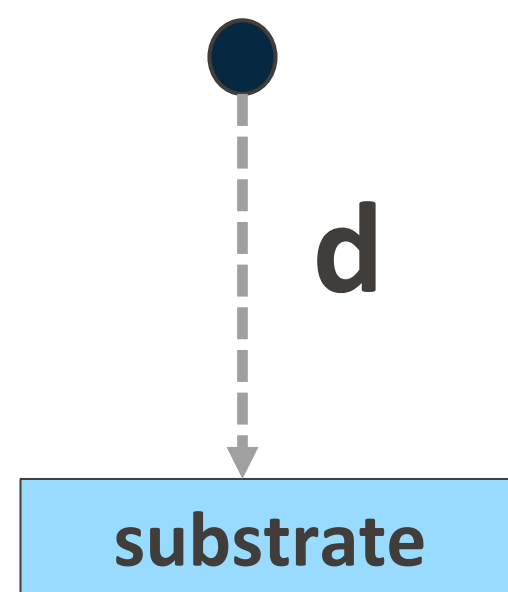


Chemisorption

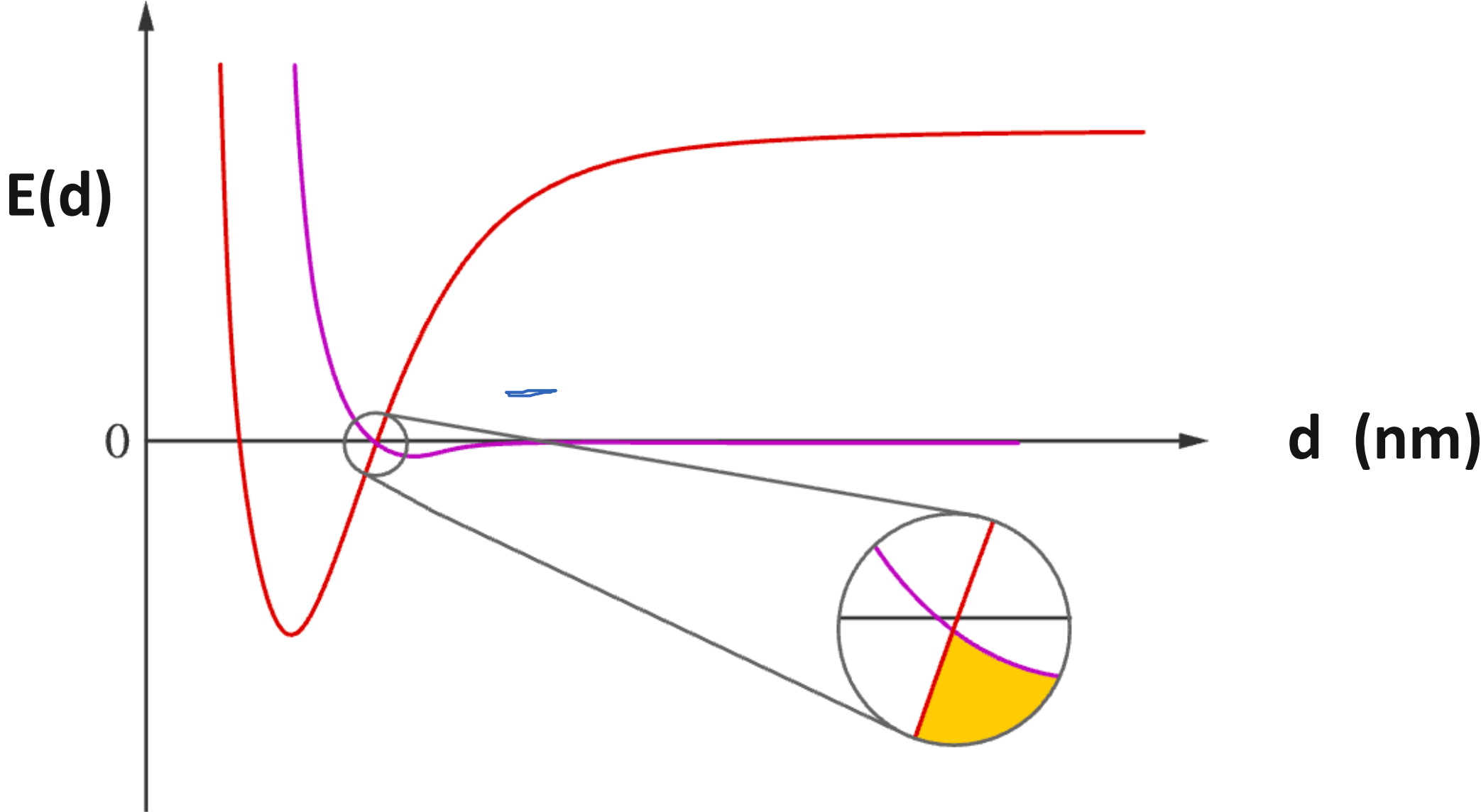
Chemical bond between adsorbate and substrate



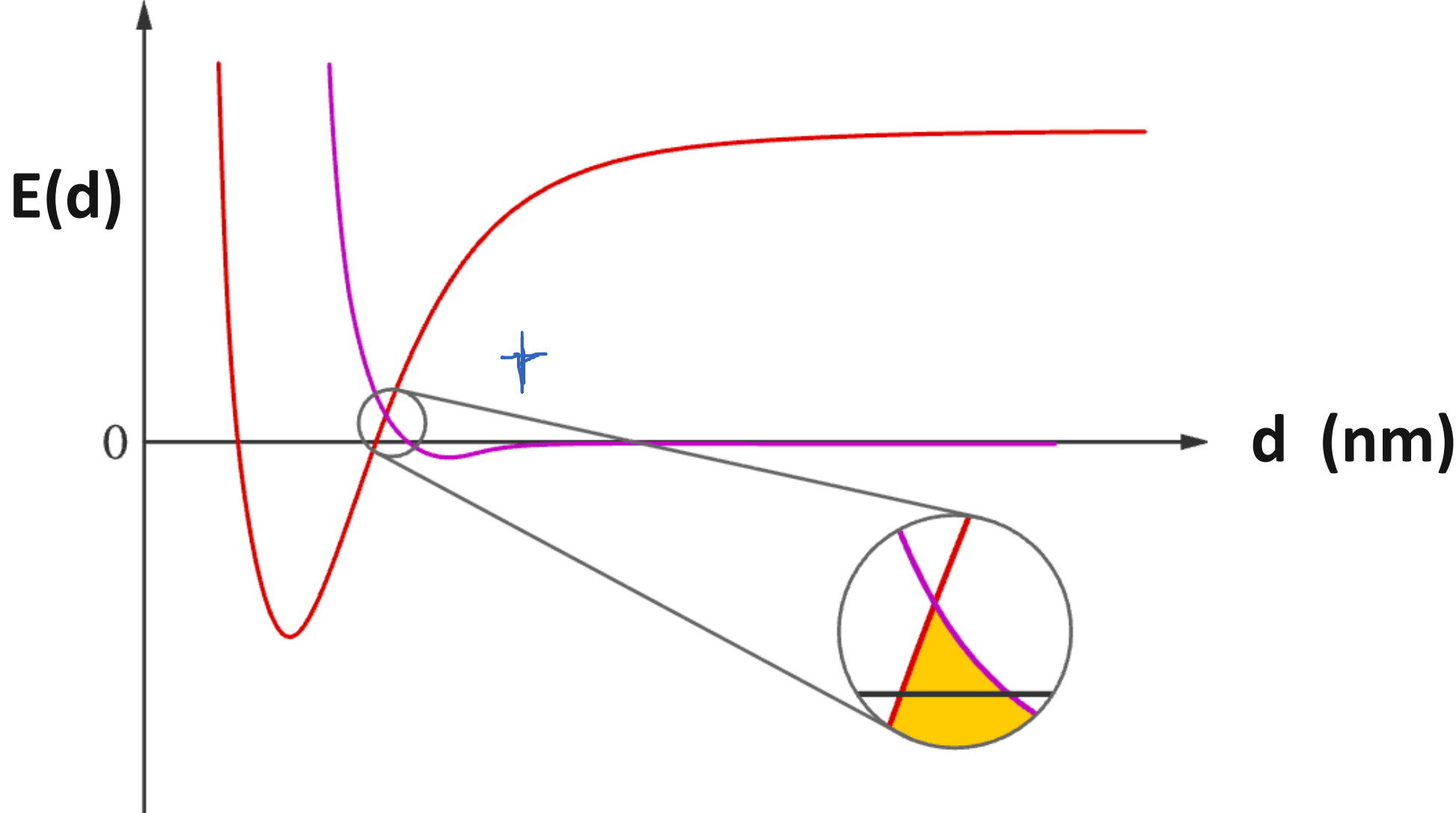
During chemisorption, the electronic characteristics of the surface can change



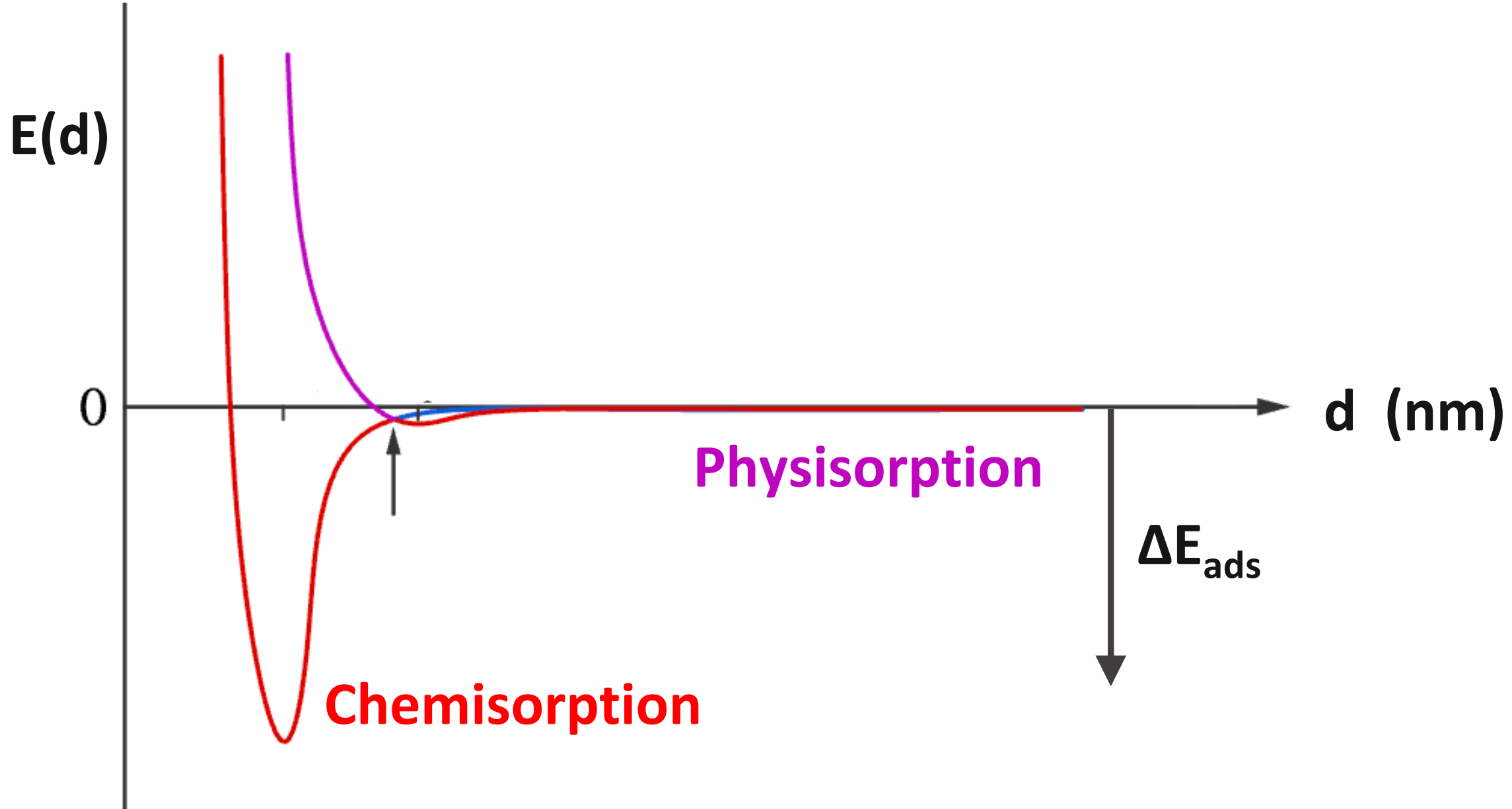
Crossover Point of Chemisorption/Physisorption Curves



No direct activation barrier for chemisorption to happen



Activation barrier for chemisorption to happen



Chemisorption on Surfaces Often Occur After Physisorption

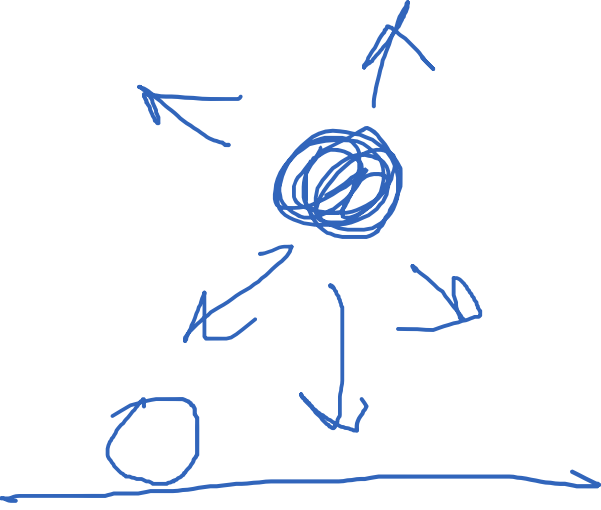
Spontaneous process: $\Delta G < 0$

Adsorbate loses degrees of freedom upon adsorption: $\Delta S < 0$

$$\Delta G = \Delta H - T\Delta S \rightarrow +$$



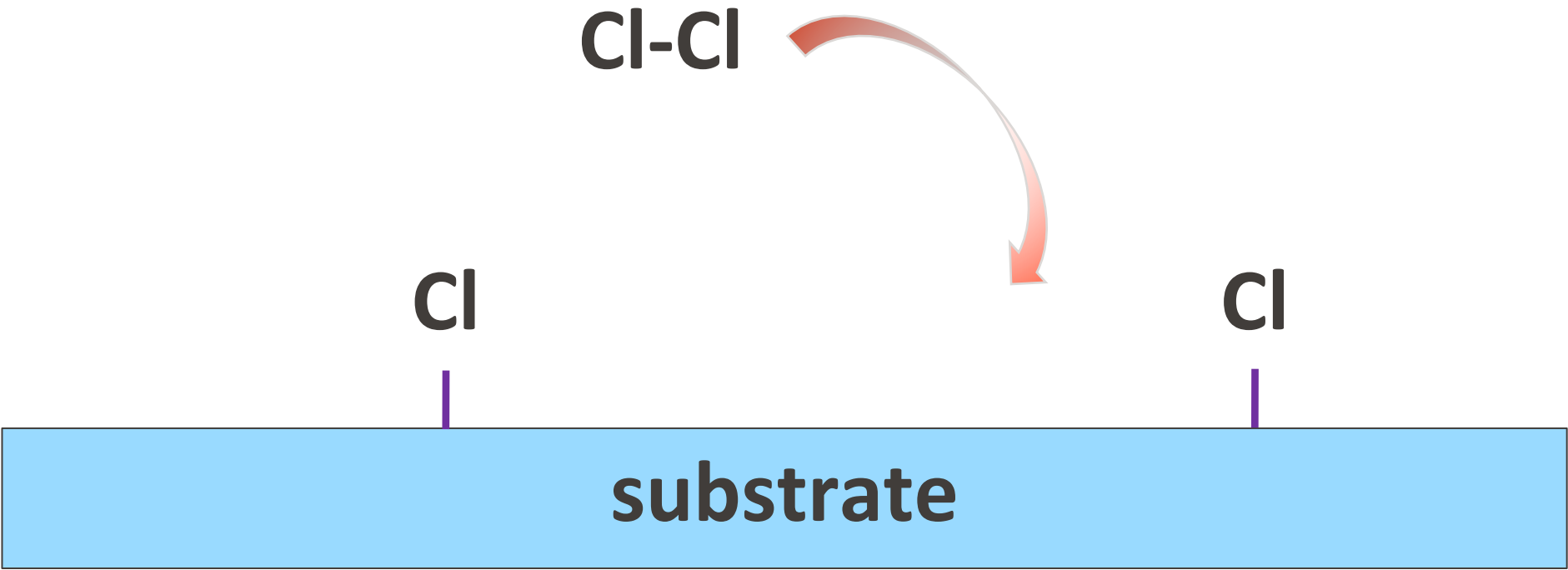
Almost always exothermic: $\Delta H < 0$



Atomic Structure

17
Cl
Chlorine
35.45

Dissociation energy (strength of chemical bond) high in gas phase



Surface interactions reduce energy required to break Cl-Cl bond

Metal surfaces (e.g., Platinum) \rightarrow empty d orbitals

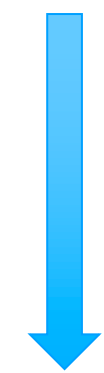
Semiconductors (e.g., Silicon) \rightarrow displace H atoms to create Si-Cl bonds

Catalytic surfaces inherently promote bond breaking!

Chemisorption Exception: H₂ on Glass

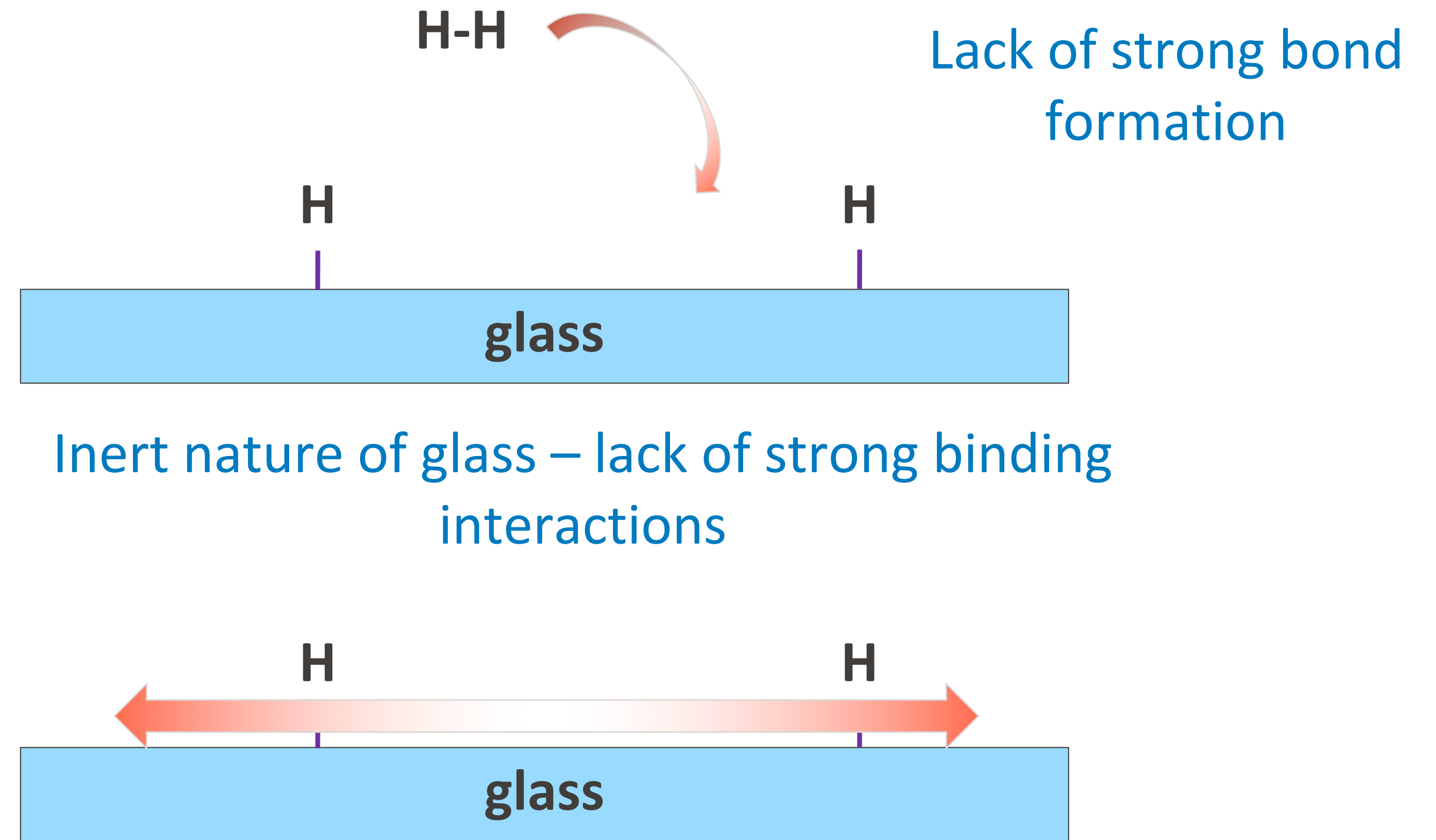
Spontaneous process: $\Delta G < 0$

Endothermic reaction: $\Delta H > 0$



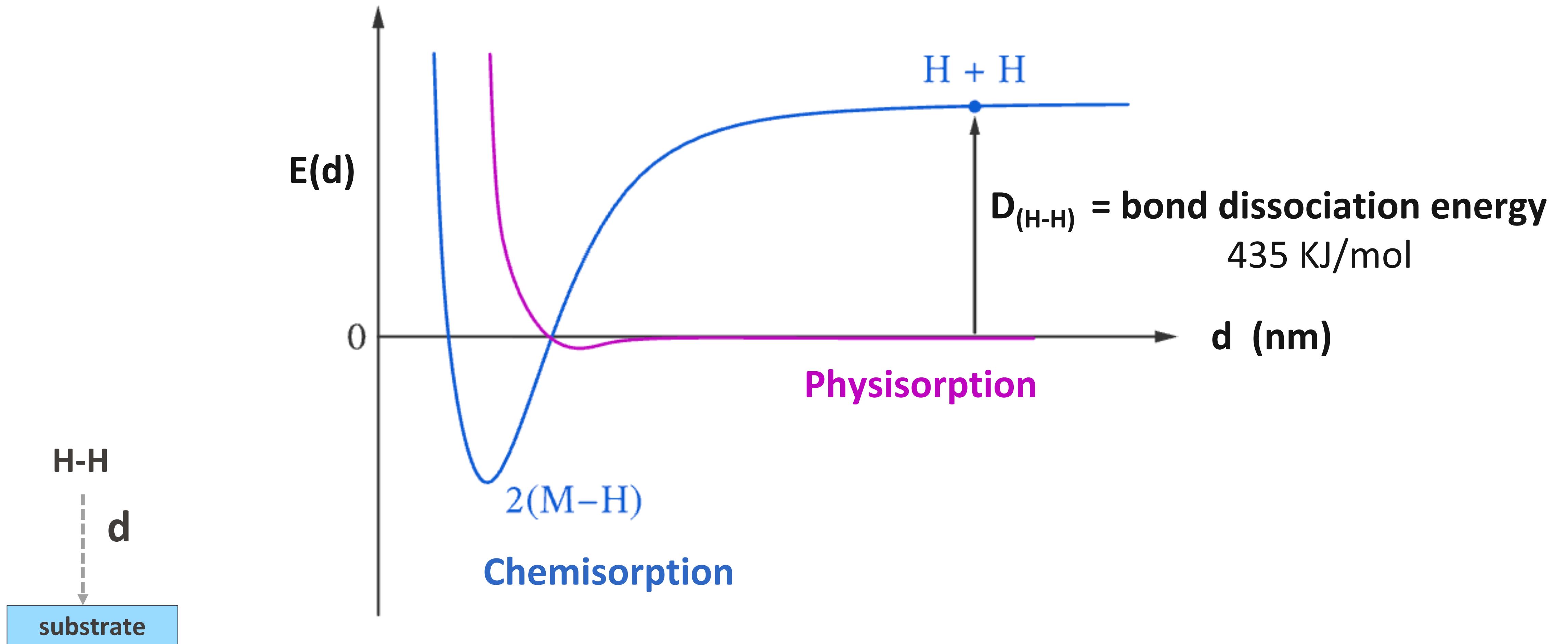
$$\Delta G = \Delta H - T\Delta S \rightarrow -$$

$\Delta S > 0$ meaning that entropy *increases*



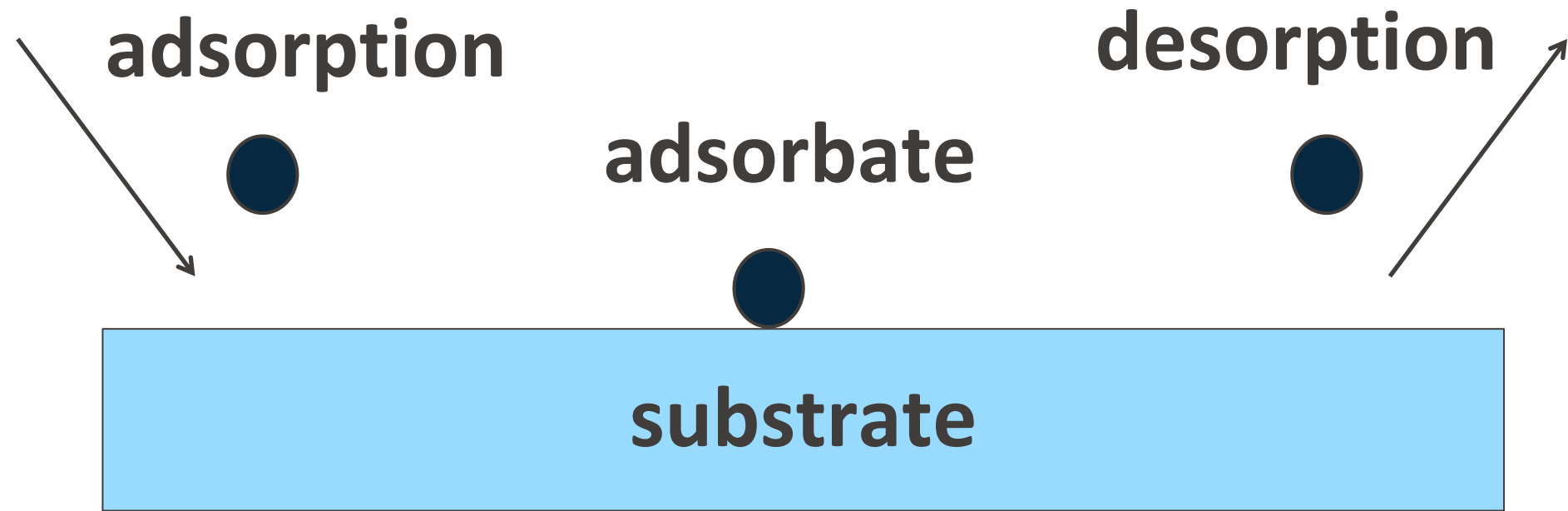
Adsorbed H diffuses readily on glass and therefore the two diffusing atoms have more degrees of freedom than the gas-phase diatomic molecule

The Different Paths For H₂ Adsorption to the Surface



This concept is important for how catalysis works in a future lesson

Desorption from the Surface



Breaking of chemical bonds and removal of adsorbed species from the surface

Molecule requires sufficient energy to activate the desorption (E_d)

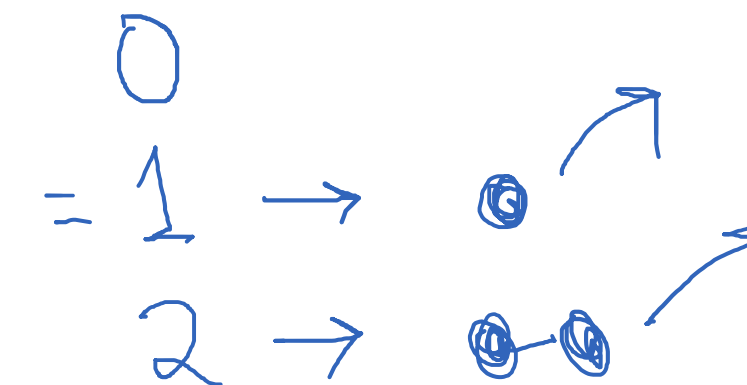
Desorption is temperature dependent and is described by:

desorption rate

$$\frac{d\theta}{dt} = -\frac{dN_i}{dt} = -\nu_i N_i^m \cdot \exp\left(\frac{-E_{d,i}}{RT}\right)$$

Polanyi-Wigner equation

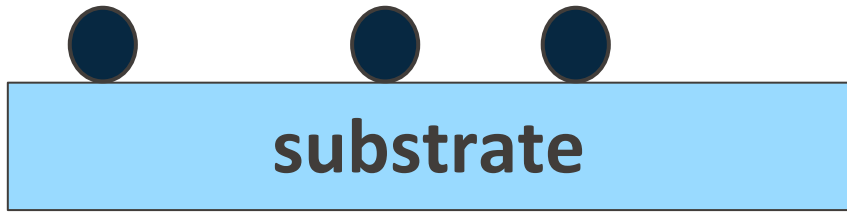
- N_i : surface concentration of the adsorbate
- ν_i : frequency factor – how often molecules try to escape
- E_{di} : desorption activation energy
- m : order of the desorption reaction



adsorbate
vibrations
binding geometry
 $10^{12} - 10^{13} \text{ s}^{-1}$

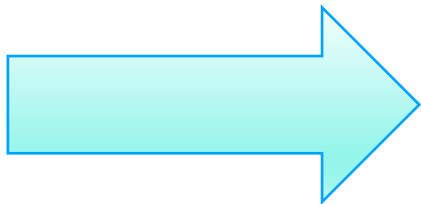
Ordered Adsorbate Layers

Small 2-D islands possibly ordered or completely disordered layers

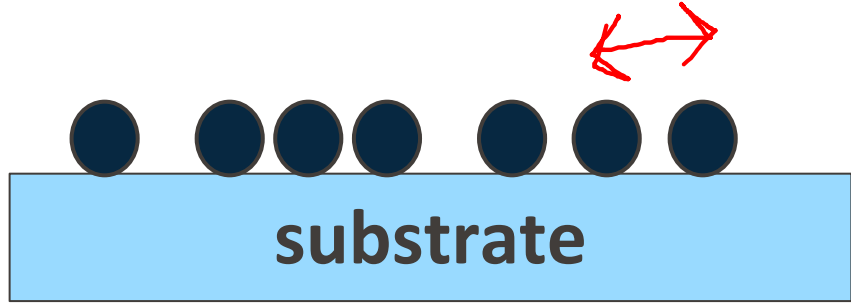


Low surface coverage

$$\theta = 0.25$$



Crowding and interactions

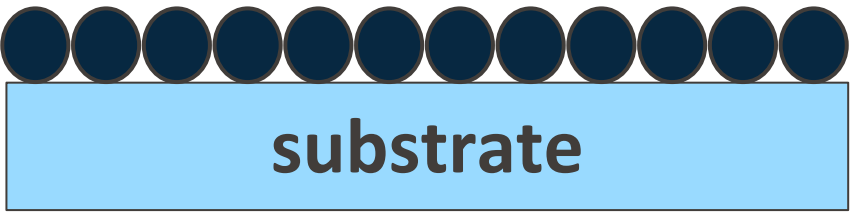


Medium surface coverage
(5-10 Å between atoms)

$$\theta = 0.5$$



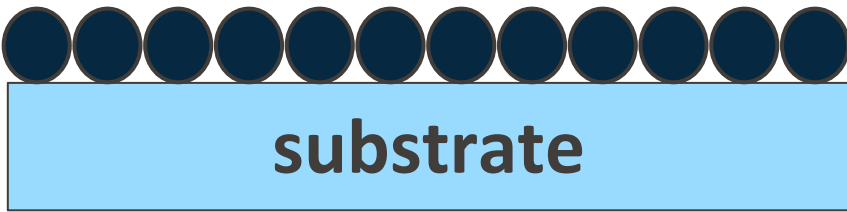
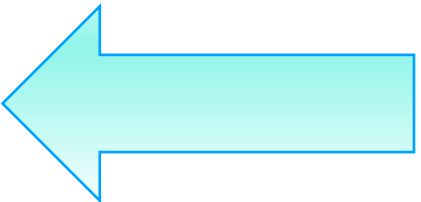
Adsorbate-substrate
Adsorbate-adsorbate



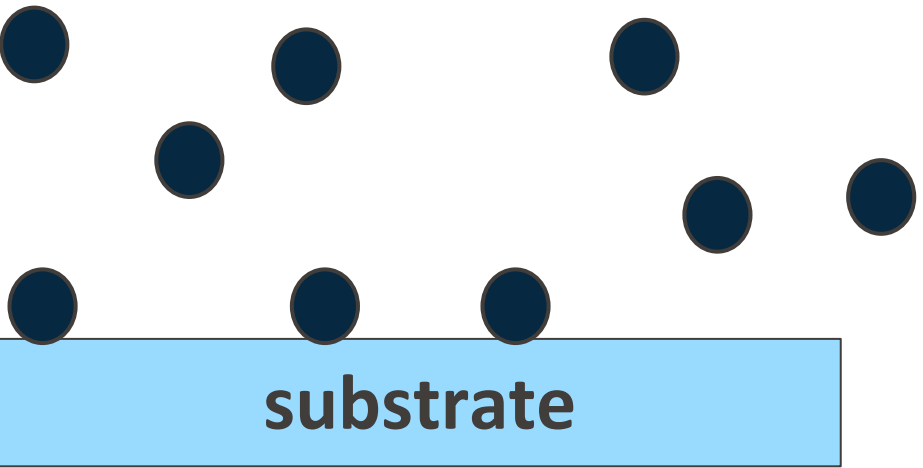
High surface coverage
Arranged to minimize energy

$$\theta = 1$$

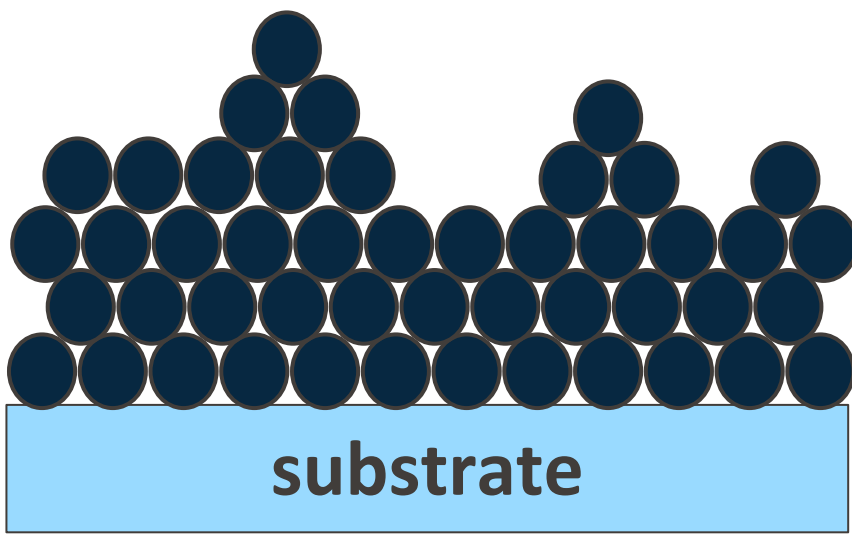
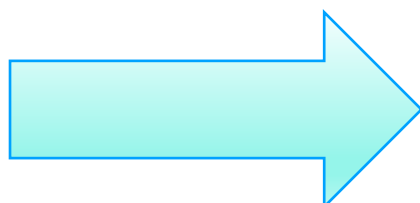
Monolayer adsorption



Adsorbate



Multilayer adsorption



Crystal structure of the surface dictates where molecules adsorb

Key Takeaways

Contamination comes from air, humidity, residues, dust, handling, etc.

Adsorption = surface, Absorption = bulk

Physisorption = weak and reversible
Chemisorption = strong and permanent

Adsorbates are arranged on surfaces to minimize surface energy

How are adsorbates arranged on surfaces?

Solid Surfaces: Short Recap of Lattice Structures

Amorphous solids



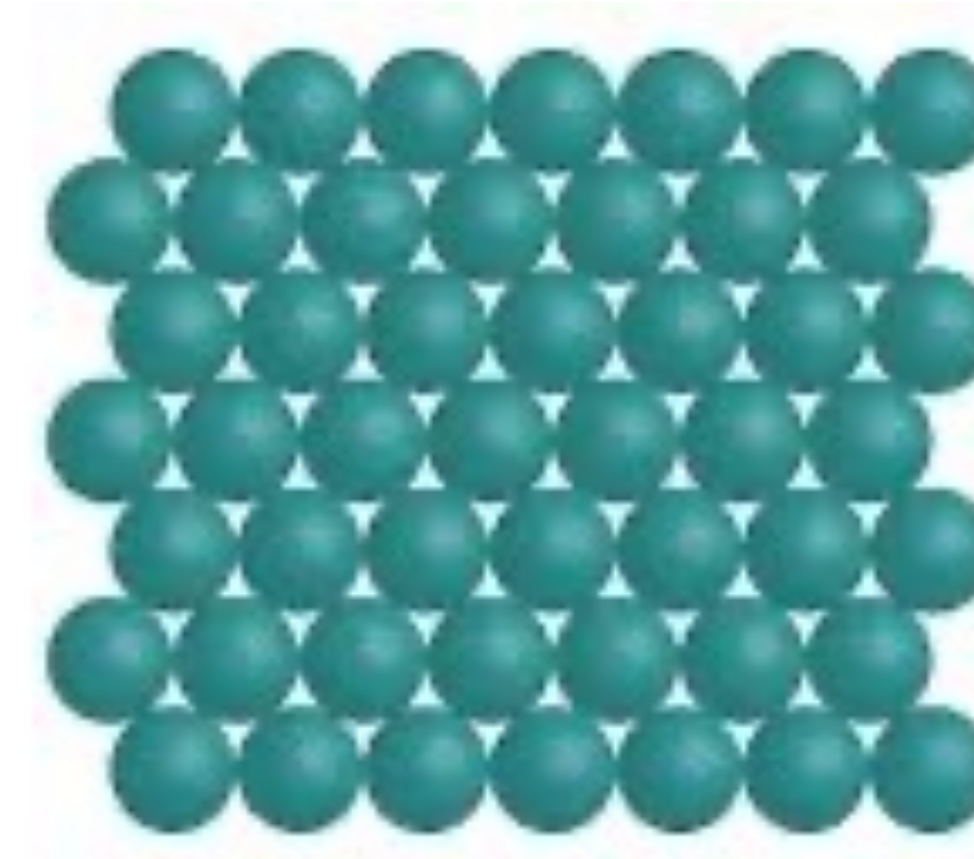
Random arrangement

No definite shape, can be molded

Softens over range of temperatures

Glass, plastic, gels

Crystalline solids



Regular repeating lattice

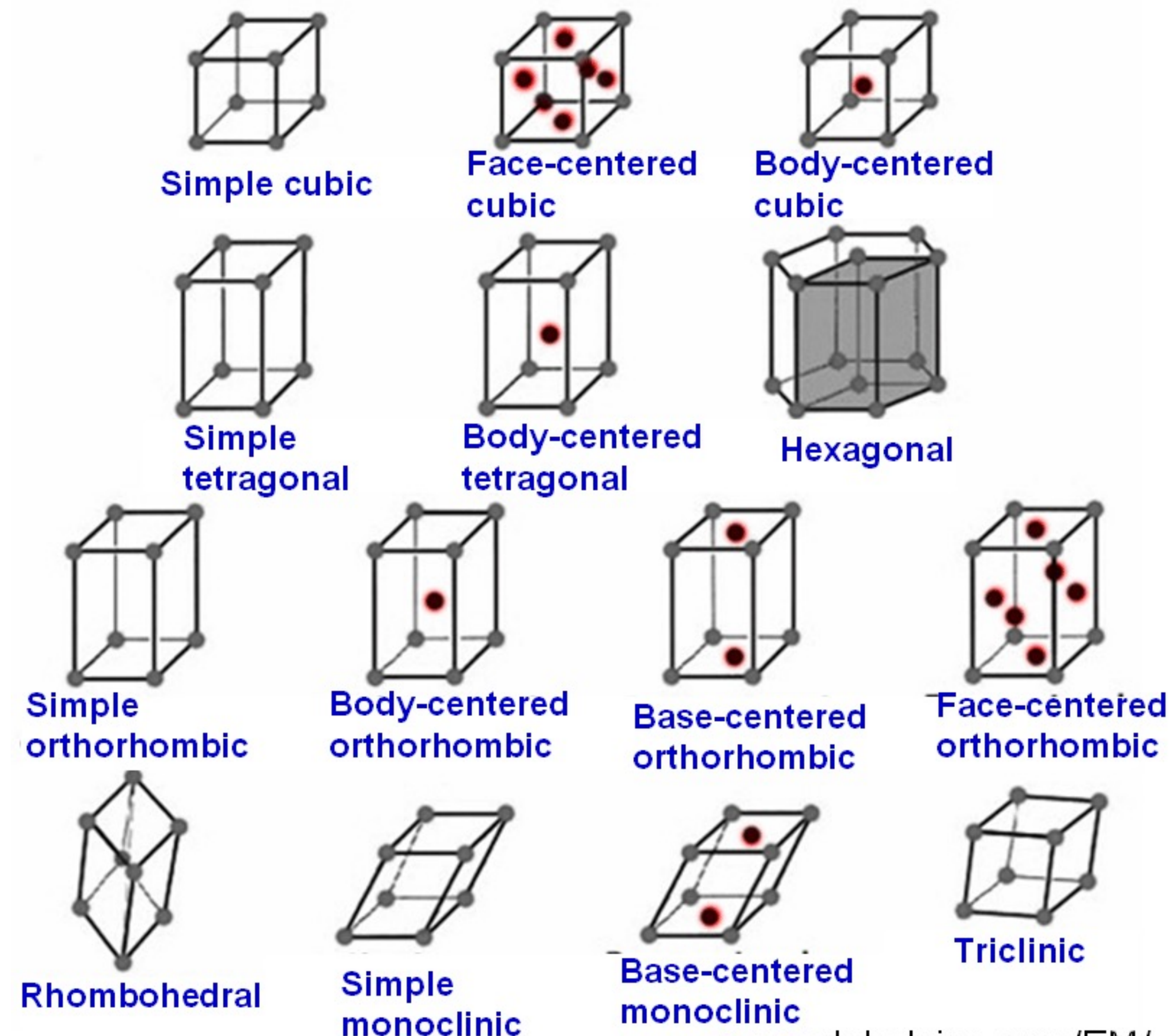
Definite geometric shape

Sharp, well-defined melting point

Salt, diamond, sugar

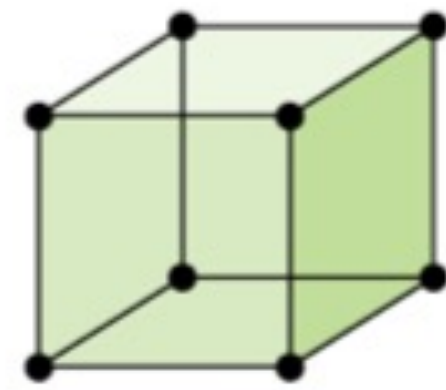
The 14 Bravais Lattices for all 3-D Crystals

All 3-D crystals can be described by one of these lattices. What matters is remembering that a crystal is a periodic arrangement of atoms, and depending on how we slice it, you expose different planes

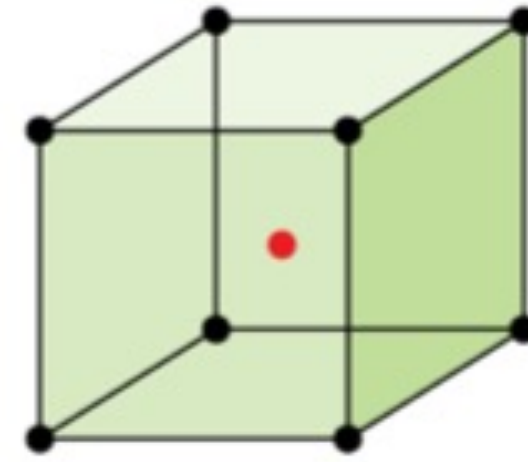


www.globalsino.com/EM/

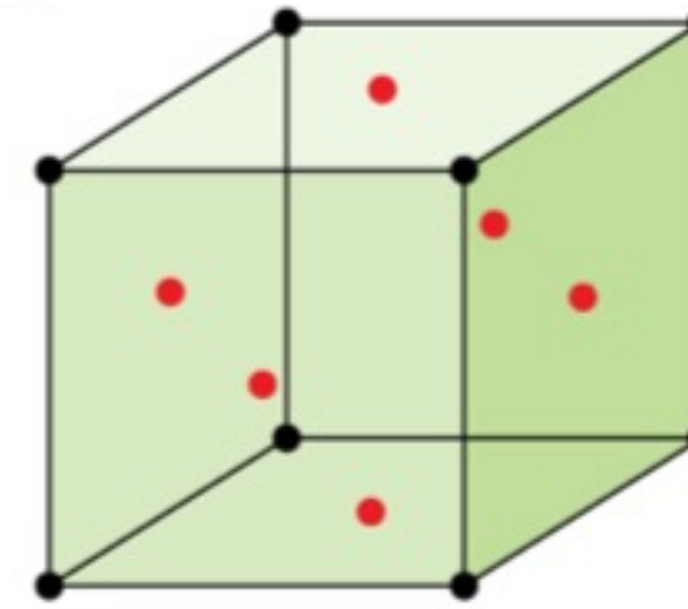
Common Cubic Lattices for Surface Science



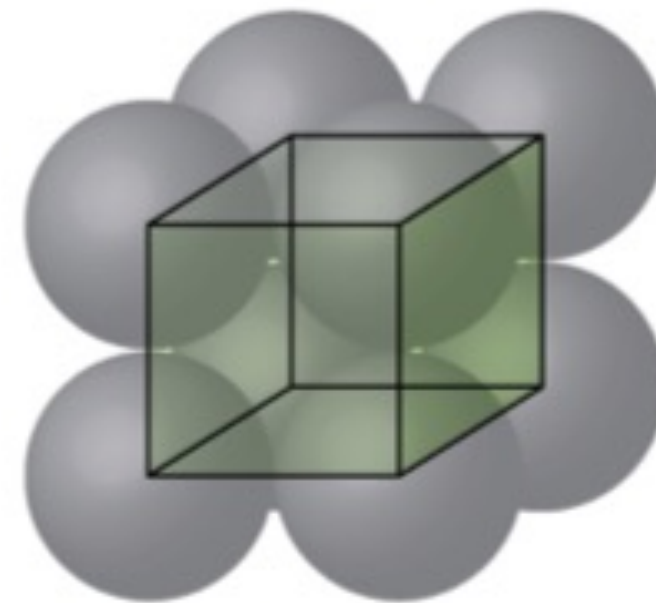
Simple
cubic



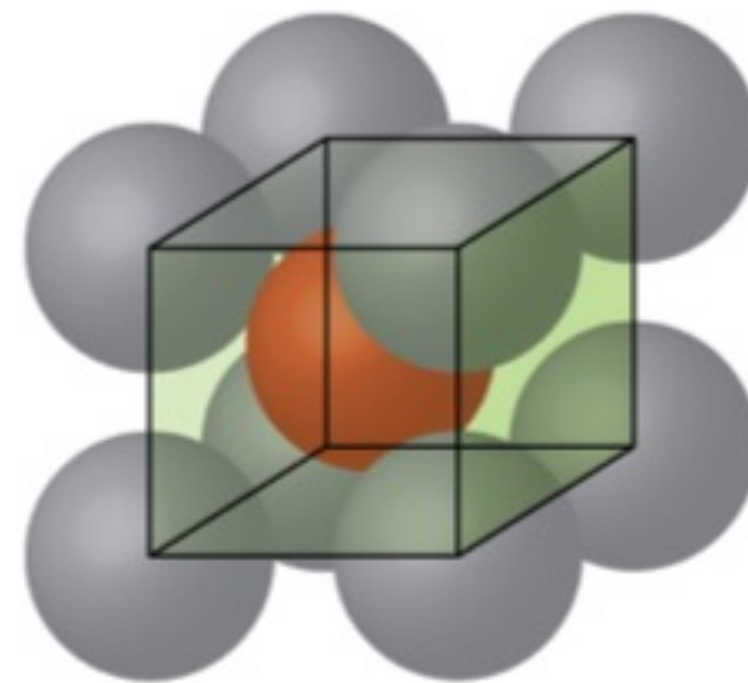
Body-centered cubic
(bcc)



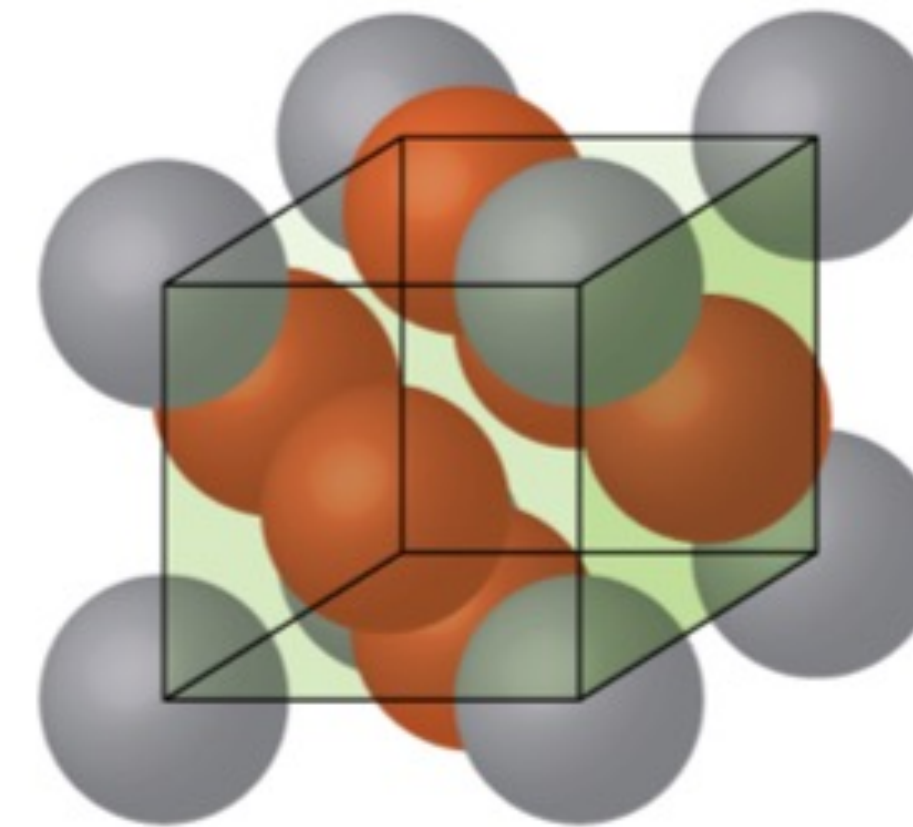
Face-centered cubic
(fcc)



Polonium
(rare in Nature)



Iron, Tungsten
Chromium,
Molybdenum



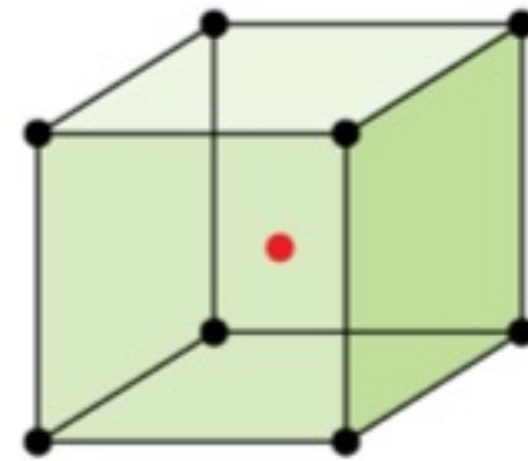
Copper, Nickel
Aluminum, Platinum
Gold, Lead

Close-Packed Structures: Role in Adsorption/Absorption

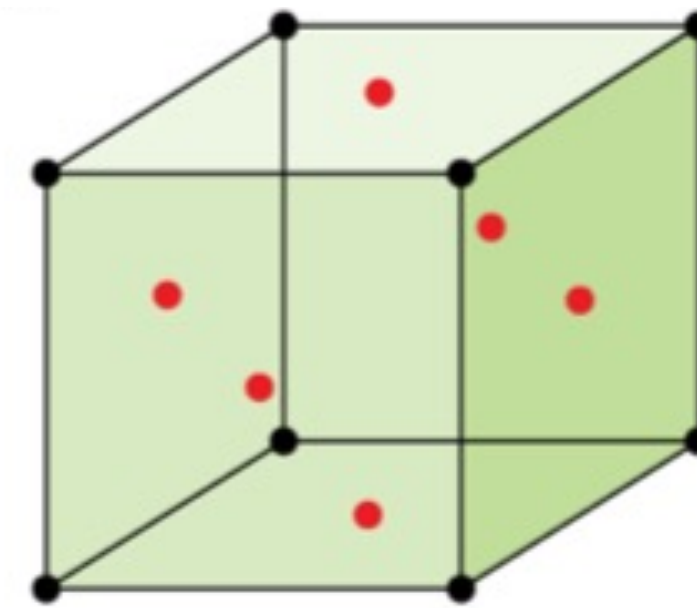
Structures where atoms are packed as closely as possible and minimizing empty space

$$\text{Packing efficiency} = \frac{\text{Volume occupied by atoms}}{\text{Volume of unit cell}} \times 100$$

68%

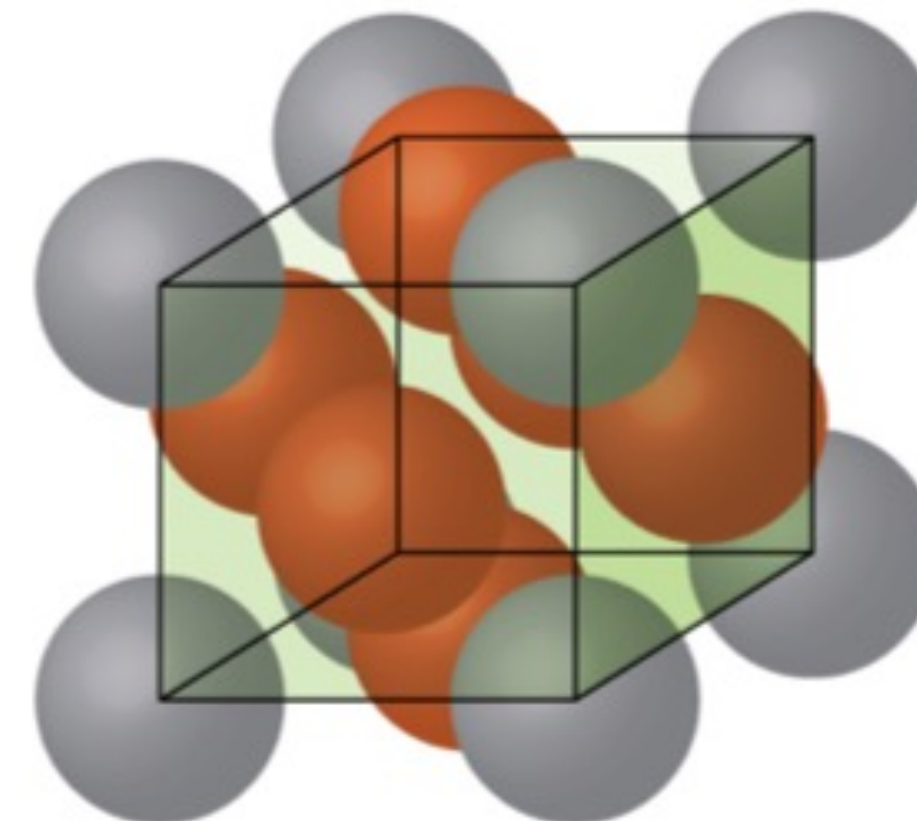
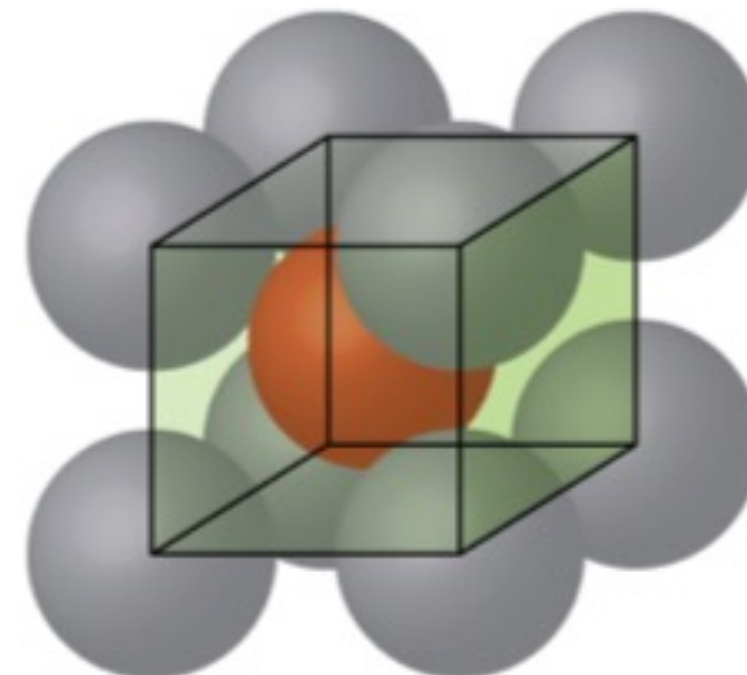


Body-centered cubic
(bcc)



74%

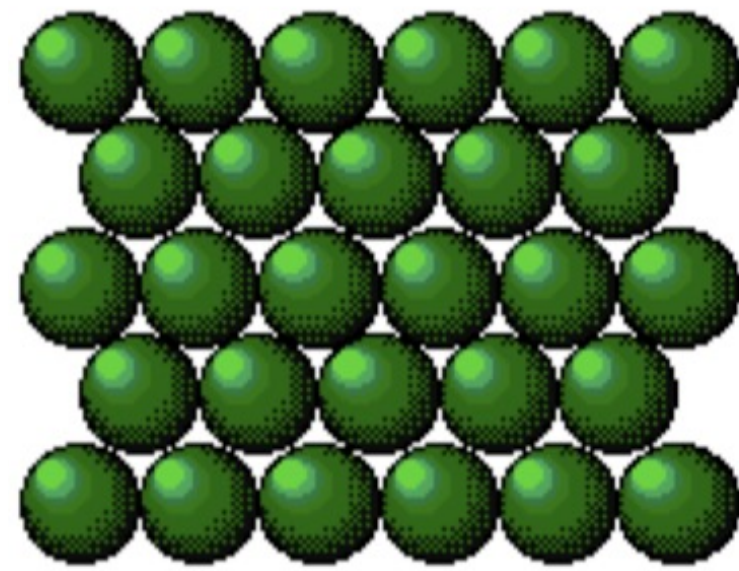
Face-centered cubic
(fcc)



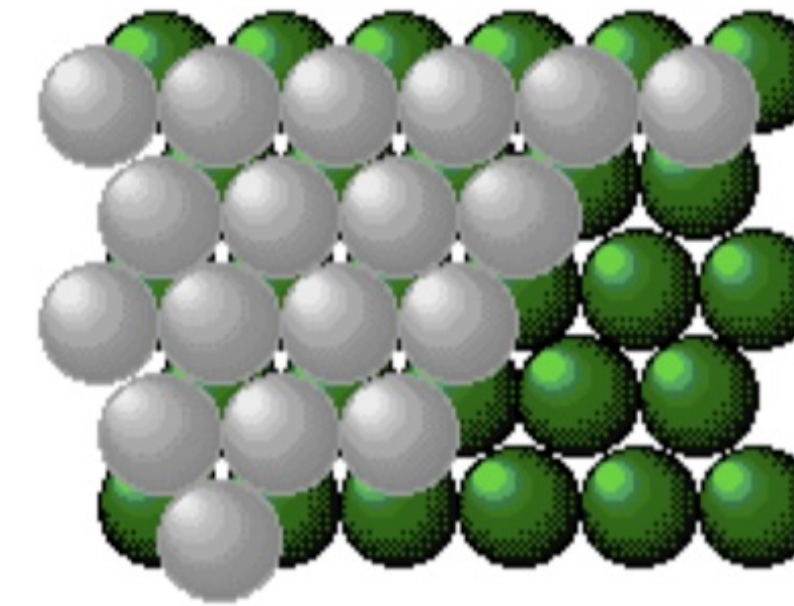
Close-Packed Structures: Role in Adsorption/Absorption

Structures where atoms are packed as closely as possible and minimizing empty space

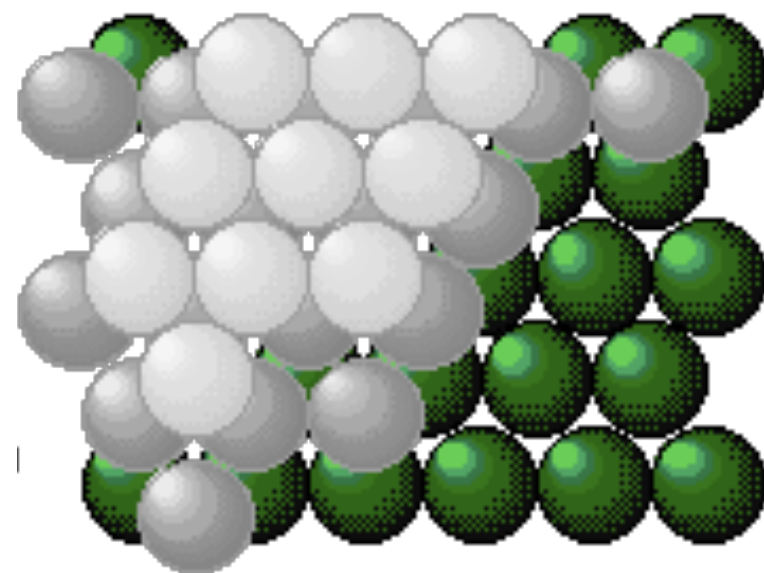
1st layer: close packed atoms



2nd layer: atoms are situated over gaps in the 1st layer



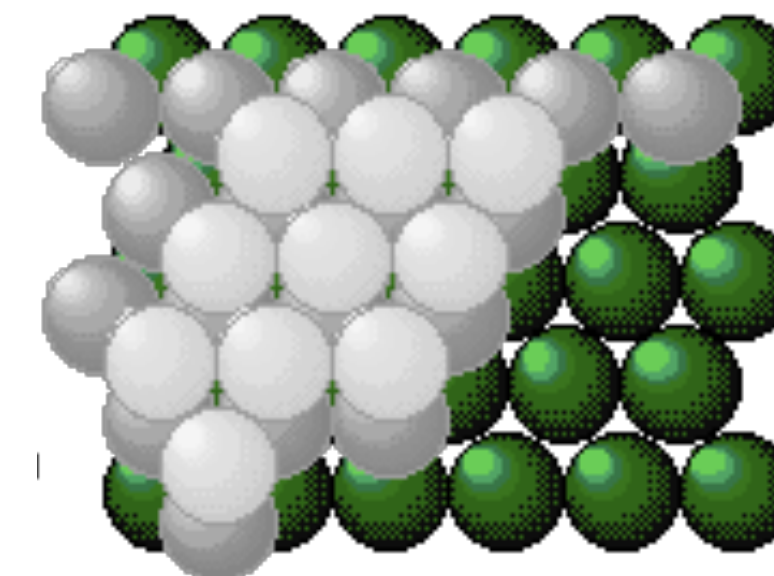
3rd layer: atoms are situated over the gaps in the 2nd layer



and over the atoms of the first layer

Hexagonal close packed

Two possibilities:

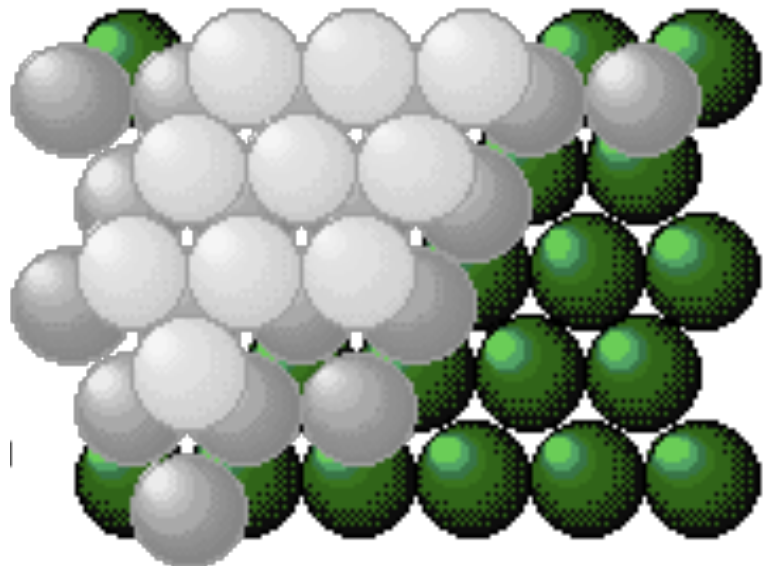


Over the gaps in the first layer

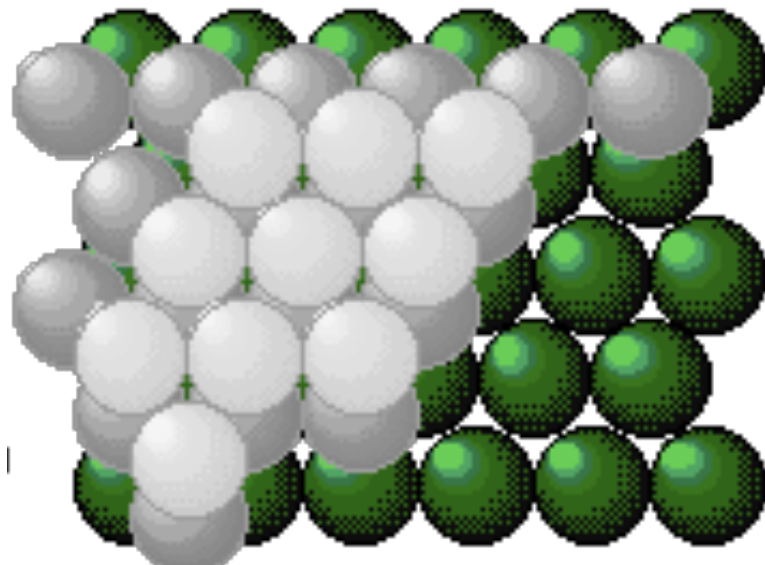
Cubic close packed

Close-Packed Structures: Role in Adsorption/Absorption

The packing efficiency influences both surface interactions (adsorption) and bulk interactions (absorption)

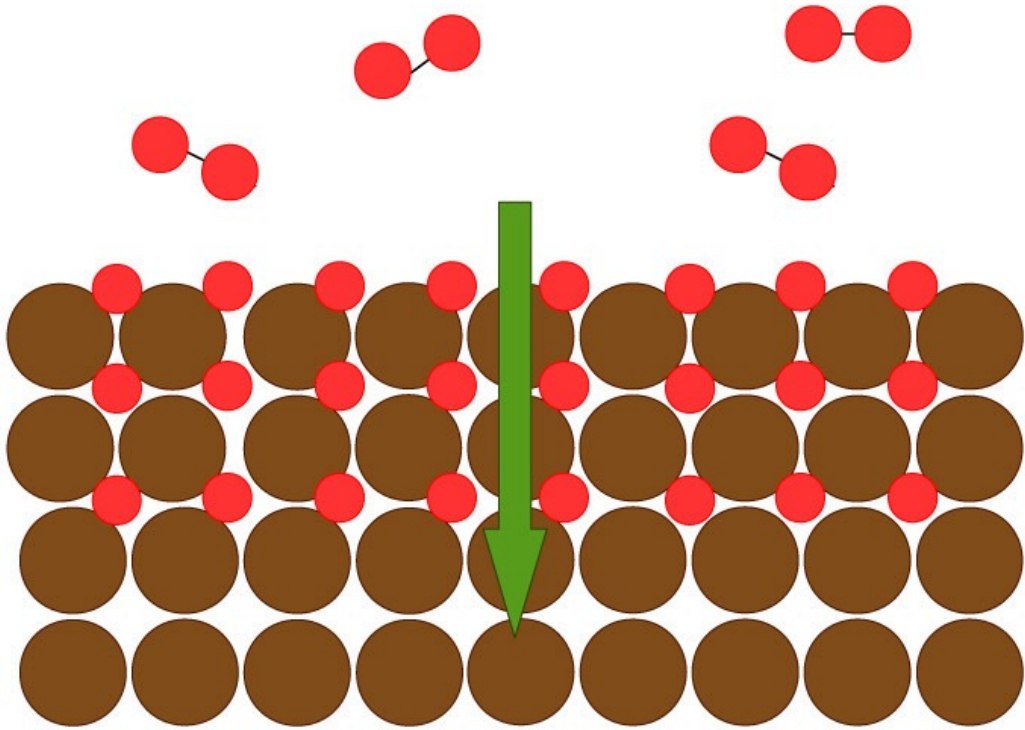


and over the atoms of the first layer
Hexagonal close packed

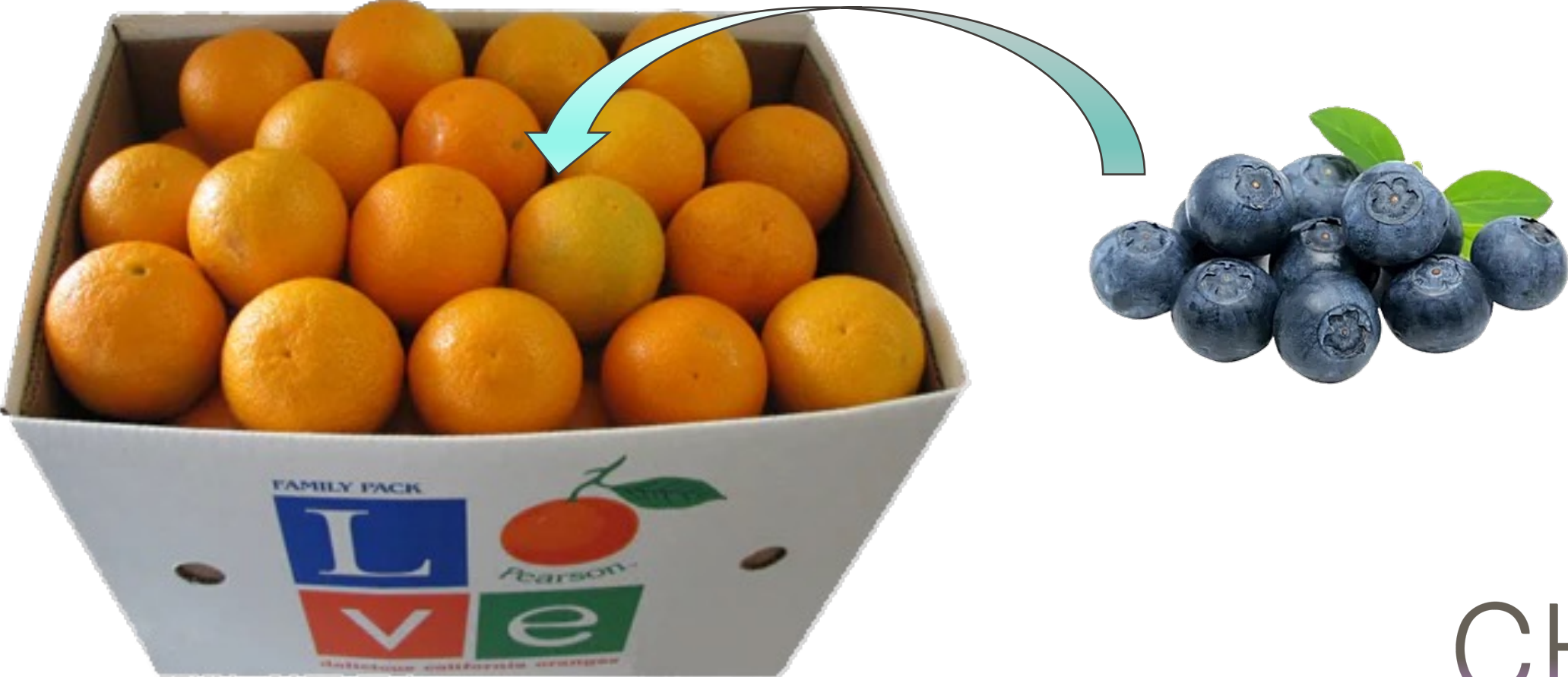


Over the gaps in the first layer
Cubic close packed

Interstitial sites (gaps between atoms in crystal lattices) define absorption pathways



Gattinoni & Michaelides | *Surf. Sci. Rep.* | 2015



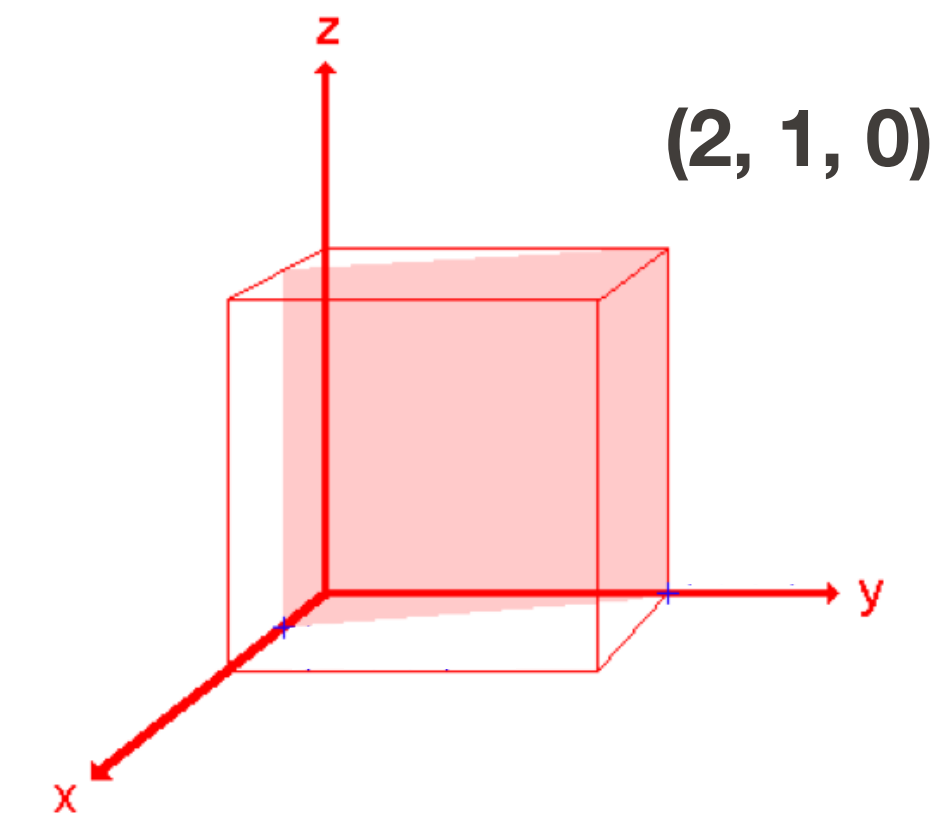
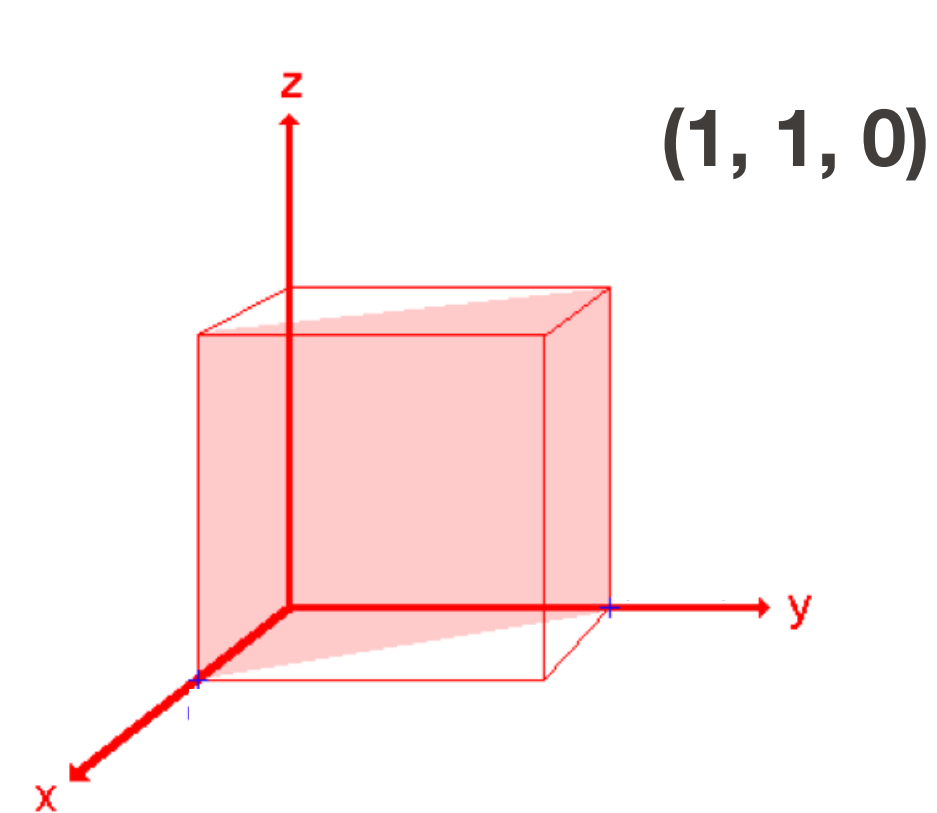
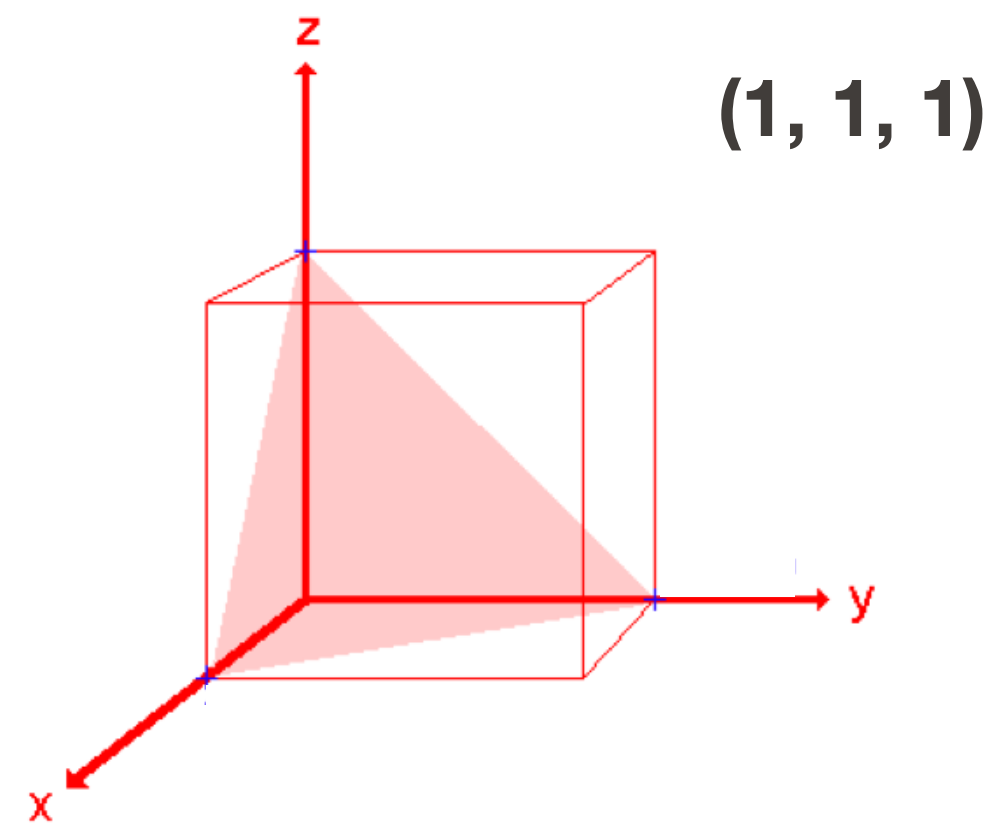
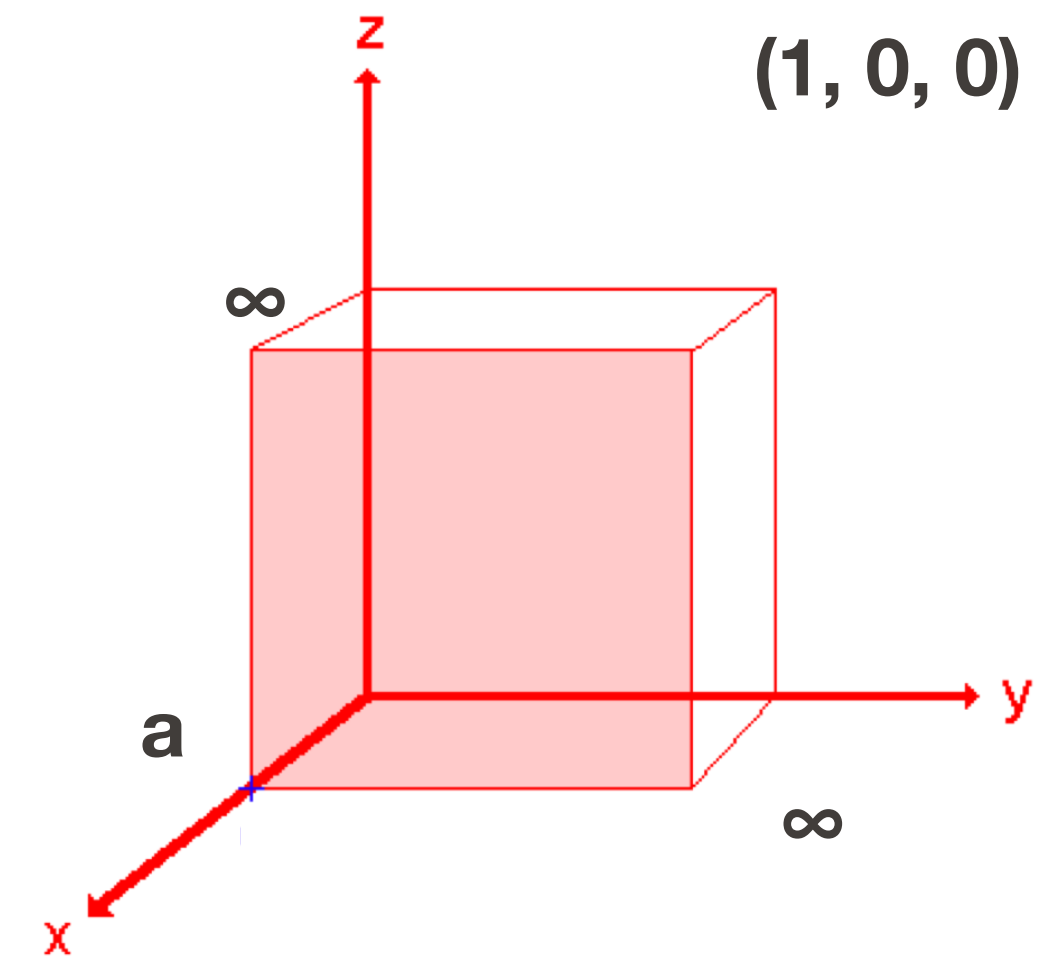
Miller Indices to Describe Crystal Planes

1. Identify where planes intersect the three axes

2. Take reciprocals of these locations in terms of lattice parameters a , b , c . If no intersection (parallel) then intersect is infinity (reciprocal is 0)

3. Use smallest whole numbers (1, 0, 0)

4. Put integers into parentheses to get Miller indices



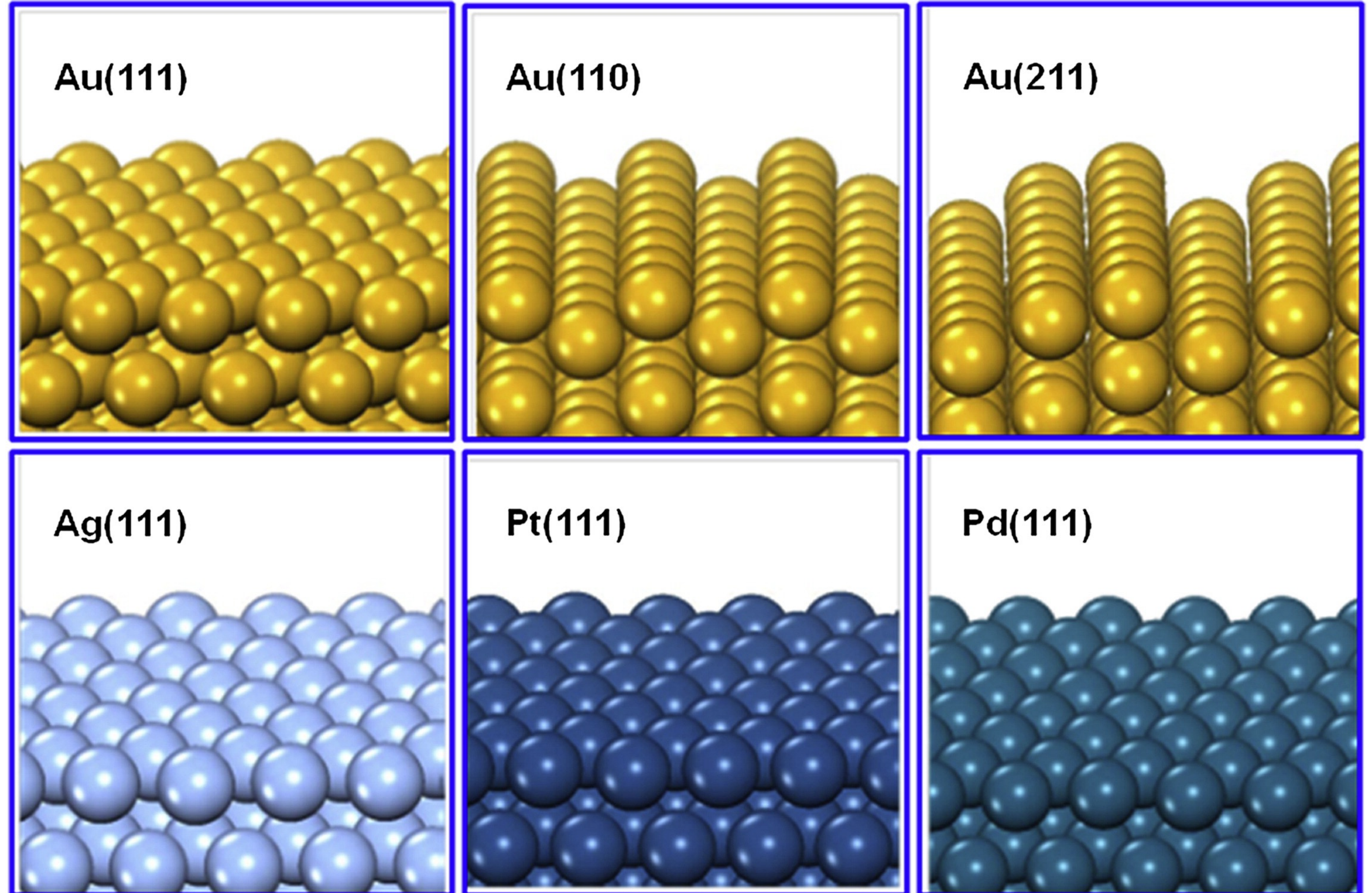
Atomic Arrangements of Atoms on Different Planes

Miller indices describe crystallographic planes in crystalline material

Each orientation represents specific arrangement of atoms on the surface of the crystal lattice, with distinct geometric and chemical properties

Variations in:

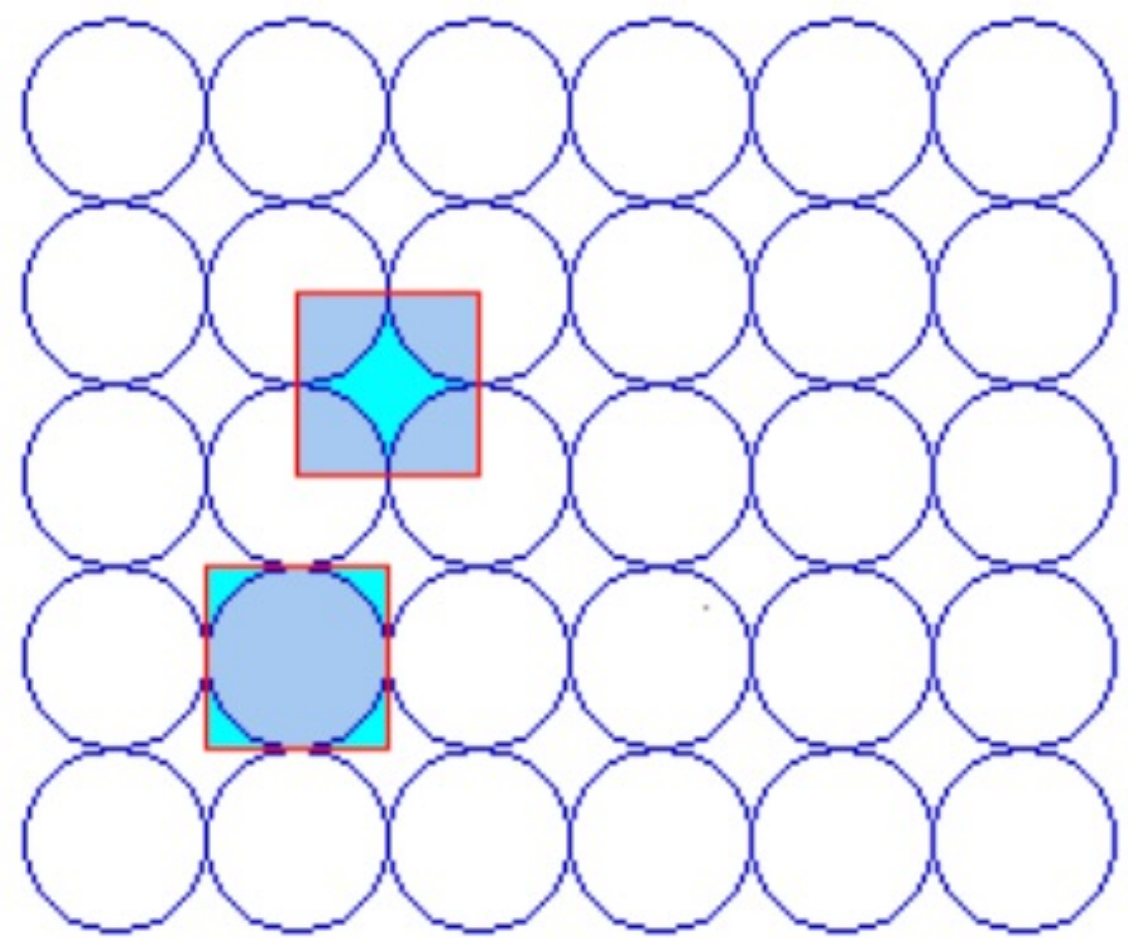
- Atomic density
- Surface energy
- Geometry
- Stability



Li et al., | Biomaterials | 2023

Ordered Adsorbate Layers in Relation to Substrate's Elementary Cell

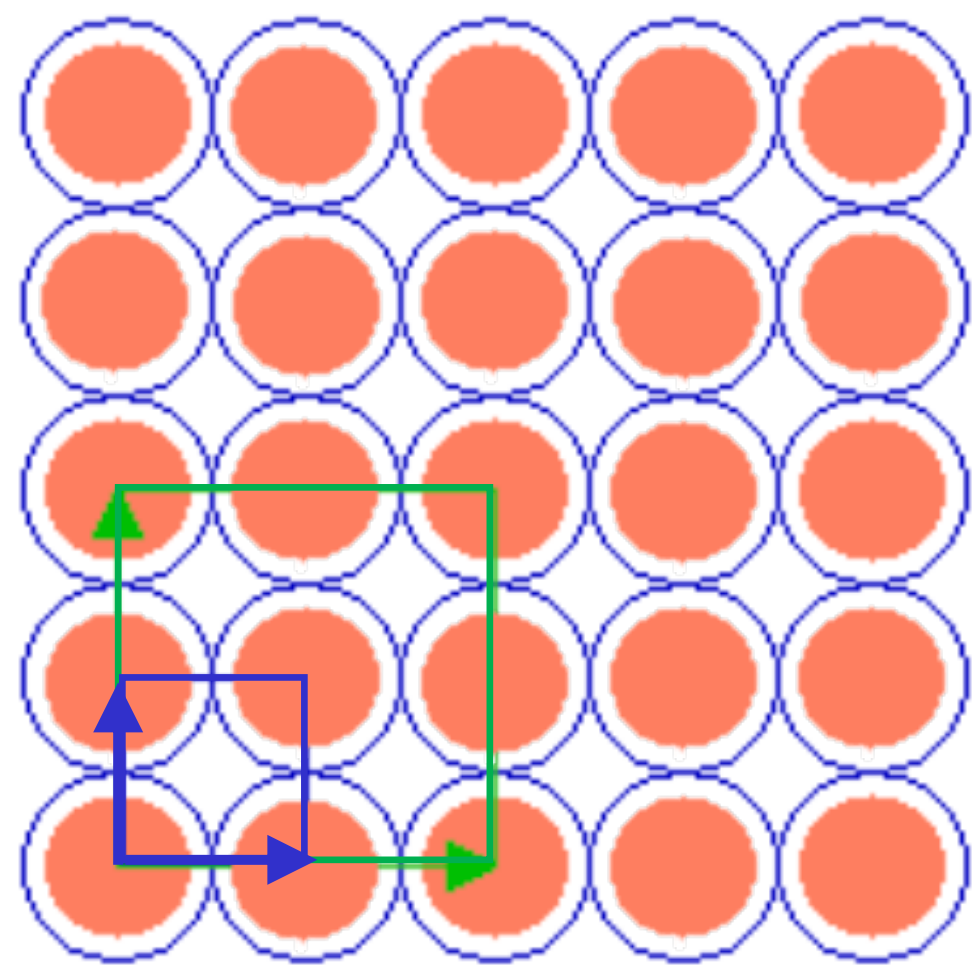
fcc(100) lattice



Two possible choices of unit cell

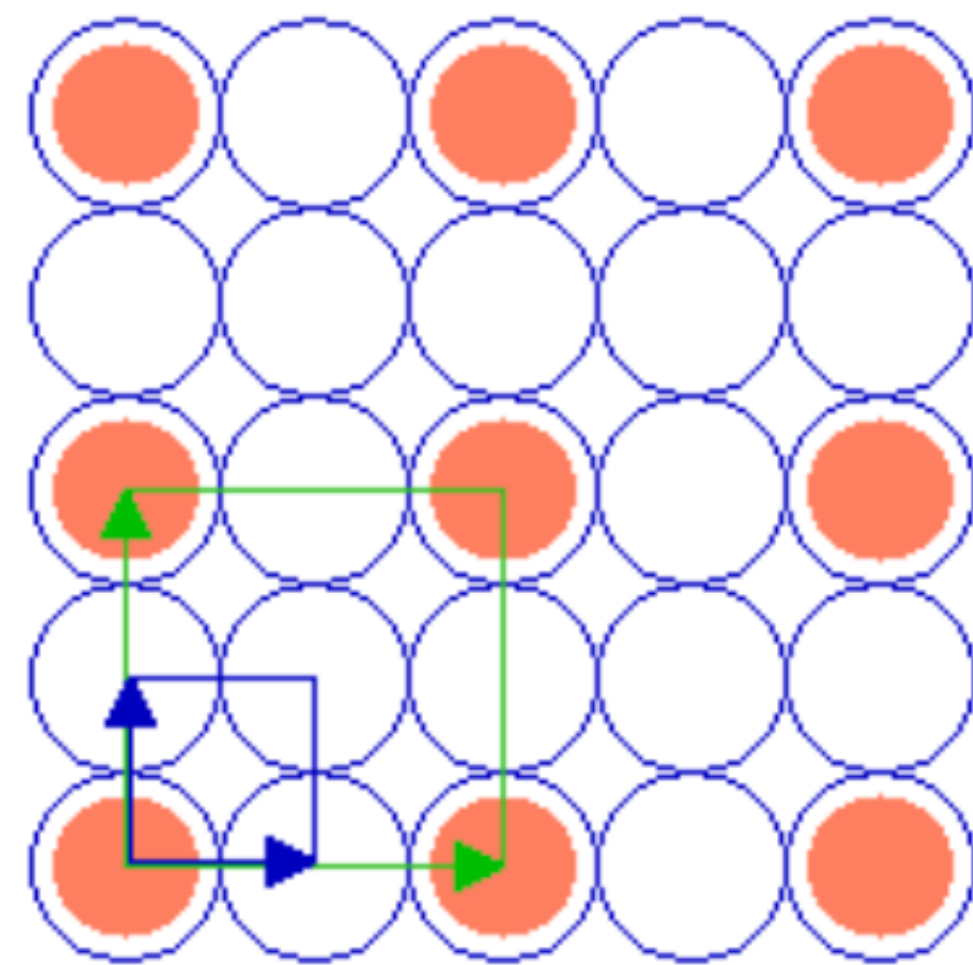
Substrate provides periodic grid of atoms

Adsorbates



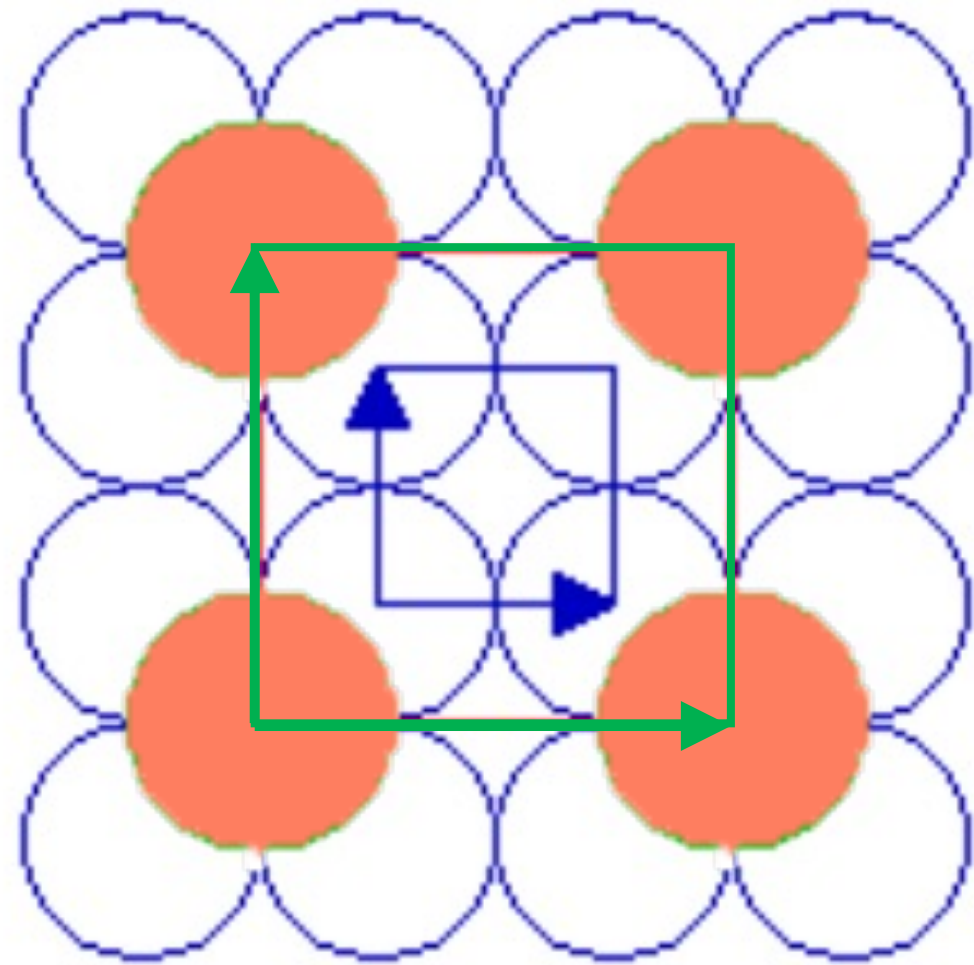
(1x1)
 $\theta = 1$

coverage



(2x2)
 $\theta = 1/4$

Adsorbate unit cell Substrate unit cell

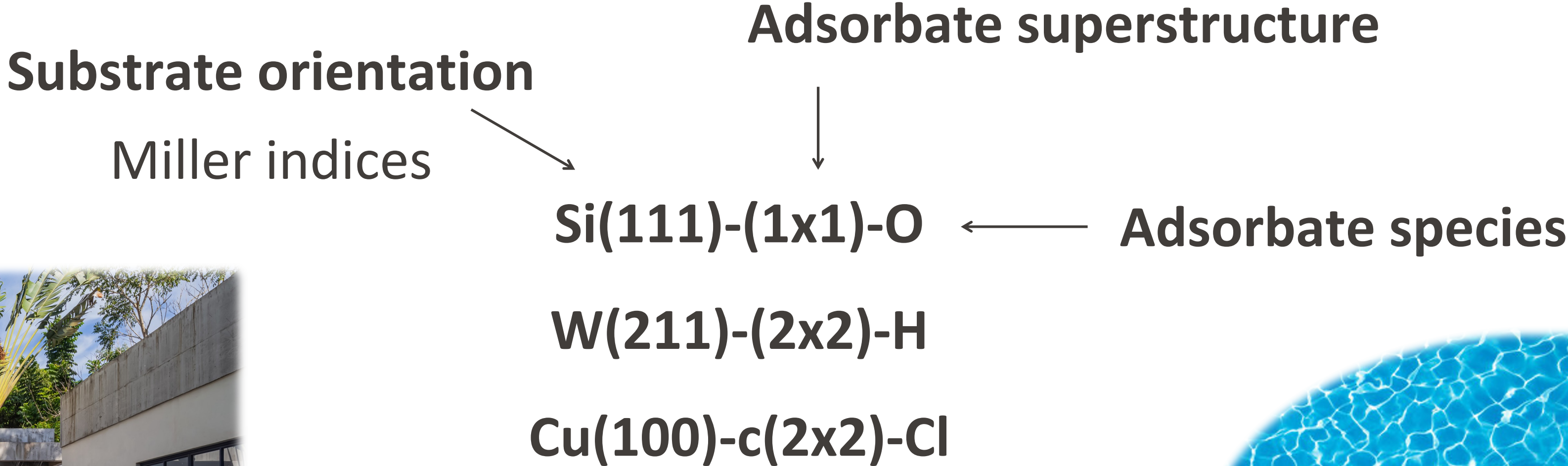


c(2x2)
 $\theta = 1/2$

*c = centered

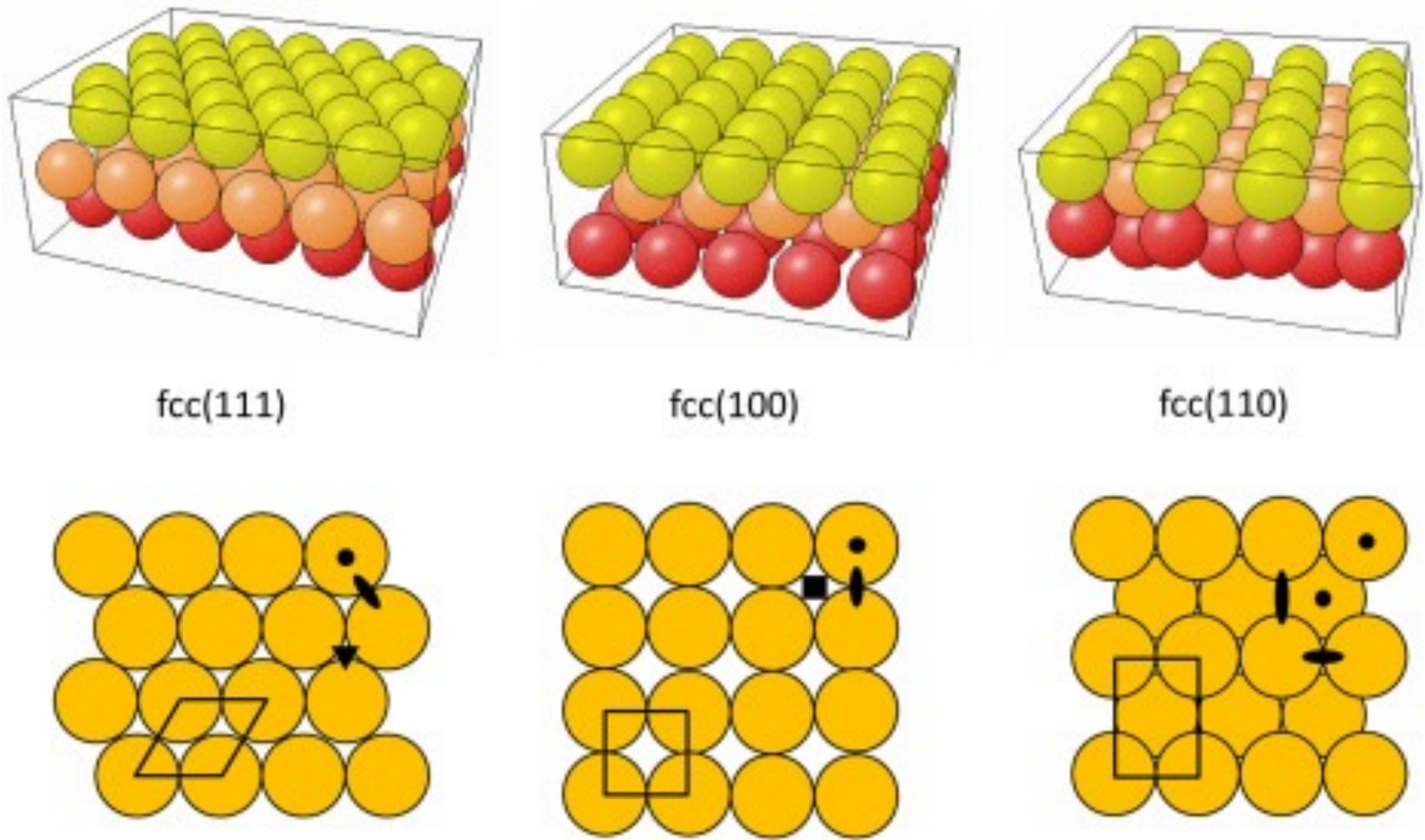
Adsorbates don't just stick randomly — they form ordered patterns based on substrate lattice

How to Read Wood's Notation (Adsorbate Address)



Face-Specific Behavior of Adsorption

Chloride ions adsorption on copper electrode surfaces

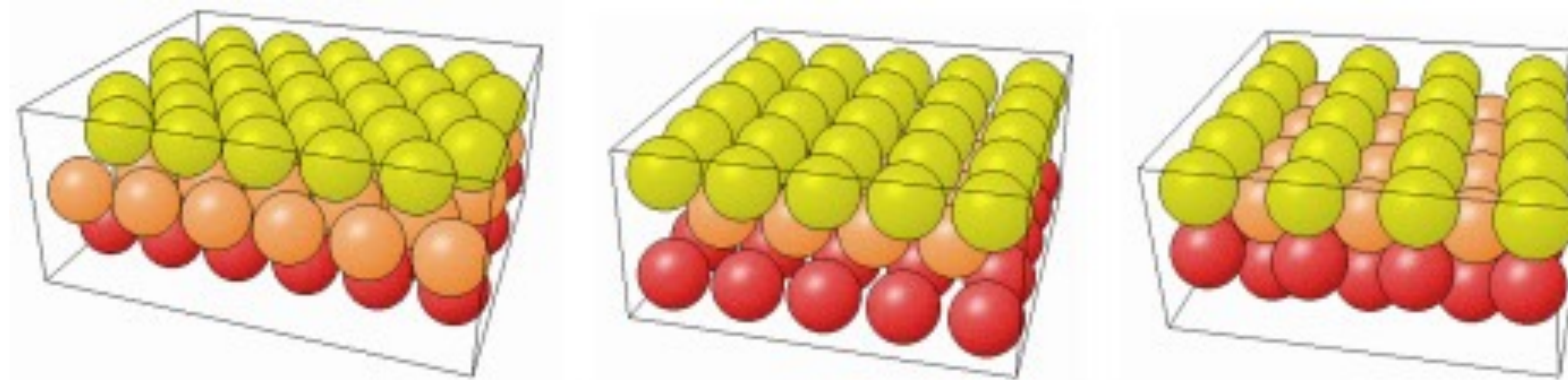


Wandelt | *Surf. Sci. Electrochem.* | 2018

Most symmetric adsorption sites are marked by the shapes

Visualizing Face-Specific Structure of Surfaces

Chloride ions adsorption on copper electrode surfaces

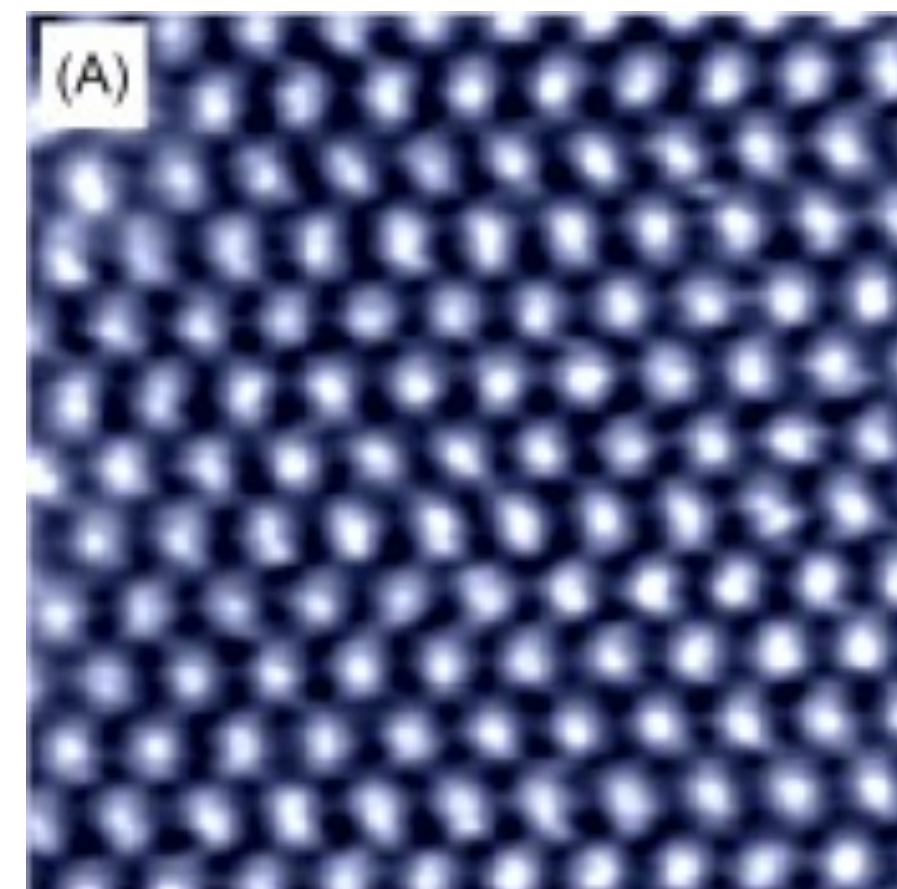


fcc(111)

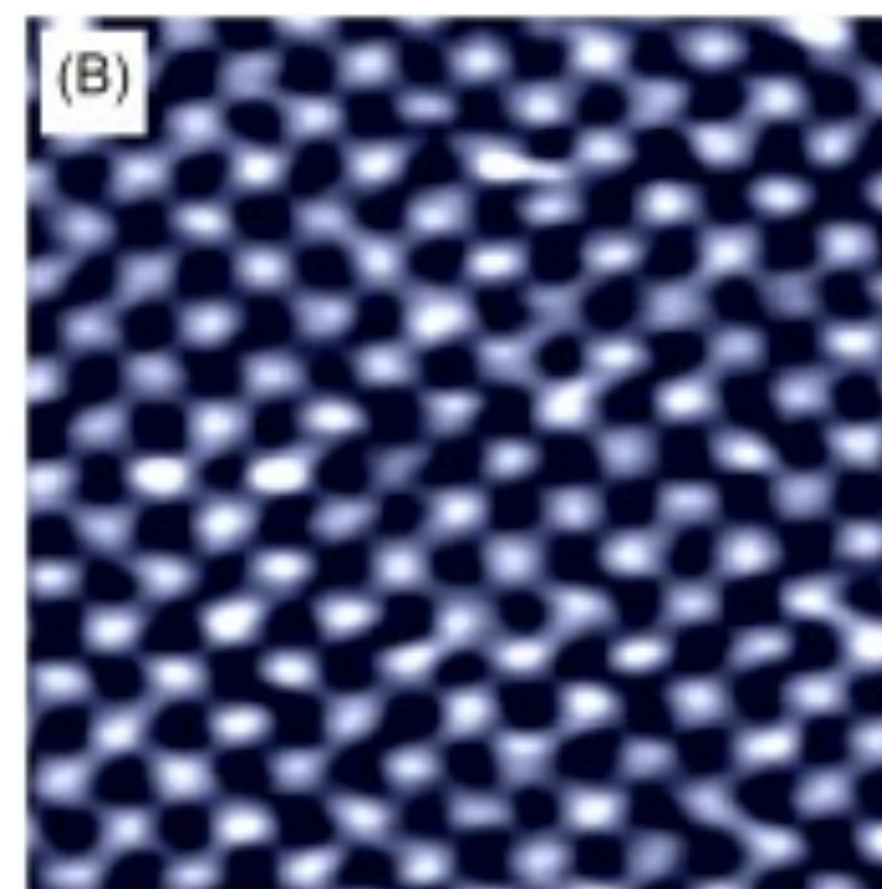
fcc(100)

fcc(110)

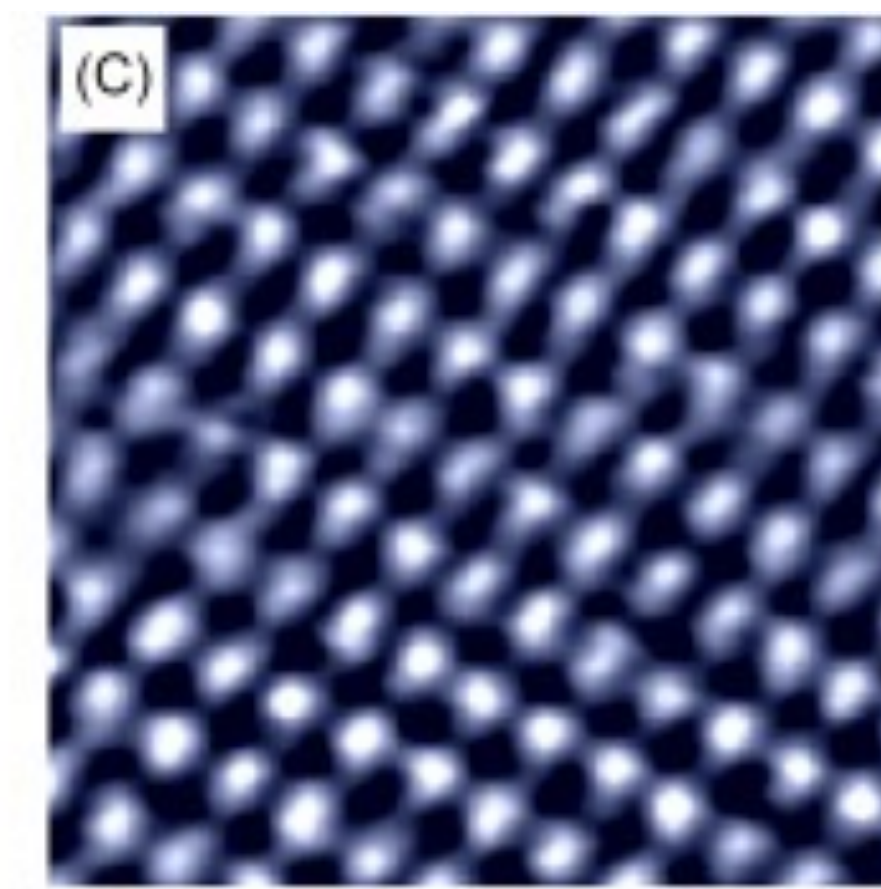
Scanning tunneling microscopy (STM) images of anion-free copper surfaces



Cu(111)



Cu(100)



Cu(110)

Scale:
~ 3 x 3 nm

Wandelt | *Surf. Sci. Electrochem.* | 2018

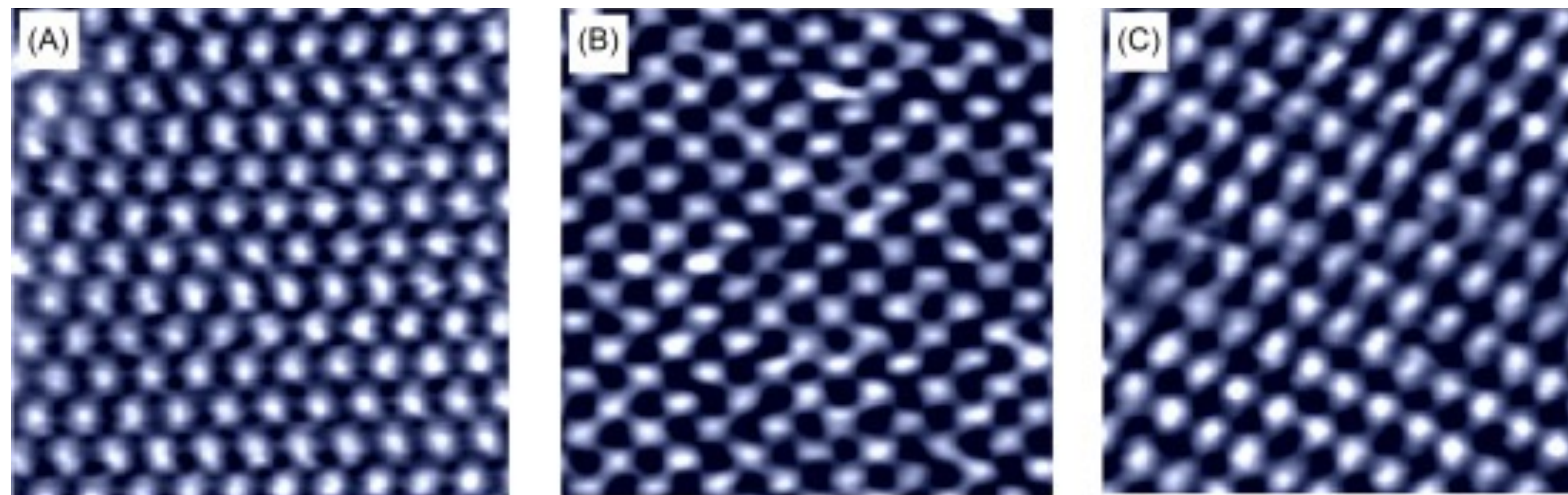
Extracting Face-Specific Parameters

FCC

	Cu(111) <i>hexa</i>	Cu(100) <i>square</i>	Cu(110) <i>rectangular</i>
Lattice constants (nm)	$\vec{a} = \vec{b} = 0.256; \alpha = 60^\circ$	$\vec{a} = \vec{b} = 0.256; \alpha = 90^\circ$	$a = 0.256, b = 0.362; \alpha = 90^\circ$
Density (atoms/cm ²)	1.767×10^{15} ↑	1.530×10^{15}	1.082×10^{15} ↓
Coordination number	9	8	7
Missing neighbors	3	4	5
Interlayer spacing (nm)	$d = 0.212$	$d = 0.181$	$d = 0.128$
Workfunction (eV)	4.94	4.59	4.48

12 neighbors

Scanning tunneling microscopy (STM) images of anion-free copper surfaces



Cu(111)

Cu(100)

Cu(110)

Scale:
~ 3 x 3 nm

Key Takeaways

Crystal lattice structures of surfaces defines how adsorbates stick

Packing of lattice structure influences adsorption/absorption

Adsorbates form ordered patterns on the substrate lattice (adsorbate address)

Depending on the cut of the crystal, adsorption behavior will change

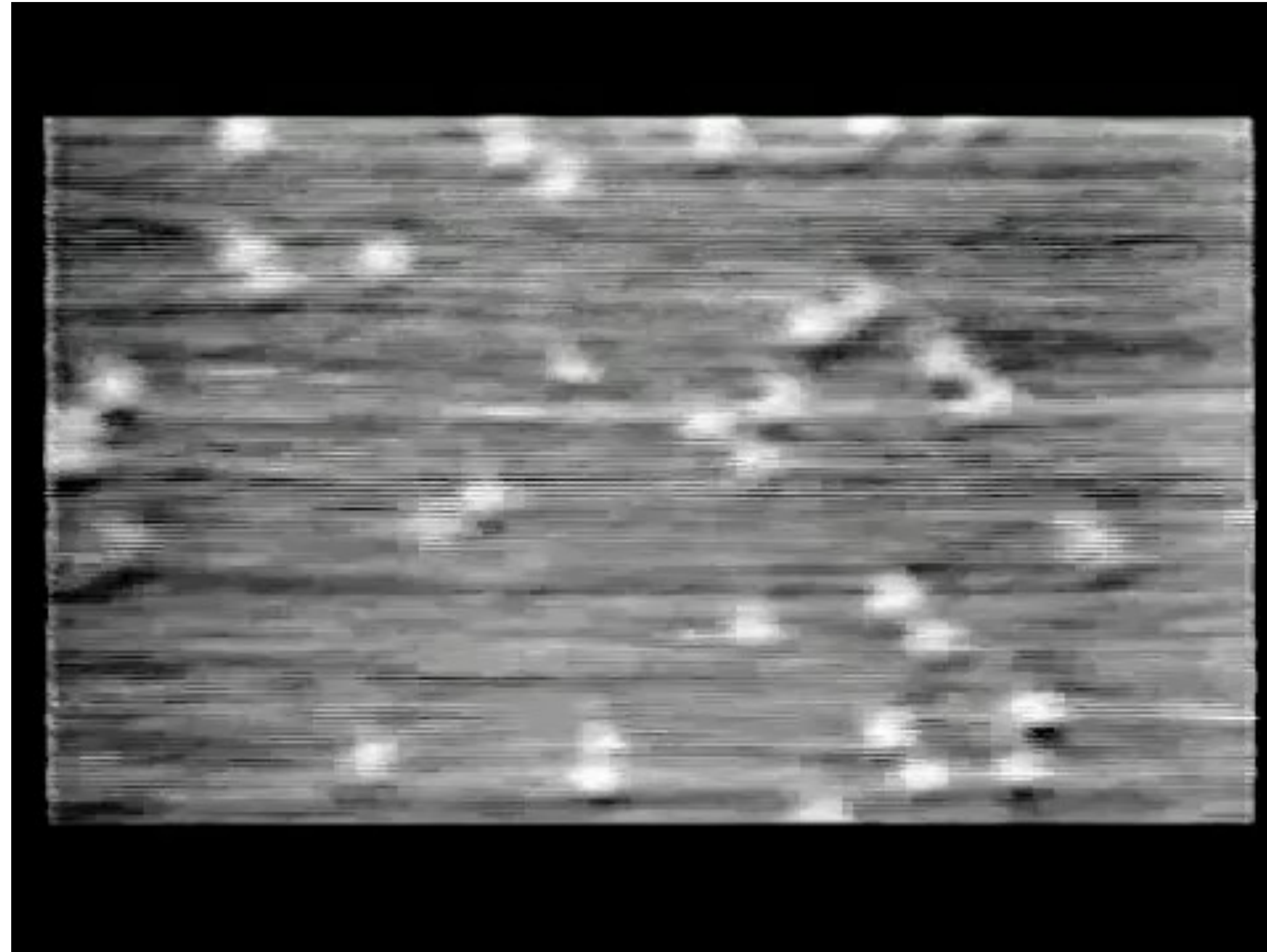
How can we characterize/visualize this phenomenon?

Real-Time Observation of Oxygen on Ruthenium Surface

Scanning tunneling microscopy (STM) images the random walk of individual oxygen atoms on Ru at 300 K

$$\theta < 0.25$$

$\theta = 0.25$ corresponds to a complete, ordered (2x2) overlayer



Experiments conducted in a UHV chamber

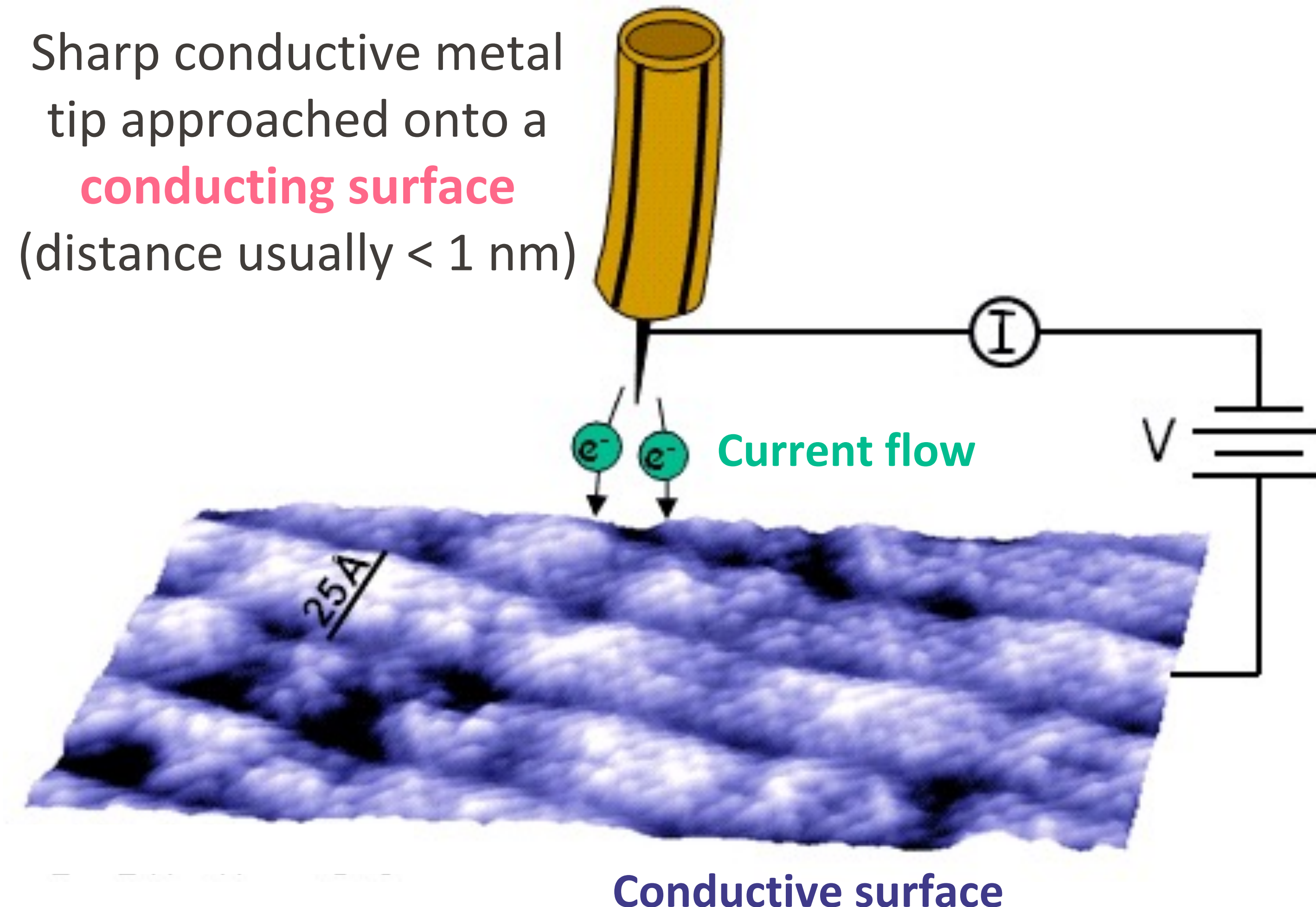
10 Å

Wintterlin | *Surface Science* | 1997

Seeing Surfaces with Atomic-Scale Resolution

Scanning Tunneling Microscopy (STM)

Sharp conductive metal tip approached onto a **conducting surface** (distance usually < 1 nm)



STM provides information on:

- 1) Electron-density distribution
- 2) Electronic work function
- 3) Surface topography

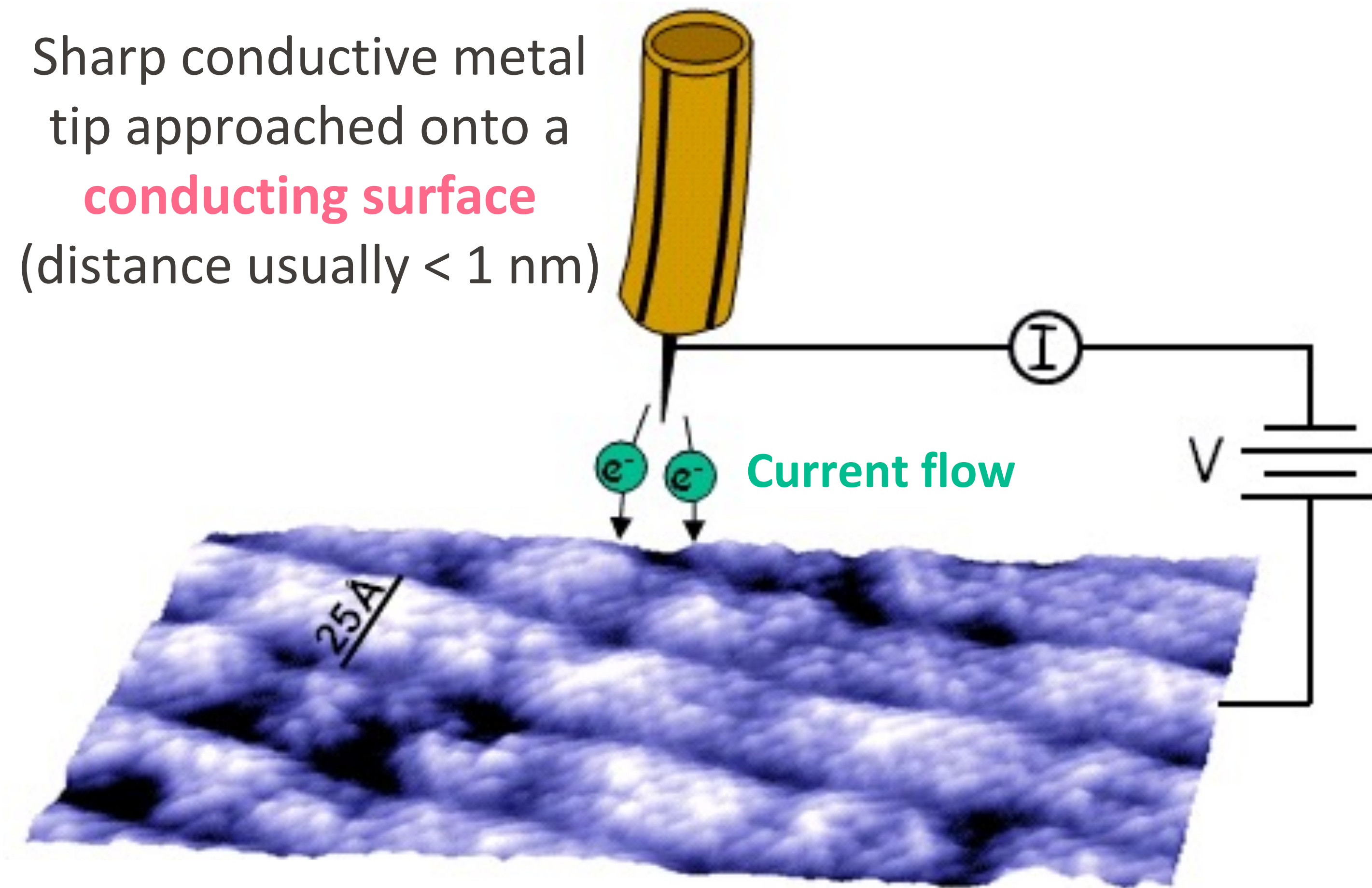
A 3-D image of the "surface" can be obtained with atomic resolution

Seeing Surfaces with Atomic-Scale Resolution

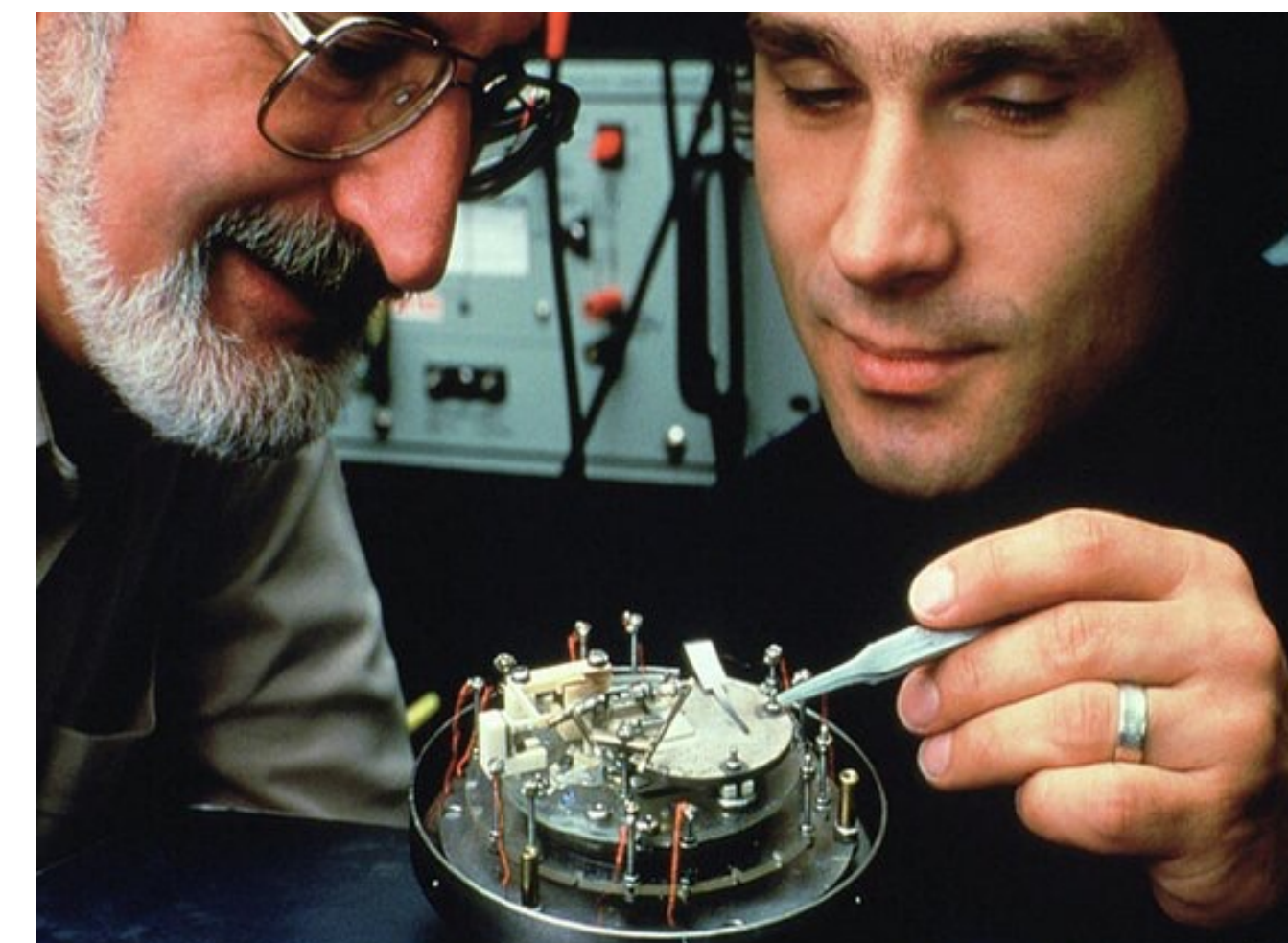
Scanning Tunneling Microscopy (STM)

1981 IBM Rüsclikon

Sharp conductive metal tip approached onto a **conducting surface** (distance usually < 1 nm)



Conductive surface

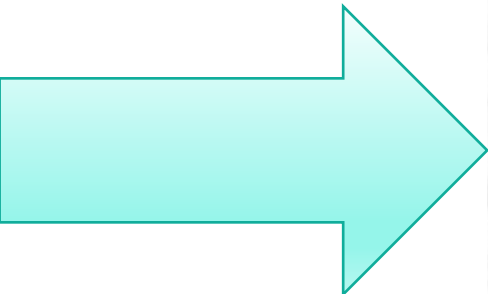
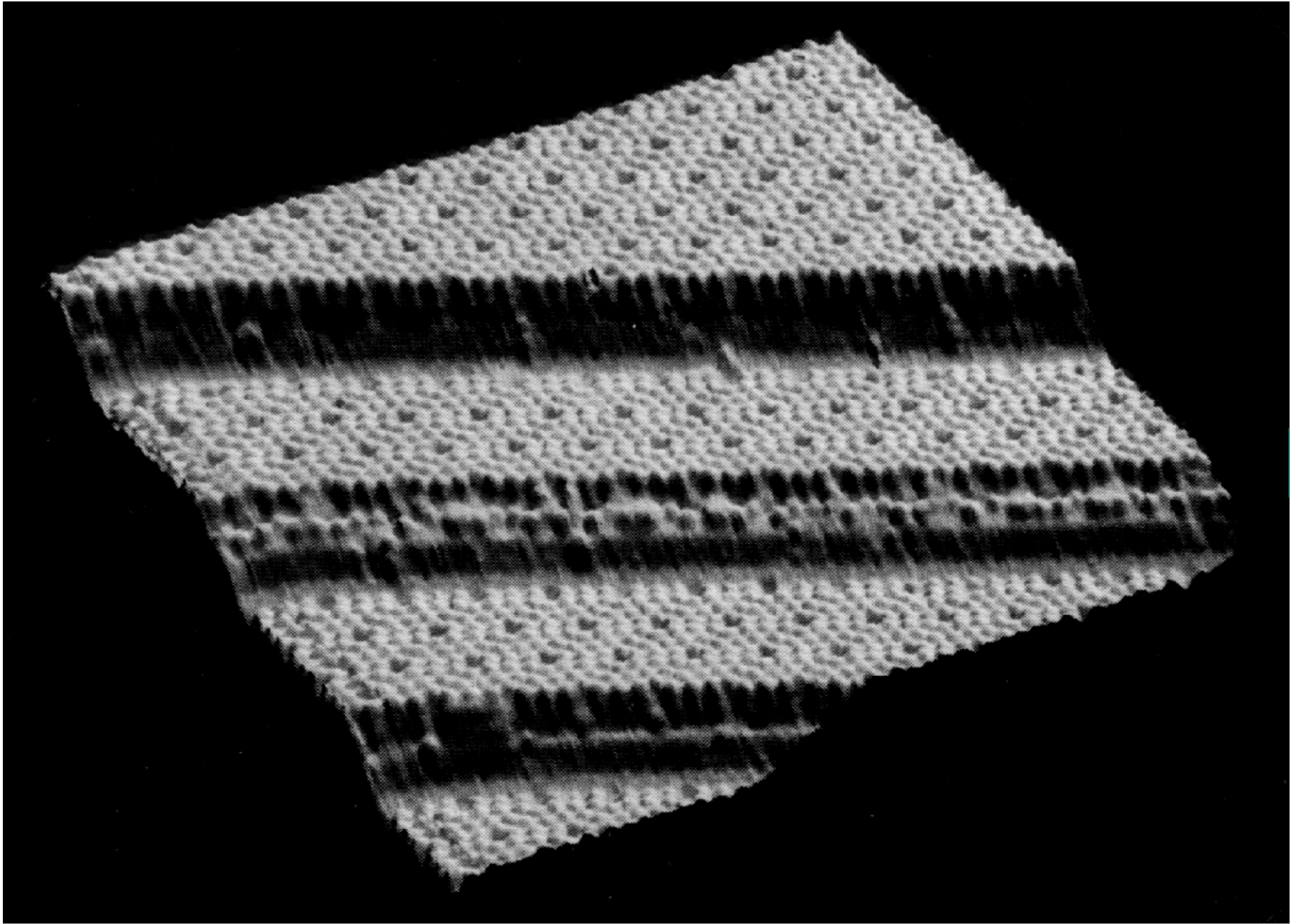


Heinrich Rohrer & Gerd Binnig

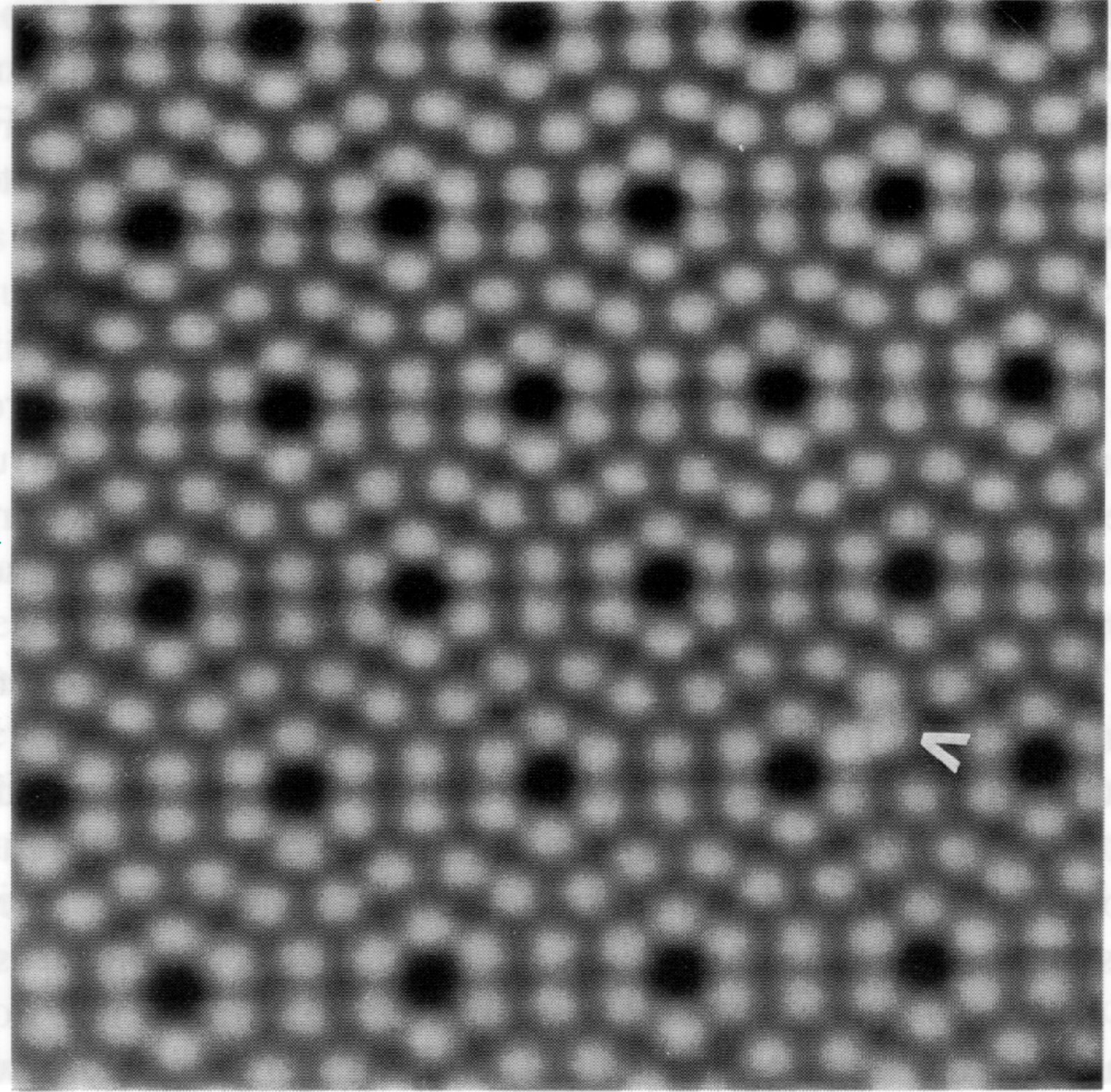


Nobel Prize in Physics for invention of STM (1986)

Seeing Surfaces with Atomic-Scale Resolution



LEED low energy electron diffraction

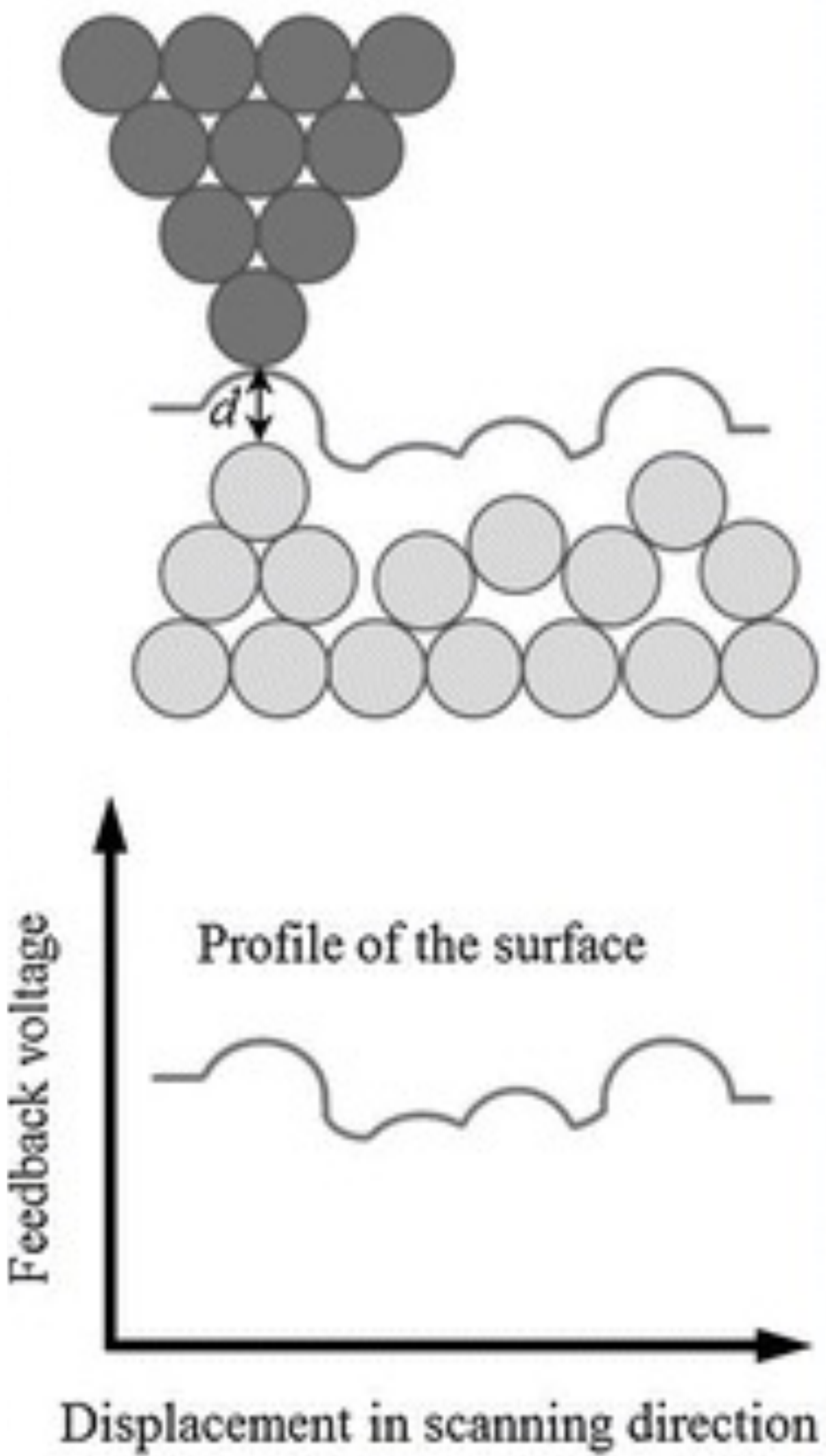
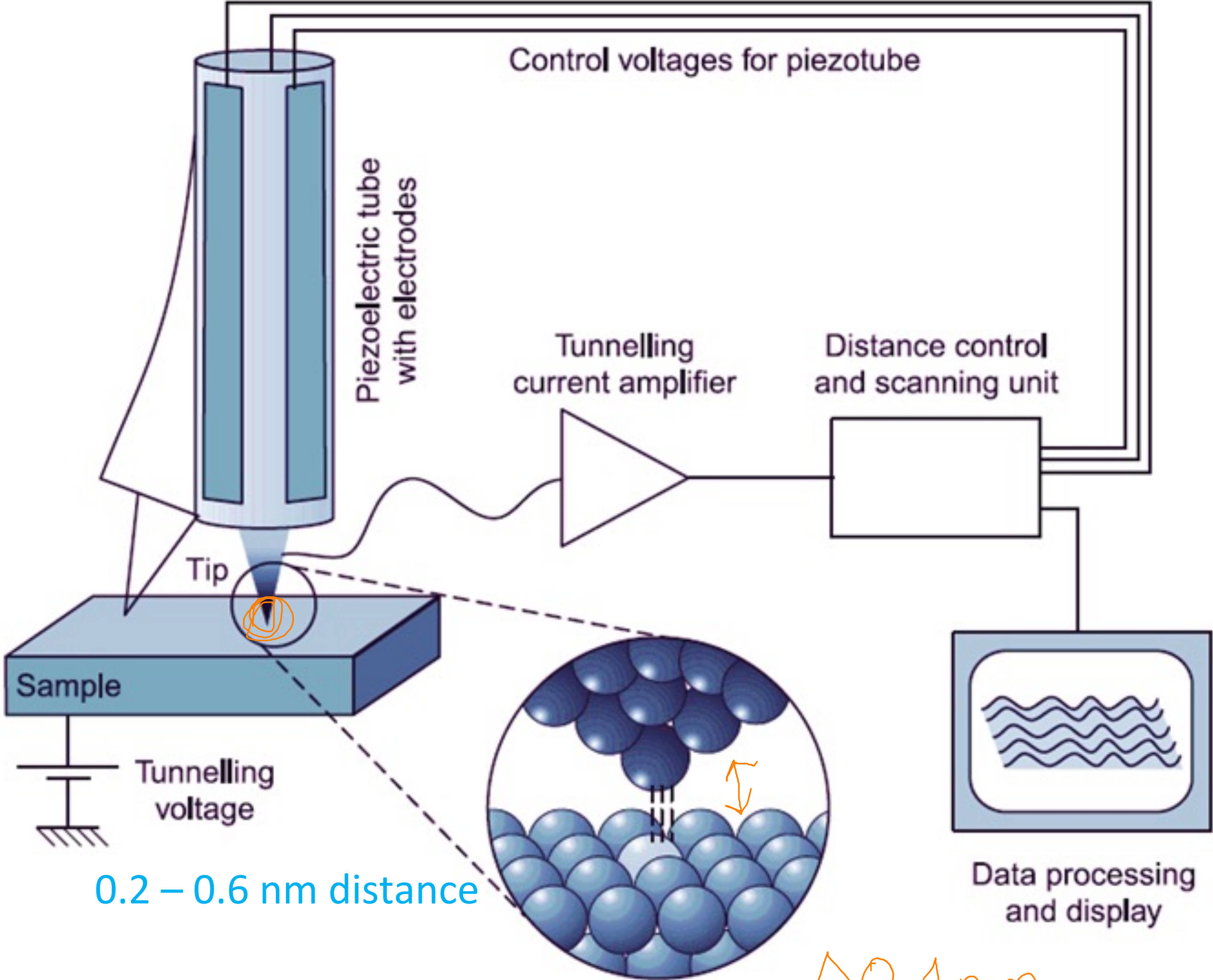


Perspective STM image of a 32 x 36 nm area of a Si(111) surface showing atomic layers

Source: Lucio Isa

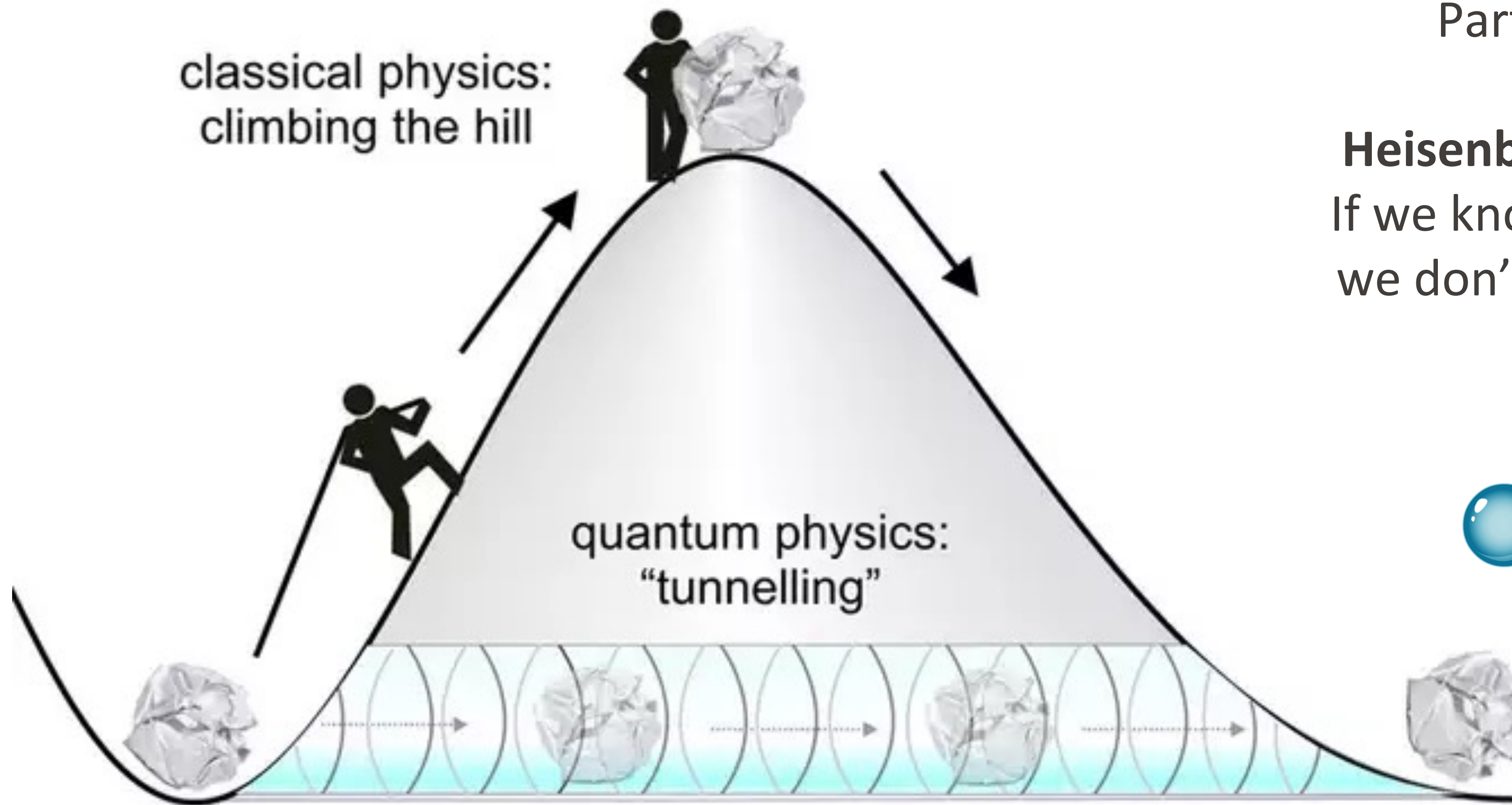


STM Uses a Tunneling Current to Map Atoms on Surfaces



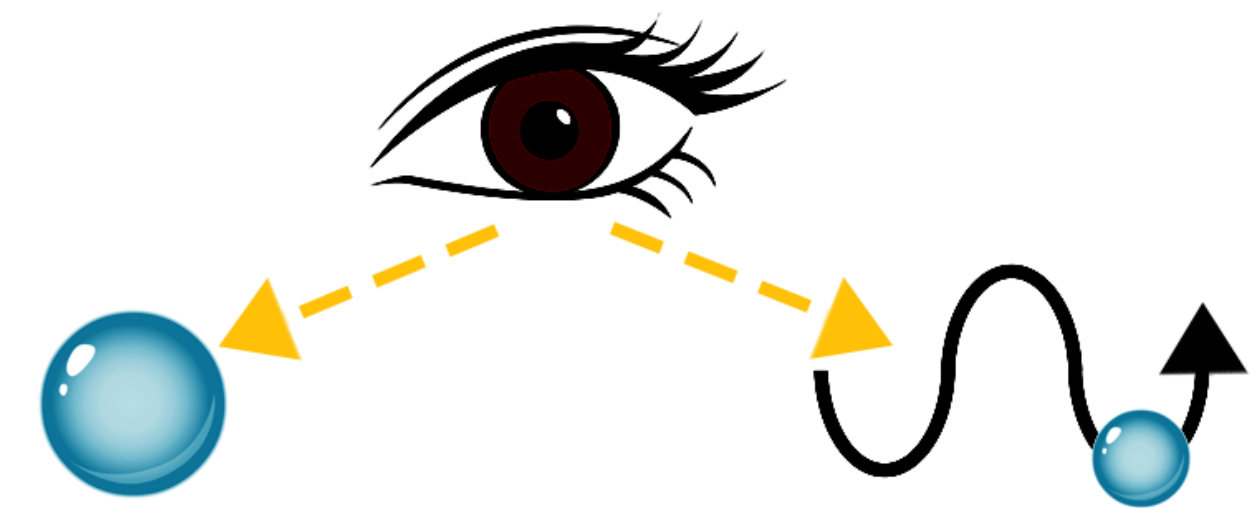
Source: Wikipedia

What is Quantum Tunneling?



Particles can act as waves

Heisenberg Uncertainty Principle:
If we know a particle's momentum,
we don't know its precise position



MAX-PLANCK-GESELLSCHAFT

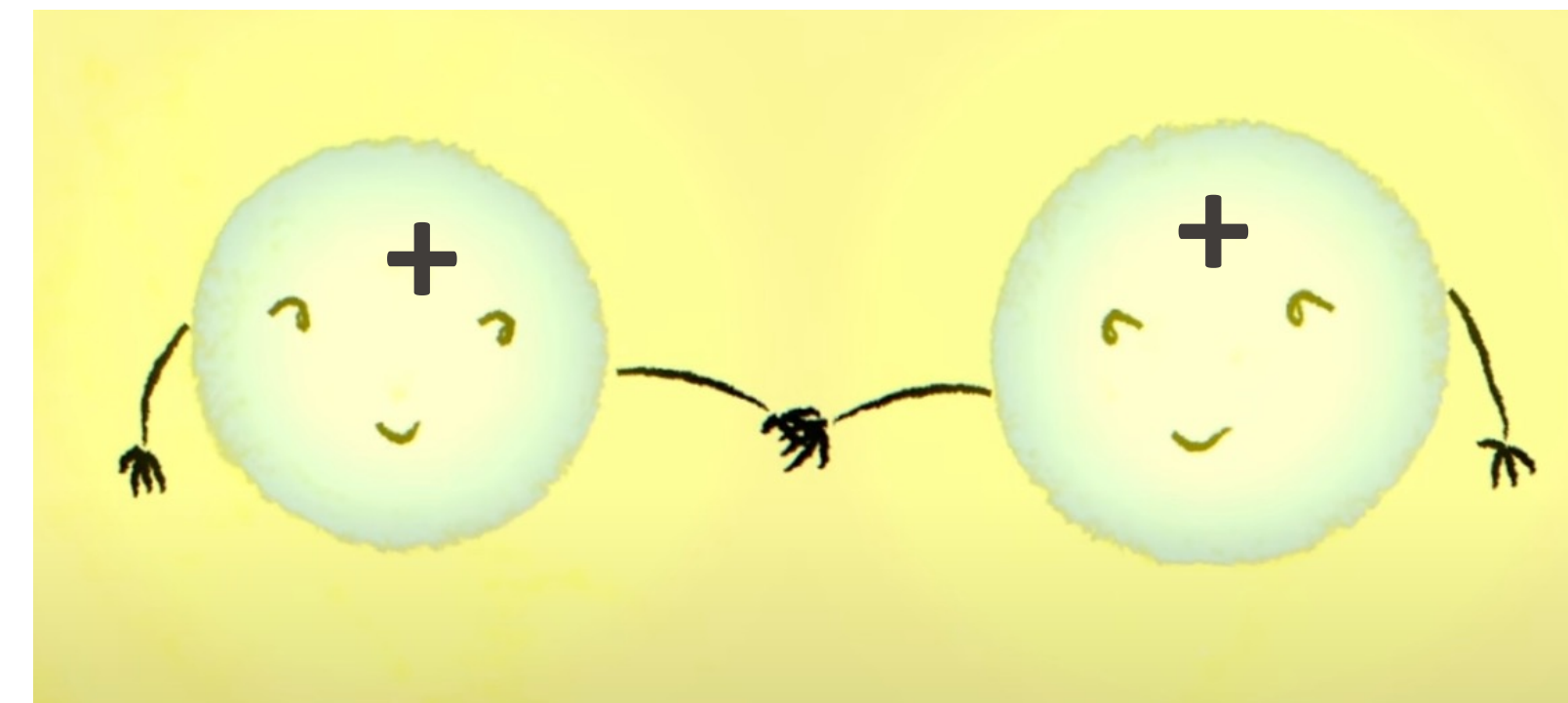
CHEM\$NA

How is Quantum Tunneling Relevant in Our Lives?

Nuclear fusion of hydrogen atoms to form helium

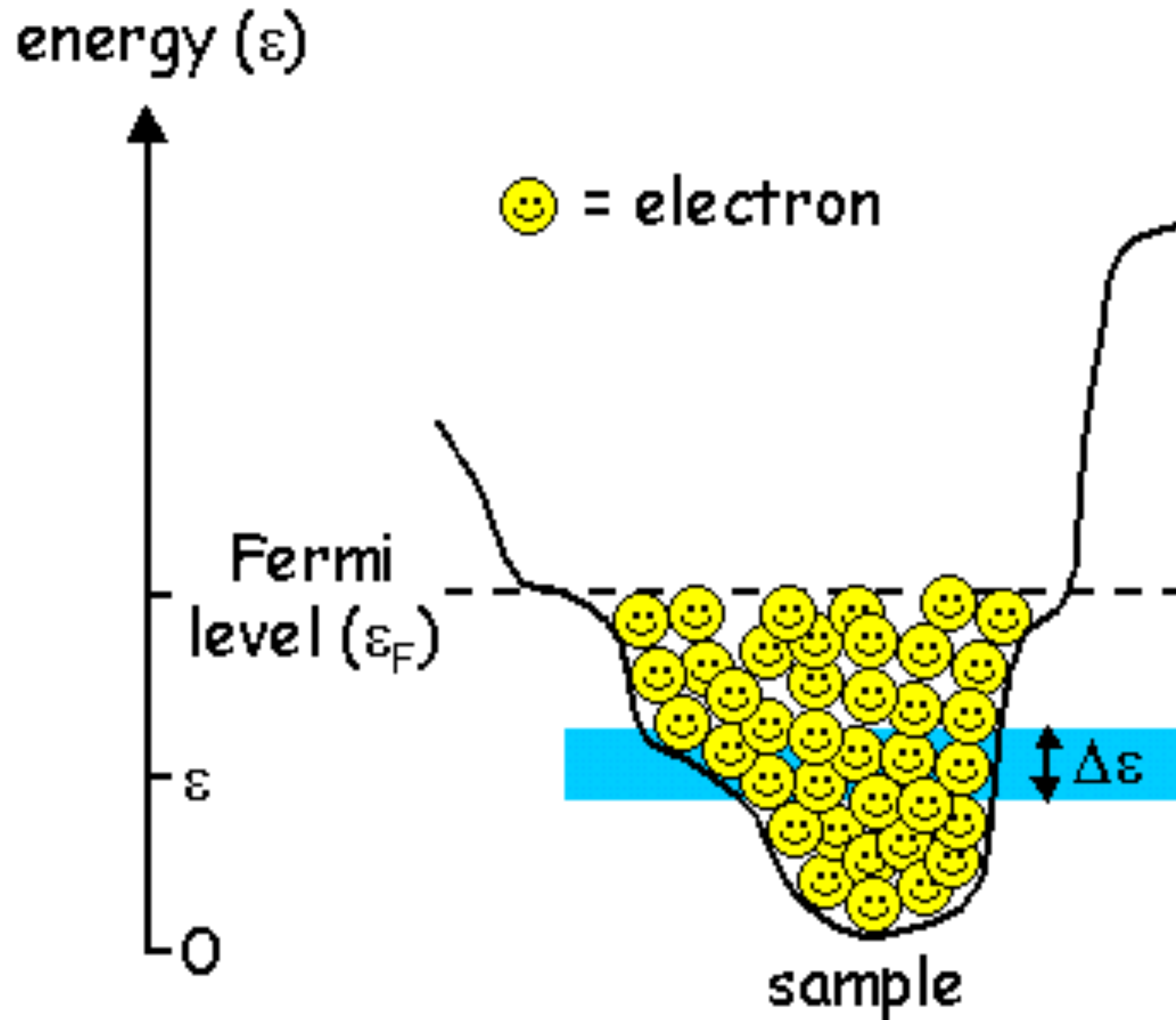


Overcoming repulsion shouldn't be possible



Quantum tunneling
1 in a trillion encounters

What is a Tunneling Current that Enables STM?



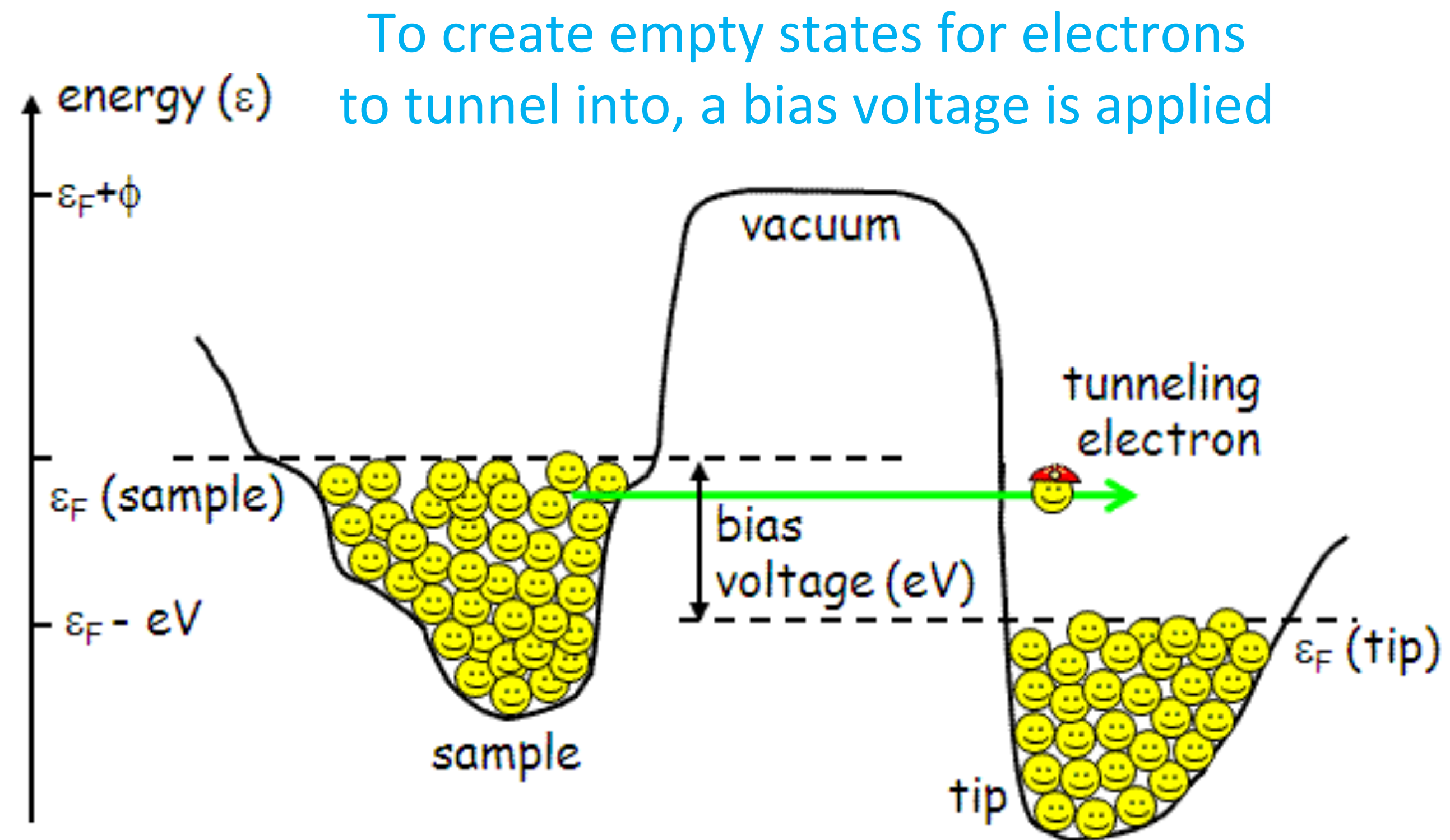
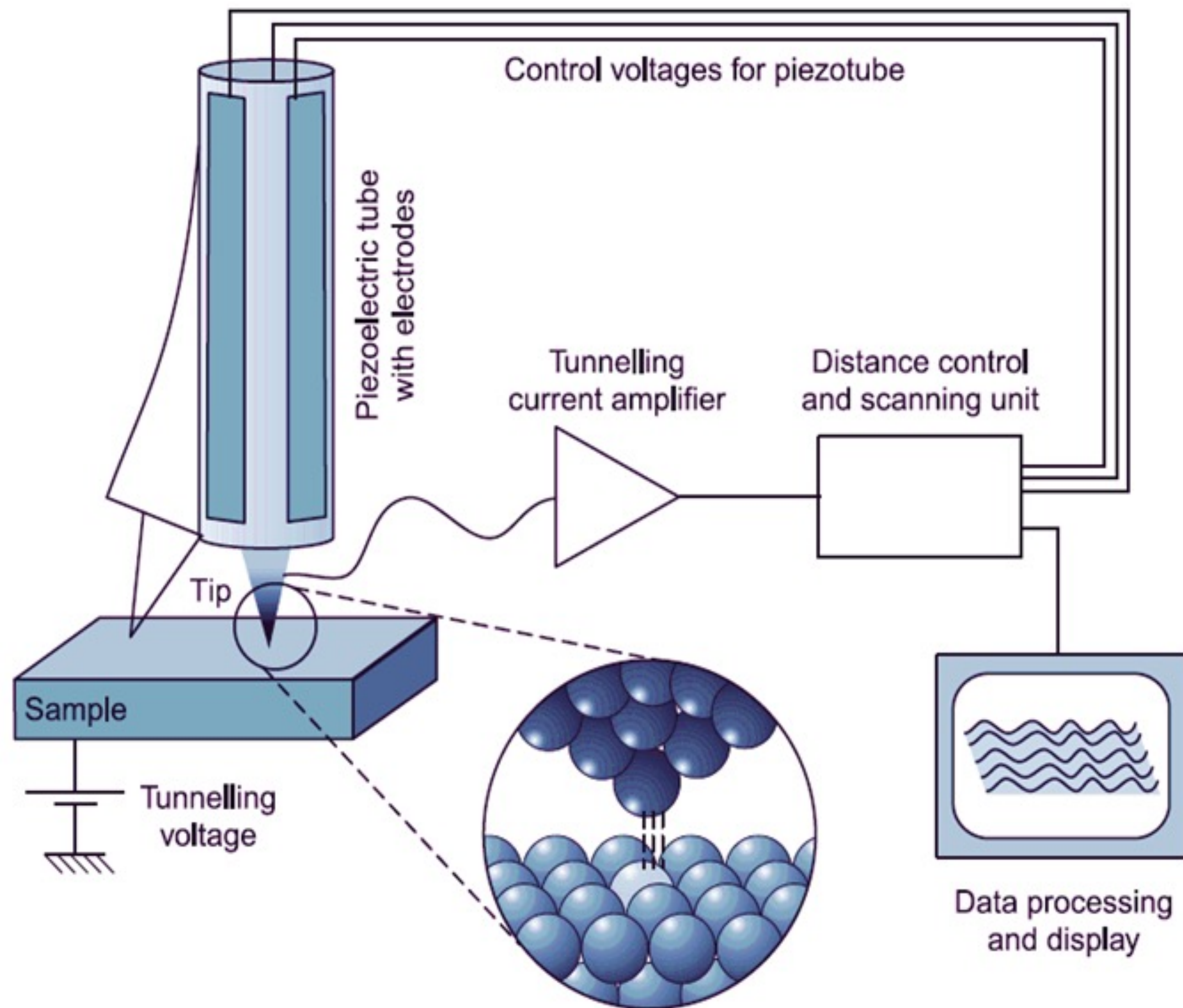
Electrons fill up energy valley in the sample until there are no more electrons

Pauli exclusion principle

Remember: no two electrons occupy the same energy state

The density of states at energy ϵ , $DOS(\epsilon)$, is the number of ☺ sitting in this strip, divided by $\Delta\epsilon$.

What is a Tunneling Current that Enables STM?



To create empty states for electrons to tunnel into, a bias voltage is applied

Tunneling current proportional to density of states in sample

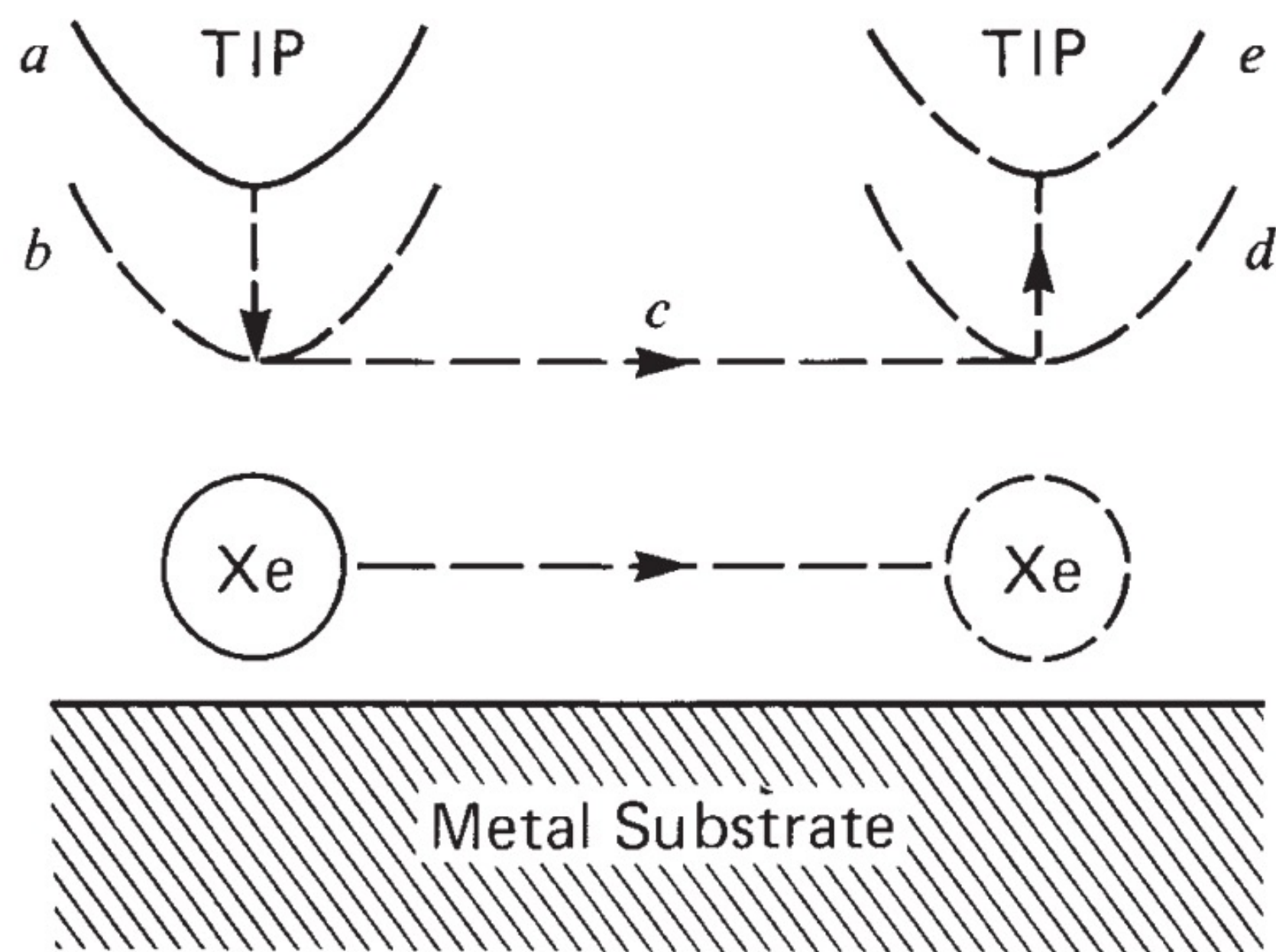
The Potential to Manipulate Atoms at the Nanoscale

Positioning single atoms with a scanning tunnelling microscope

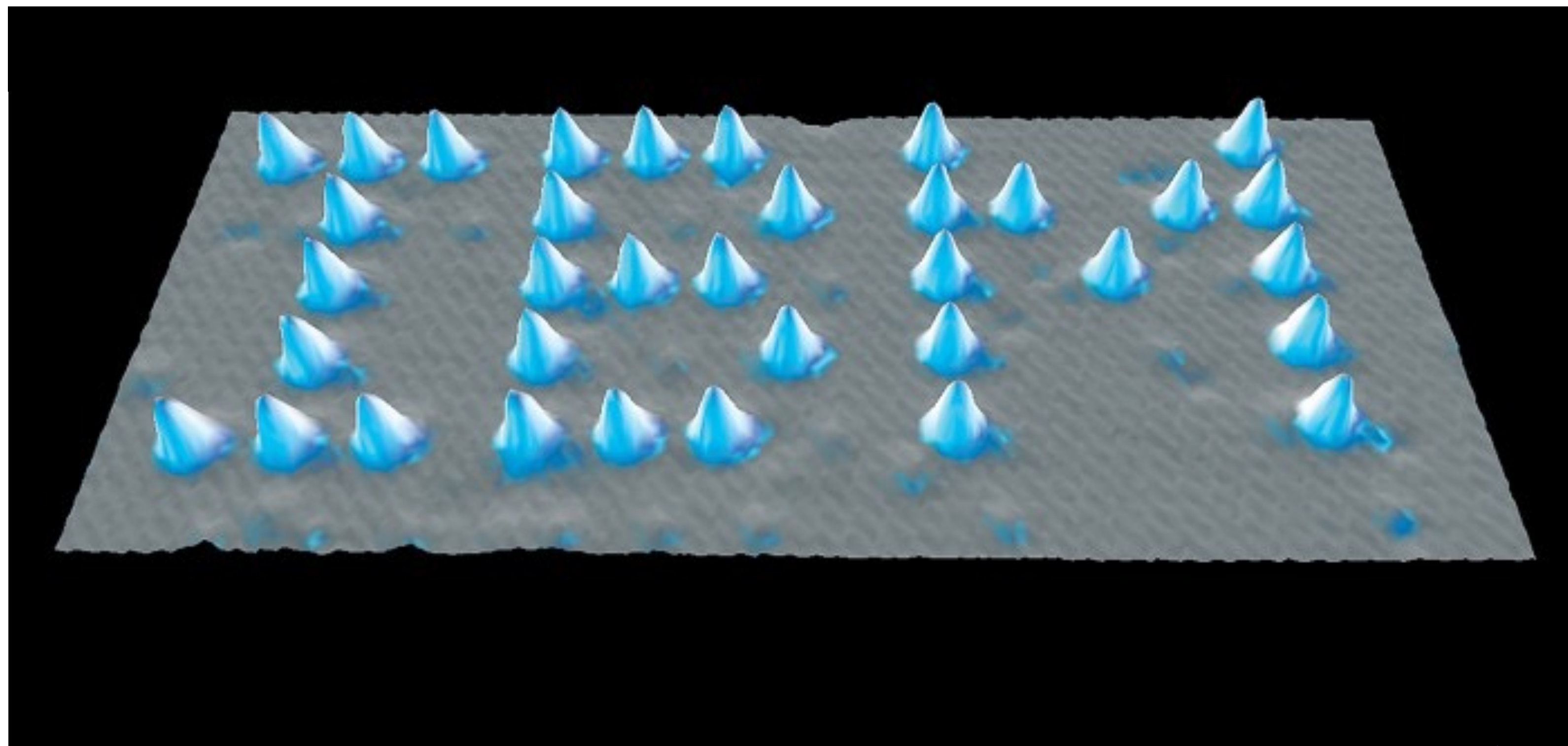
NATURE · VOL 344 · 5 APRIL 1990

D. M. Eigler & E. K. Schweizer*

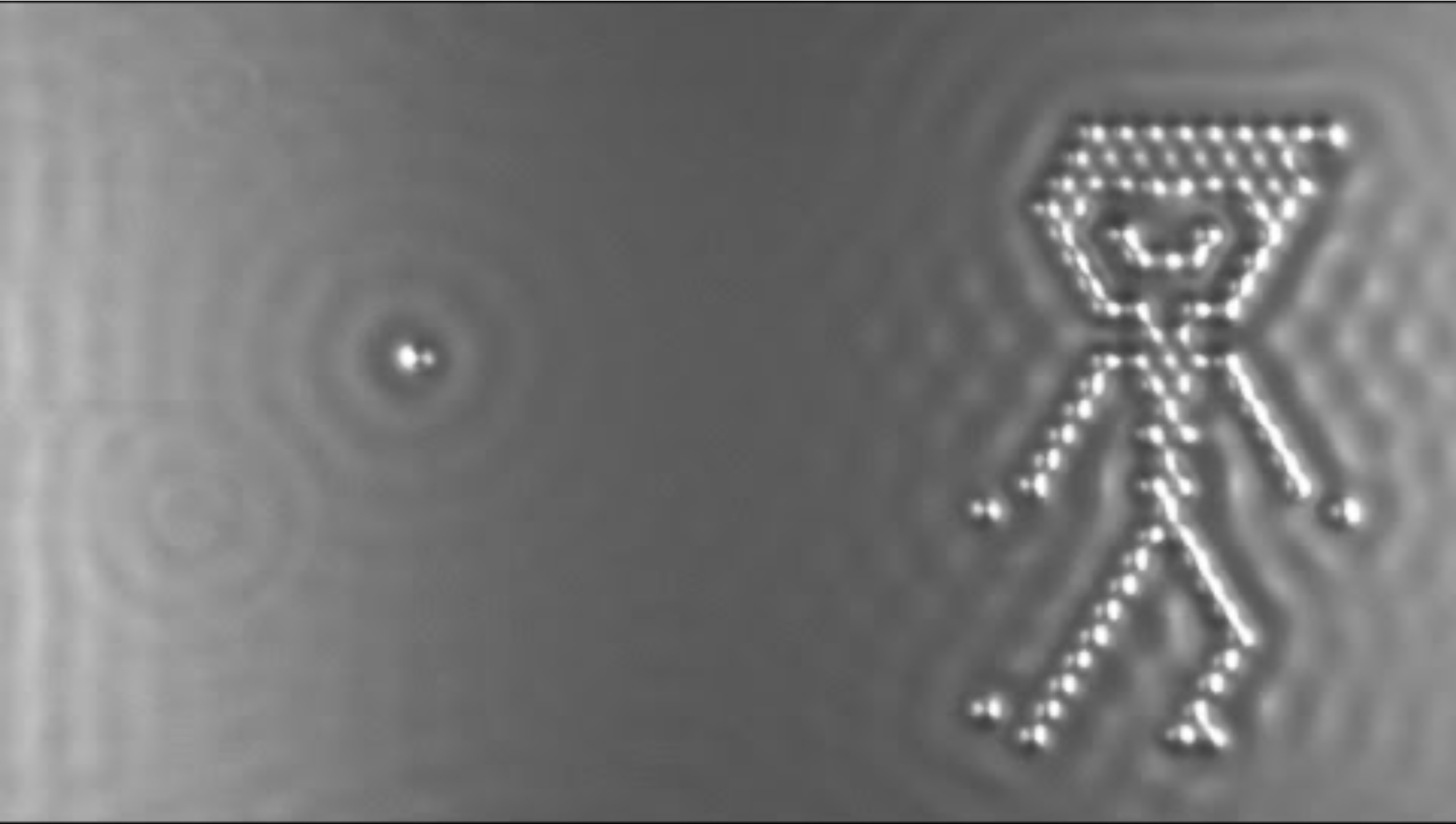
IBM Research Division, Almaden Research Center, 650 Harry Rd, San Jose, California 95120, USA



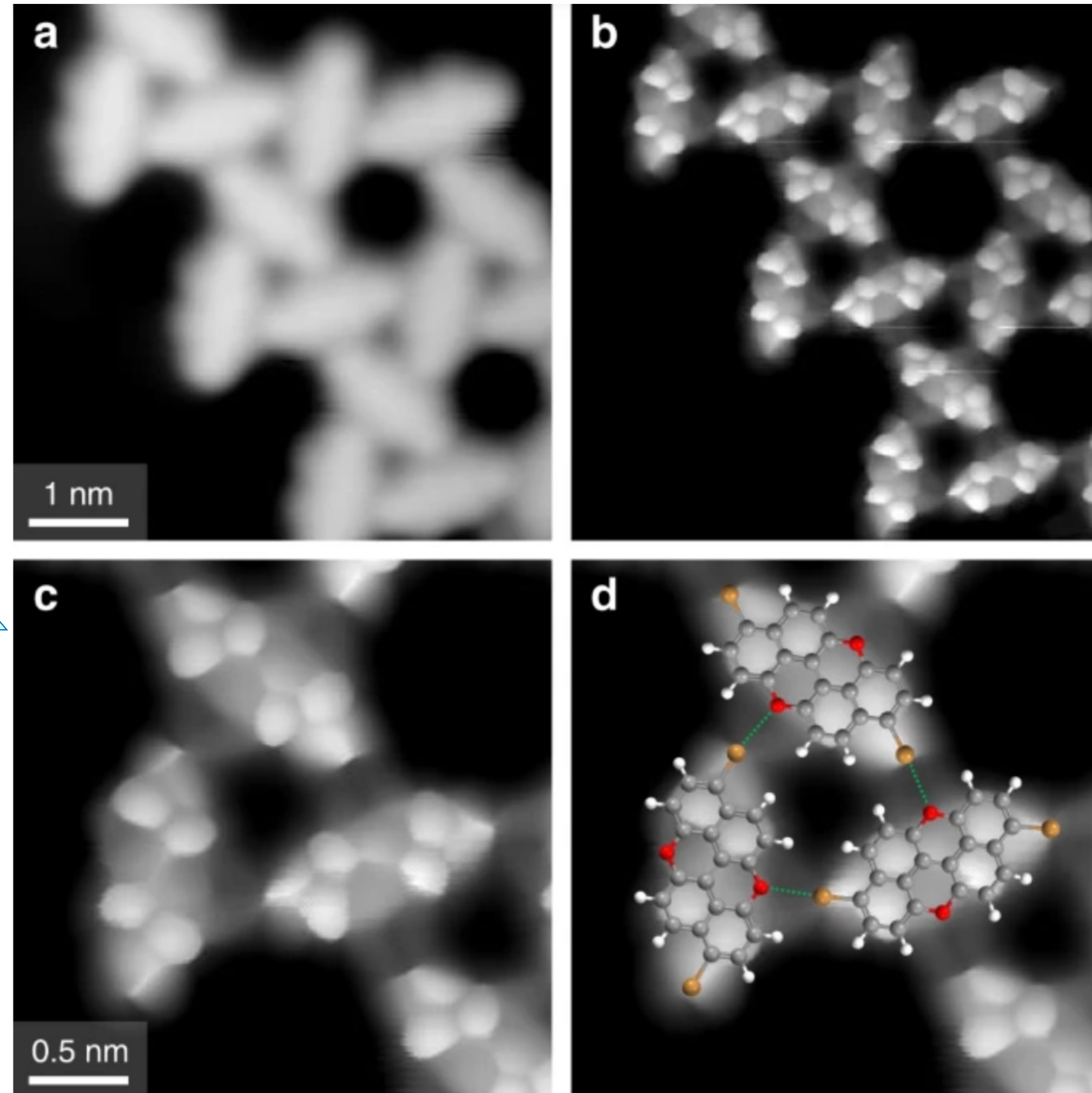
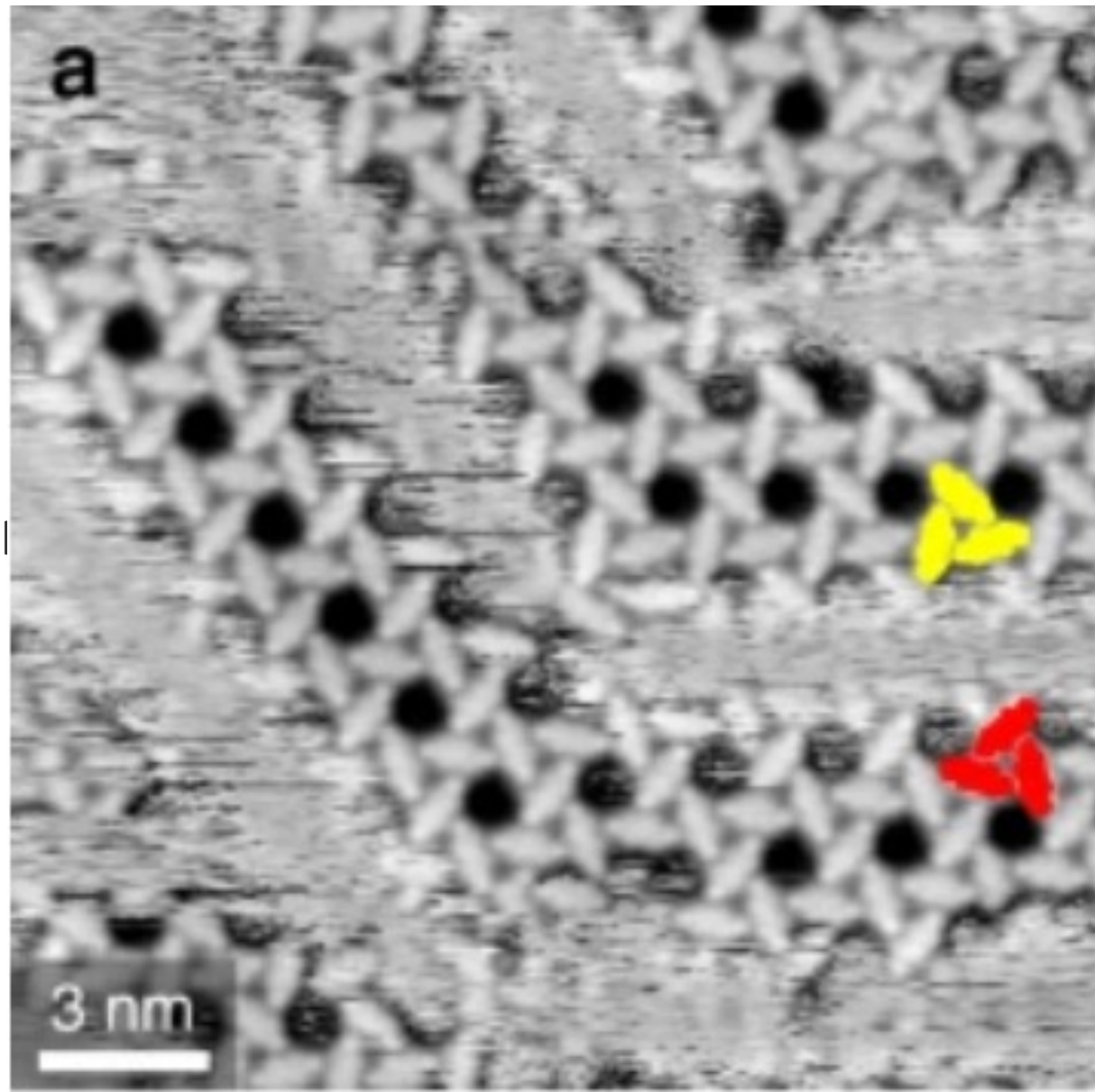
Nickel (110)



The World's Smallest Movie by IBM



The Power and Limitations of STM



Predicting intermolecular interactions with high-resolution STM

High resolution

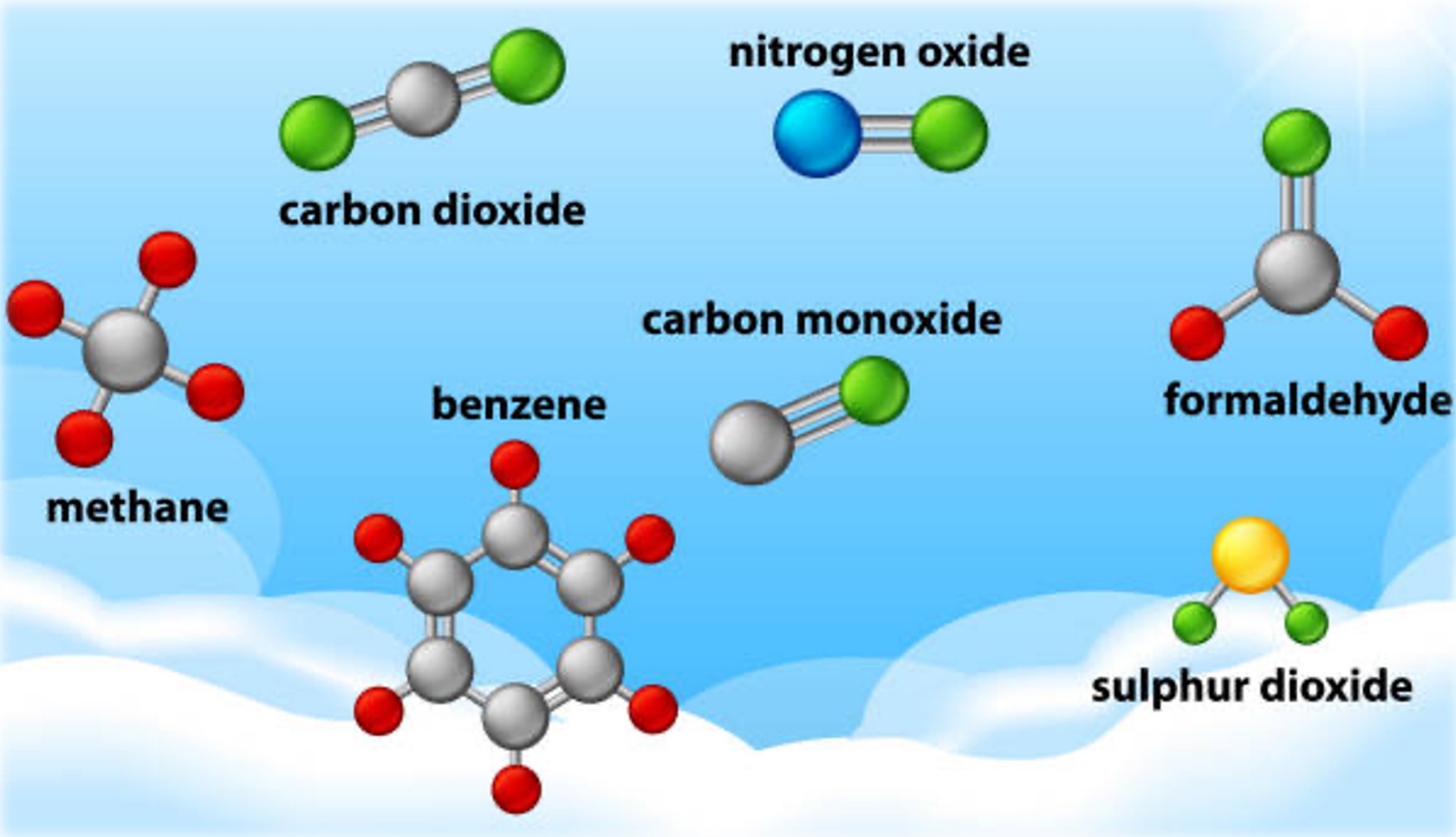
Requires UHV and low temperature

Only conducting surfaces

Slow scanning

Sensitive to vibration

Ordered, Pristine Surfaces Do Not Last Long



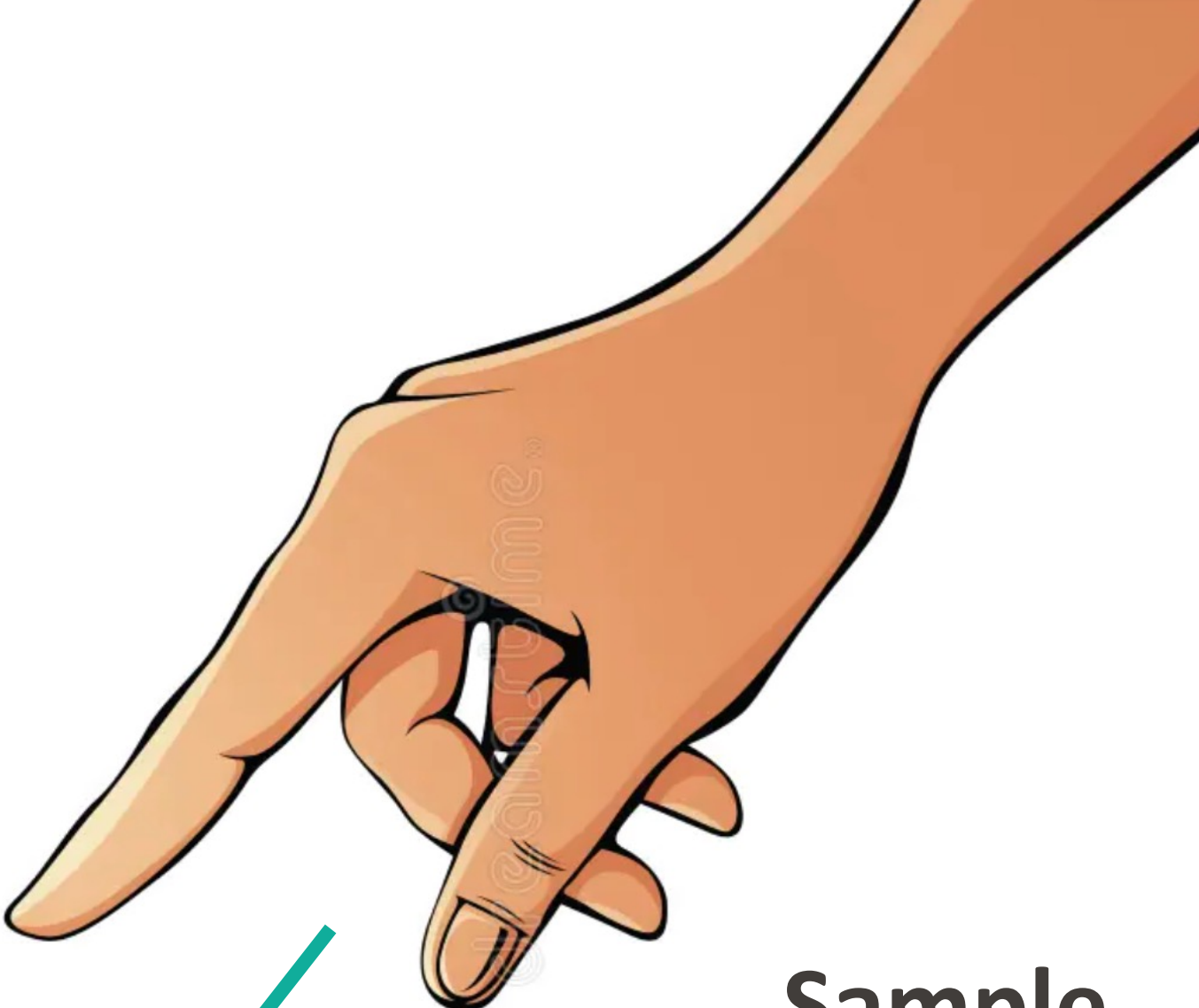
Air contaminants



Humidity



Chemical residue



Sample handling



Dust

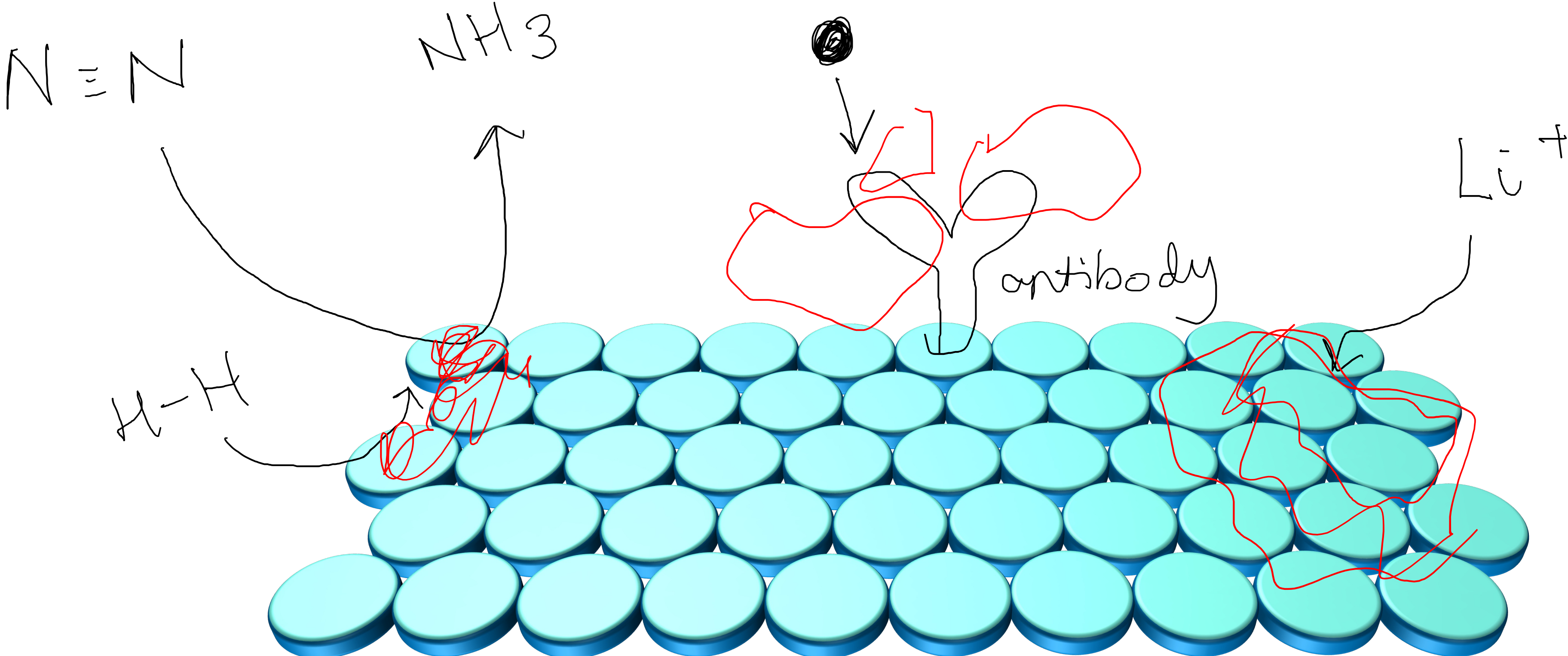


Why Contamination on Surfaces is a Problem

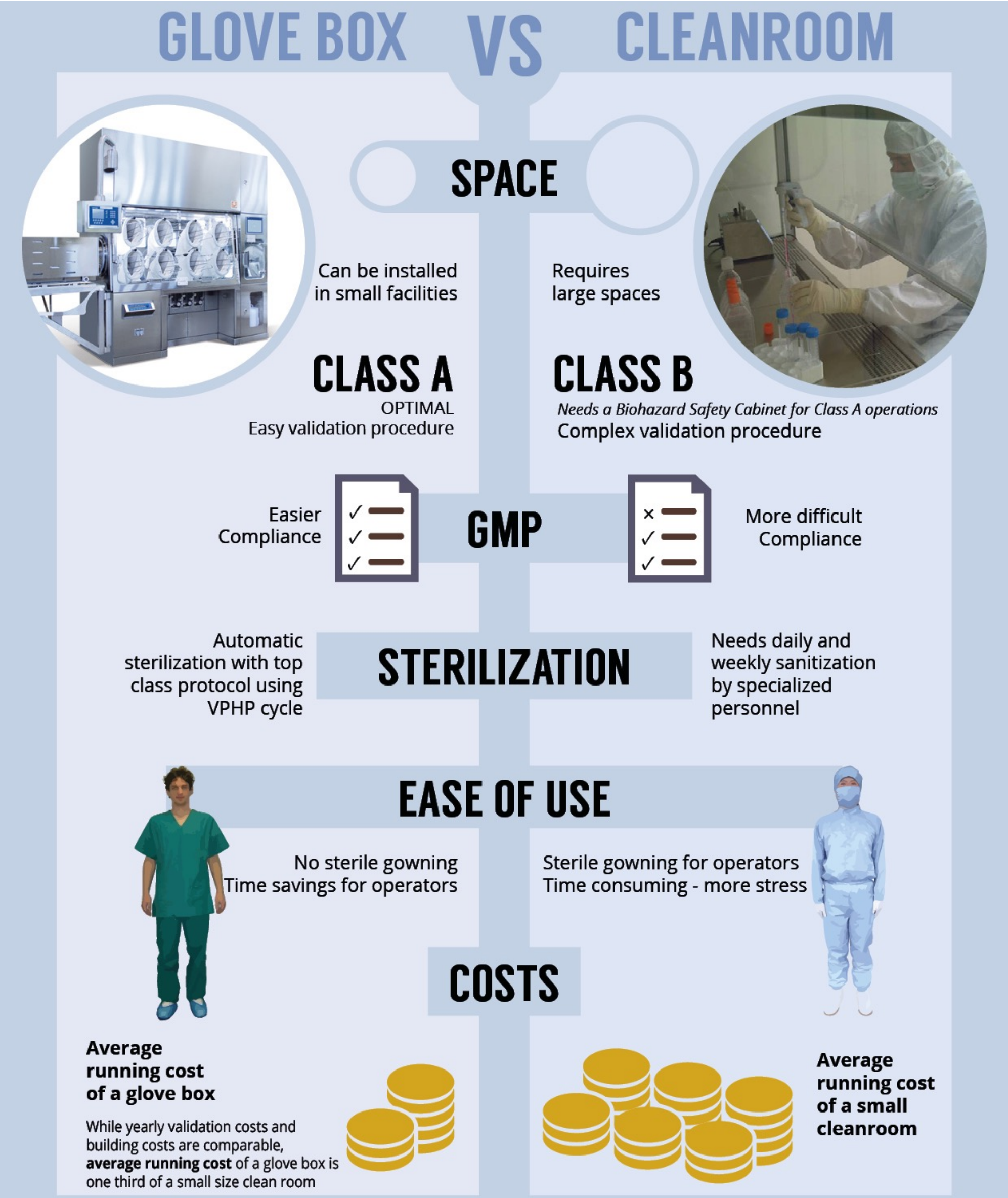
Catalysis

Biosensing

Energy storage



Controlled Environments to Limit Airborne Contaminants



Industries/applications

Pharmaceuticals

Biotechnology

Medical Devices

Nanotechnology

Semiconductor & Electronics

Aerospace



Cleanroom: Controlled Environment to Limit Airborne Contaminants

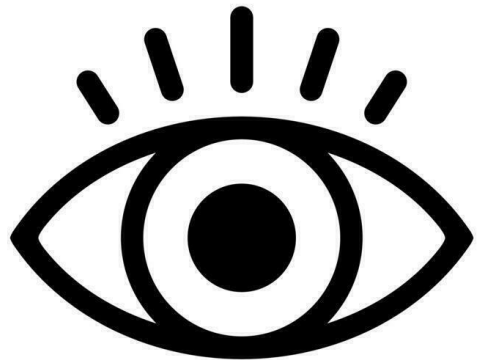
Class	Maximum Particles/m ³						FED STD 209E equivalent
	>0.1 um	>0.2 um	>0.3 um	>0.5 um	>1 um	>5 um	
ISO 1	10	2					
ISO 2	100	24	10	4			
ISO 3	1,000	237	102	35	8		Class 1
ISO 4	10,000	2,370	1,020	352	83		Class 10
ISO 5	100,000	23,700	10,200	3,520	832	29	Class 100
ISO 6	1,000,000	237,000	102,000	35,200	8,320	293	Class 1,000
ISO 7				352,000	83,200	2,930	Class 10,000
ISO 8				3,520,000	832,000	29,300	Class 100,000
ISO 9				35,200,000	8,320,000	293,000	Room Air

**EPFL
Center of
MicroNano
Technology
(CMi)**

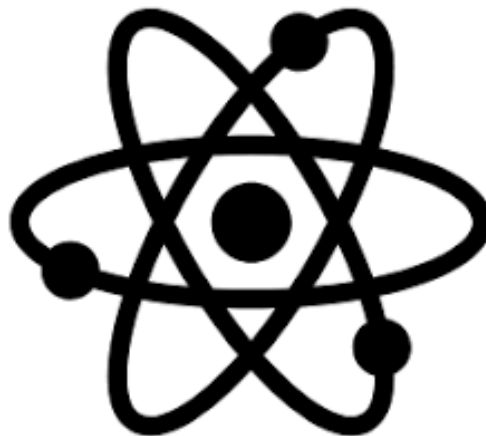
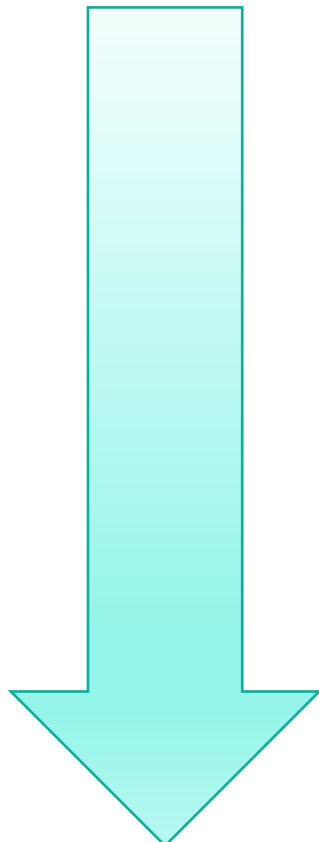
EPFL CMi Cleanroom in the BM Building



Surface Cleaning Hierarchy



Scale



Macroscopic (bulk cleaning)
Soap, detergents, sonication

Visible dirt, grease, particles

Leaves thin residues/adsorbed films

Chemicals/flame annealing
Piranha, acids, bases

Organic layers, oxides

Leaves chemical residues, roughens surface

Surface activation
Plasma/UV-ozone

Hydrocarbons, polymers, residues

Does not restore crystallinity, limited depth

Atomic-scale
Ion sputtering

All adsorbates, damaged layers

Expensive, requires UHV

Obtaining Clean Surfaces with Flame Annealing/Chemicals

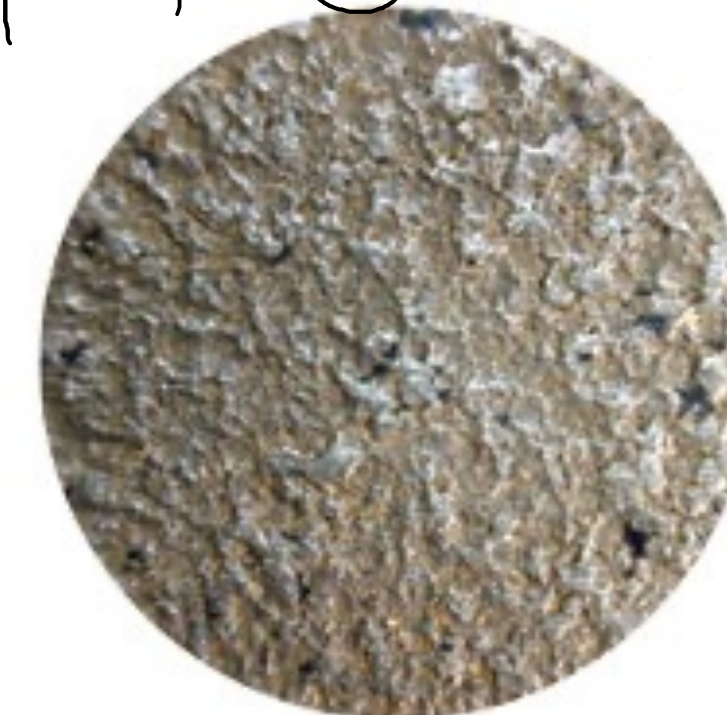
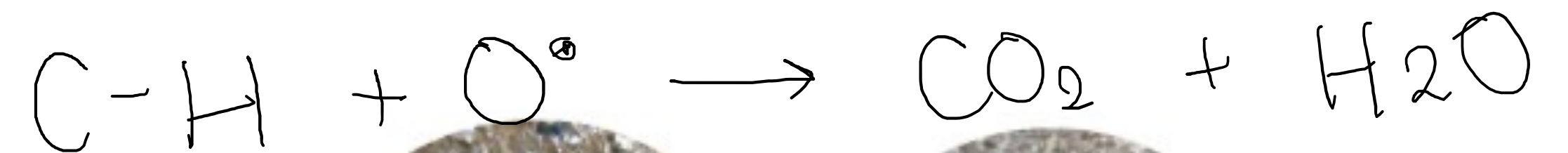
Flame annealing of substrates

For samples covered by an oxide layer, which are not stable at high temperatures



Piranha cleaning

Concentrated sulfuric acid and hydrogen peroxide



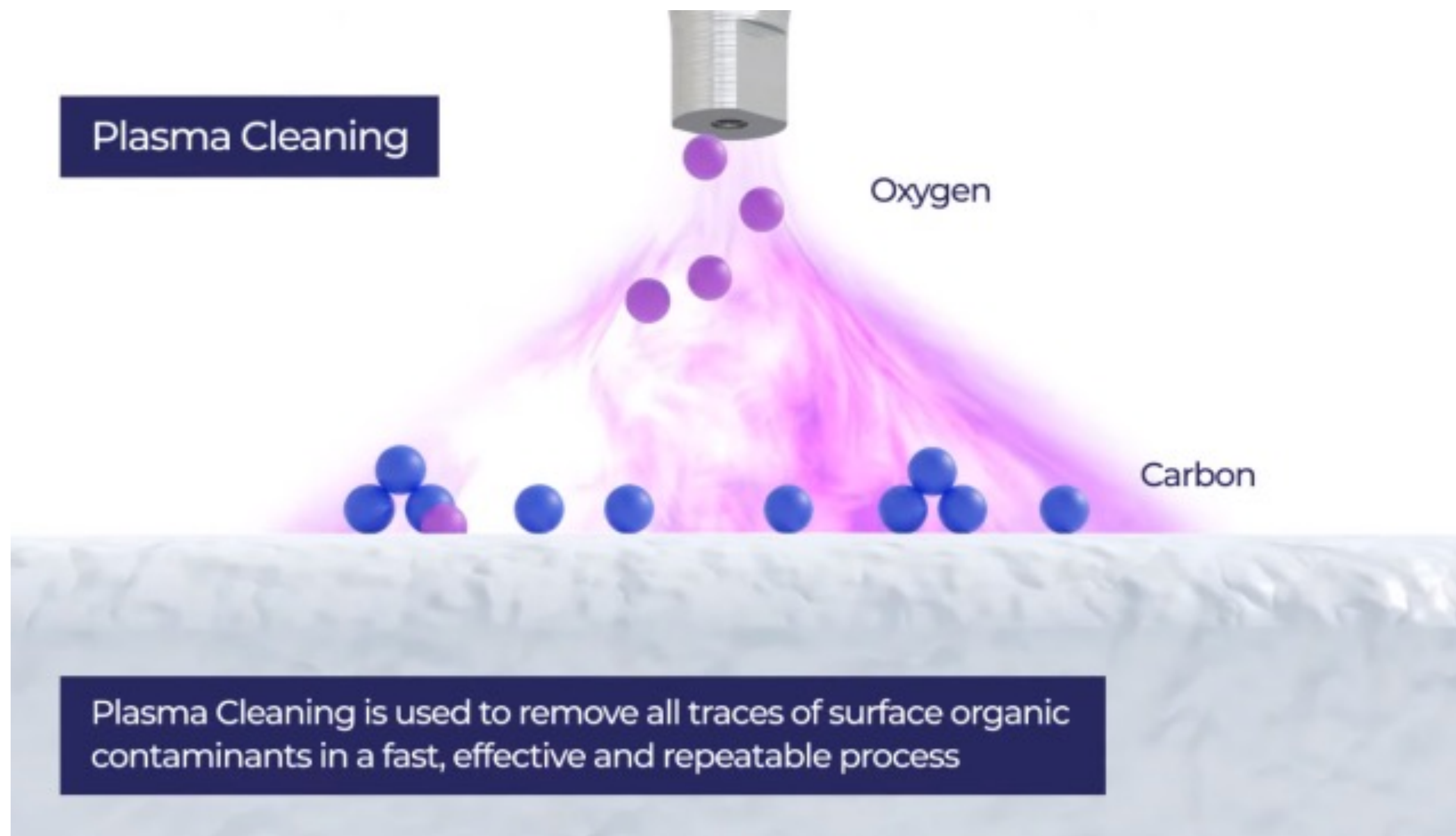
Standard
Vinegar Rinse



Weak Piranha Etch
30 minutes

Obtaining Clean Surfaces with Plasma Cleaning

Plasma cleaning to remove surface contaminants



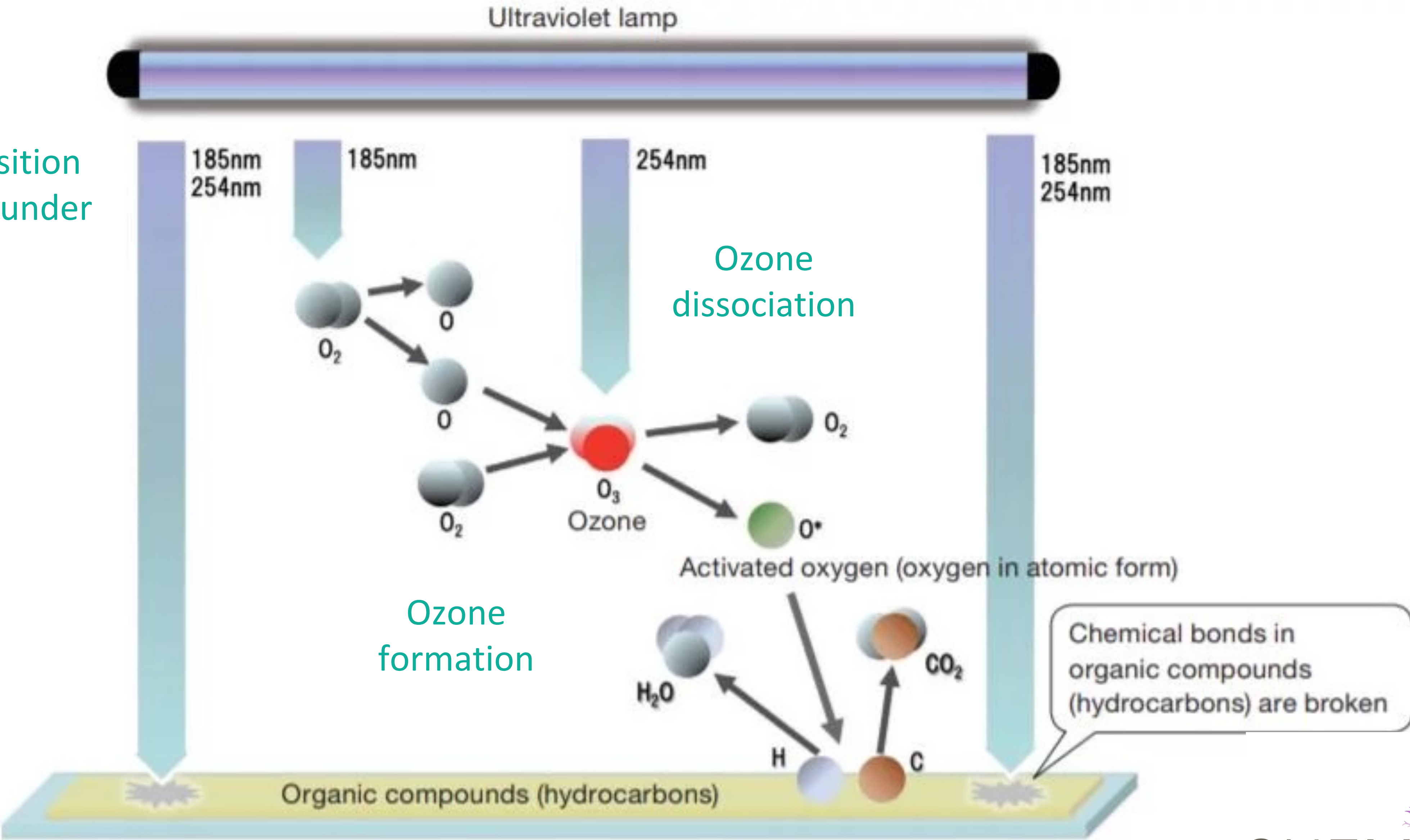
Plasma is generated by applying an electric field to a gas in a vacuum chamber

Oxygen radicals interact with carbon-based (organic) contaminants, breaking down into volatile compounds such as CO_2 and H_2O

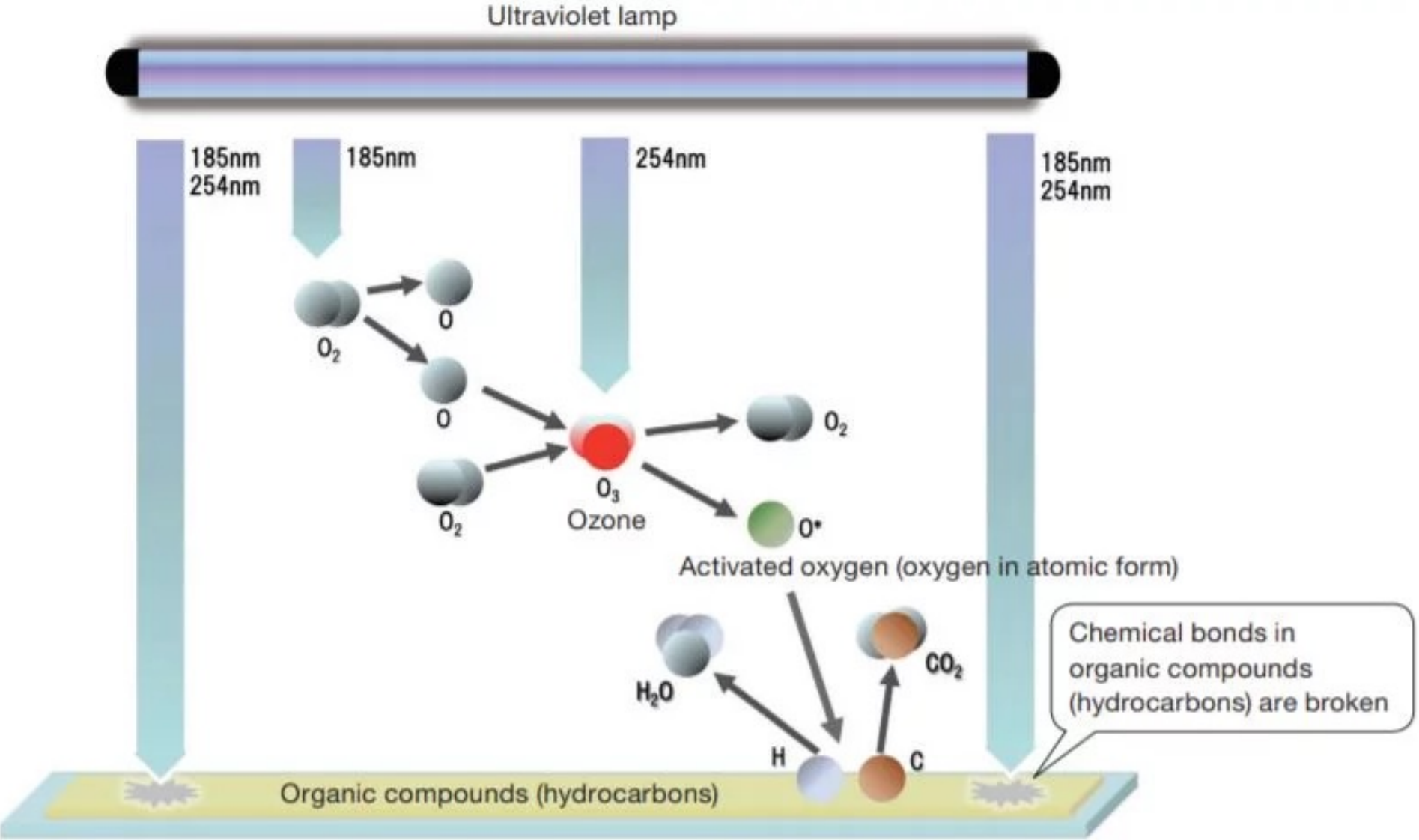
Reaction products often in gas form are carried away by vacuum system

Obtaining Clean Surfaces with UV Ozone Cleaning

Direct decomposition of hydrocarbons under UV



Comparing Plasma vs. UV Ozone Cleaning



Energy source

Electrical discharge

UV light (185, 254 nm)

Speed

Fast (seconds – minutes)

Slow (minutes – hours)

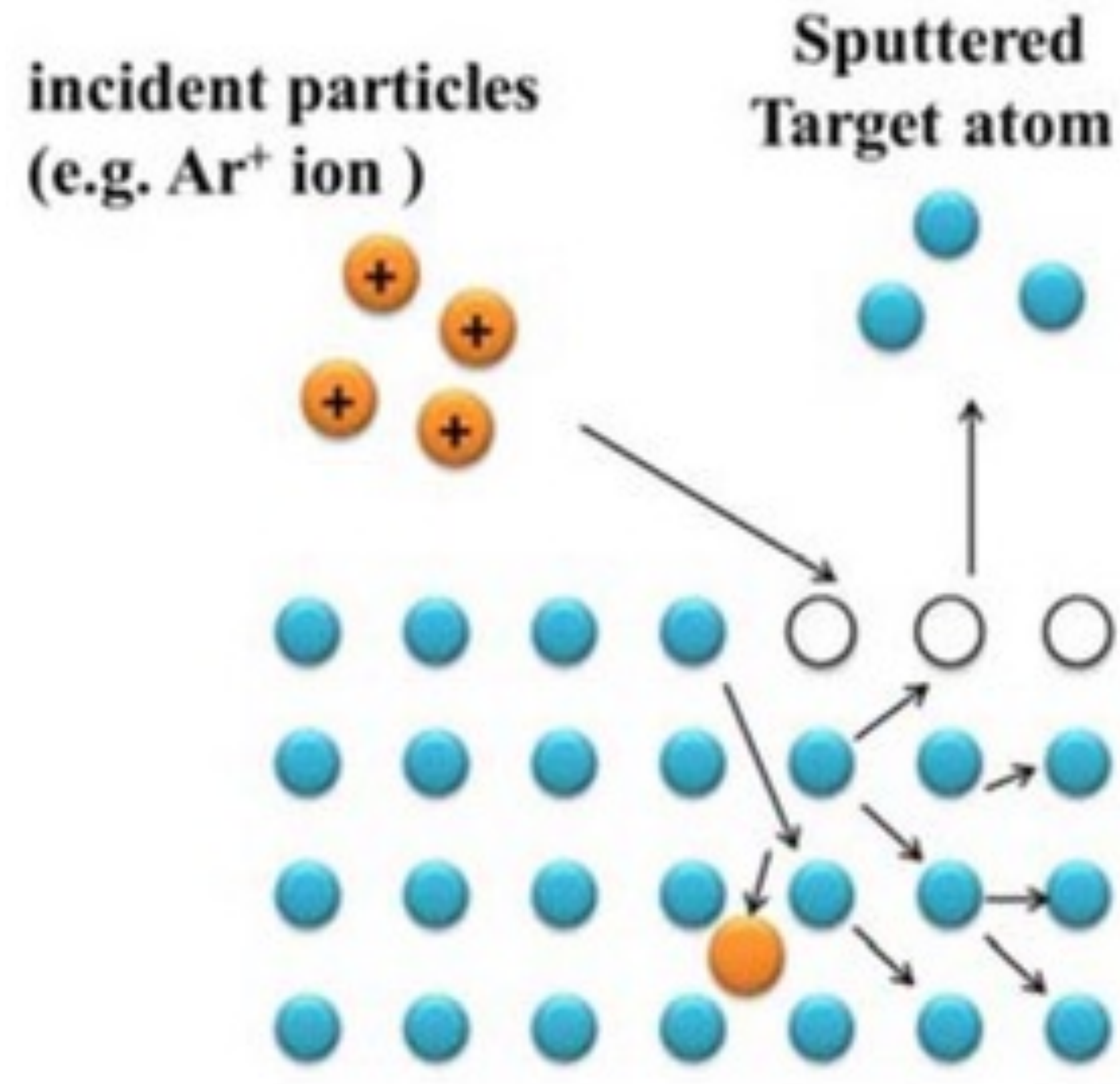
Aggressiveness

More aggressive, can etch surface

Gentler treatment, mainly oxidizes

Obtaining Clean Surfaces with Ion Sputtering

Argon sputtering removes the top layer of a sample by sputtering with Ar ions, with subsequent heating to remove surface defects



annealing

heat

Creating New Surfaces Rather than Cleaning

Fracture of a material: possible to obtain pure and very smooth surfaces (mica)



Newly cleaved surface atomically flat and clean

No solvents, plasmas, or chemicals required

Only works for materials with good cleavage planes (mica, graphine, silicon)

Clean surface contaminated if left in air

Key Takeaways

Contamination on surfaces affect many areas of research

We can tackle contamination in controlled environments like the cleanroom

There are different methods to clean the surface from the macroscale to atomic-scale

It's important you can choose how to clean your surface depending on the contamination

Summary of Today's Class

- Adsorption *vs.* Absorption
- Physisorption *vs.* Chemisorption
- Crystal lattice of substrates order adsorbates
- STM can visualize surfaces at atomic resolution
- How to tackle the challenge of contamination

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1202, Geneva

<https://www.epfl.ch/labs/chemina/>

